DAQ

PCI E Series User Manual

Multifunction I/O Boards for

PCI Bus Computers

January 1999 Edition
Part Number 320945D-01

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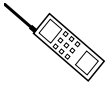

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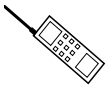

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About This Manual

This manual describes the electrical and mechanical aspects of each board in the PCI E Series product line and contains information concerning their operation and programming. Unless otherwise noted, text applies to all boards in the PCI E Series.

The PCI E Series includes the following boards:

- PCI-MIO-16E-1
- PCI-MIO-16E-4
- PCI-MIO-16XE-10
- PCI-MIO-16XE-50
- PCI-6031E (MIO-64XE-10)
- PCI-6032E (AI-16XE-10)
- PCI-6033E (AI-64XE-10)
- PCI-6071E (MIO-64E-1)

The PCI E Series boards are high-performance multifunction analog, digital, and timing I/O boards for PCI bus computers. Supported functions include analog input, analog output, digital I/O, and timing I/O.

Organization of This Manual

The *PCI E Series User Manual* is organized as follows:

- Chapter 1, *Introduction*, describes the PCI E Series boards, lists what you need to get started, describes the optional software and optional equipment, and explains how to unpack your PCI E Series board.
- Chapter 2, *Installation and Configuration*, explains how to install and configure your PCI E Series board.
- Chapter 3, *Hardware Overview*, presents an overview of the hardware functions on your PCI E Series board.

- Chapter 4, *Signal Connections*, describes how to make input and output signal connections to your PCI E Series board via the board I/O connector.
- Chapter 5, *Calibration*, discusses the calibration procedures for your PCI E Series board.
- Appendix A, *Specifications*, lists the specifications of each PCI E Series board.
- Appendix B, *Optional Cable Connector Descriptions*, describes the connectors on the optional cables for the PCI E Series boards.
- Appendix C, *Common Questions*, contains a list of commonly asked questions and their answers relating to usage and special features of your PCI E Series board.
- Appendix D, *Customer Communication*, contains forms you can use to request help from National Instruments or to comment on our products.
- The *Glossary* contains an alphabetical list and description of terms used in this manual, including acronyms, abbreviations, definitions metric prefixes, mnemonics, and symbols.
- The *Index* alphabetically lists topics covered in this manual, including the page where you can find the topic.

Conventions Used in This Manual

The following conventions are used in this manual.

<> Angle brackets enclose the name of a key on the keyboard (for example, <option>). Angle brackets containing numbers separated by an ellipsis represent a range of values associated with a bit or signal name (for example, DIO<3..0>).

♦ The ♦ symbol indicates that the text following it applies only to specific PCI E Series boards.

 This icon to the left of bold italicized text denotes a note, which alerts you to important information.

 This icon to the left of bold italicized text denotes a caution, which advises you of precautions to take to avoid injury, data loss, or a system crash.

 This icon to the left of bold italicized text denotes a warning, which advises you of precautions to take to avoid being electrically shocked.

bold	Bold text denotes the names of menus, menu items, parameters, dialog boxes, dialog box buttons or options, icons, windows, Windows 95 tabs, or LEDs.
bold italic	Bold italic text denotes a note, caution, or warning.
italic	Italic text denotes emphasis, a cross reference, or an introduction to a key concept. This font also denotes text from which you supply the appropriate word or value, as in Windows 3.*x*.
Macintosh	Macintosh refers to all Macintosh computers with PCI bus, unless otherwise noted.
`monospace`	Text in this font denotes text or characters that should literally enter from the keyboard, sections of code, programming examples, and syntax examples. This font is also used for the proper names of disk drives, paths, directories, programs, subprograms, subroutines, device names, functions, operations, variables, file names and extensions, and for statements and comments taken from programs.
NI-DAQ	NI-DAQ refers to the NI-DAQ driver software for Macintosh or PC compatible computers unless otherwise noted.
PC	Refers to all PC AT series computers with PCI bus unless otherwise noted.
SCXI	SCXI stands for Signal Conditioning eXtensions for Instrumentation and is a National Instruments product line designed to perform front-end signal conditioning for National Instruments plug-in DAQ boards. The *Glossary* lists abbreviations, acronyms, metric prefixes, mnemonics, symbols, and terms.

National Instruments Documentation

The *PCI E Series User Manual* is one piece of the documentation set for your DAQ system. You could have any of several types of manuals depending on the hardware and software in your system. Use the manuals you have as follows:

- *Getting Started with SCXI*—If you are using SCXI, this is the first manual you should read. It gives an overview of the SCXI system and contains the most commonly needed information for the modules, chassis, and software.
- Your SCXI hardware user manuals—If you are using SCXI, read these manuals next for detailed information about signal

connections and module configuration. They also explain in greater detail how the module works and contain application hints.

- Your DAQ hardware documentation—This documentation has detailed information about the DAQ hardware that plugs into or is connected to your computer. Use this documentation for hardware installation and configuration instructions, specification information about your DAQ hardware, and application hints.
- Software documentation—You may have both application software and NI-DAQ software documentation. National Instruments application software includes ComponentWorks, LabVIEW, LabWindows®/CVI, Measure, and VirtualBench. After you set up your hardware system, use either your application software documentation or the NI-DAQ documentation to help you write your application. If you have a large, complicated system, it is worthwhile to look through the software documentation before you configure your hardware.
- Accessory installation guides or manuals—If you are using accessory products, read the terminal block and cable assembly installation guides. They explain how to physically connect the relevant pieces of the system. Consult these guides when you are making your connections.
- *SCXI Chassis Manual*—If you are using SCXI, read this manual for maintenance information on the chassis and installation instructions.

Related Documentation

The following documents contain information you may find helpful:

- *DAQ-STC Technical Reference Manual*
- National Instruments Application Note 025, *Field Wiring and Noise Considerations for Analog Signals*
- *PCI Local Bus Specification Revision 2.0*

The following National Instruments manual contains detailed information for the register-level programmer:

- *PCI E Series Register-Level Programmer Manual*

  This manual is available from National Instruments by request. You should not need the register-level programmer manual if you are using National Instruments driver or application software. Using NI-DAQ, ComponentWorks, LabVIEW, LabWindows/CVI,

Measure, or VirtualBench software is easier than the low-level programming described in the register-level programmer manual.

Customer Communication

National Instruments wants to receive your comments on our products and manuals. We are interested in the applications you develop with our products, and we want to help if you have problems with them. To make it easy for you to contact us, this manual contains comment and configuration forms for you to complete. These forms are in Appendix D, *Customer Communication*, at the end of this manual.

Chapter 1

Introduction

This chapter describes the PCI E Series boards, lists what you need to get started, describes the optional software and optional equipment, and explains how to unpack your PCI E Series board.

About the PCI E Series

Thank you for buying a National Instruments PCI E Series board. The PCI E Series boards are completely Plug and Play, multifunction analog, digital, and timing I/O boards for PCI bus computers. This family of boards features 12-bit and 16-bit ADCs with 16 and 64 analog inputs, 12-bit and 16-bit DACs with voltage outputs, eight lines of TTL-compatible digital I/O, and two 24-bit counter/timers for timing I/O. Because the PCI E Series boards have no DIP switches, jumpers, or potentiometers, they are easily software-configured and calibrated.

The PCI E Series boards are completely switchless and jumperless data acquisition (DAQ) boards for the PCI bus. This feature is made possible by the National Instruments MITE bus interface chip that connects the board to the PCI I/O bus. The MITE implements the PCI Local Bus Specification so that the interrupts and base memory addresses are all software configured.

The PCI E Series boards use the National Instruments DAQ-STC system timing controller for time-related functions. The DAQ-STC consists of three timing groups that control analog input, analog output, and general-purpose counter/timer functions. These groups include a total of seven 24-bit and three 16-bit counters and a maximum timing resolution of 50 ns. The DAQ-STC makes possible such applications as buffered pulse generation, equivalent time sampling, and seamlessly changing the sampling rate.

Often with DAQ boards, you cannot easily synchronize several measurement functions to a common trigger or timing event. The PCI E Series boards have the Real-Time System Integration (RTSI) bus to solve this problem. The RTSI bus consists of our RTSI bus interface and

a ribbon cable to route timing and trigger signals between several functions on as many as five DAQ boards in your computer.

The PCI E Series boards can interface to an SCXI system so that you can acquire over 3,000 analog signals from thermocouples, RTDs, strain gauges, voltage sources, and current sources. You can also acquire or generate digital signals for communication and control. SCXI is the instrumentation front end for plug-in DAQ boards.

Detailed specifications of the PCI E Series boards are in Appendix A, *Specifications*.

What You Need to Get Started

To set up and use your PCI E Series board, you will need the following:

- ❑ One of the following boards:

PCI-MIO-16E-1	PCI-6031E
PCI-MIO-16E-4	PCI-6032E
PCI-MIO-16XE-10	PCI-6033E
PCI-MIO-16XE-50	PCI-6071E

- ❑ *PCI E Series User Manual*
- ❑ One of the following software packages and documentation:
  - ComponentWorks
  - LabVIEW for Macintosh
  - LabVIEW for Windows
  - LabWindows/CVI for Windows
  - Measure
  - NI-DAQ for Macintosh
  - NI-DAQ for PC Compatibles
  - VirtualBench
- ❑ Your computer

Software Programming Choices

You have several options to choose from when programming your National Instruments DAQ and SCXI hardware. You can use National Instruments application software, NI-DAQ, or register-level programming.

National Instruments Application Software

ComponentWorks contains tools for data acquisition and instrument control built on NI-DAQ driver software. ComponentWorks provides a higher-level programming interface for building virtual instruments through standard OLE controls and DLLs. With ComponentWorks, you can use all of the configuration tools, resource management utilities, and interactive control utilities included with NI-DAQ.

LabVIEW features interactive graphics, a state-of-the-art user interface, and a powerful graphical programming language. The LabVIEW Data Acquisition VI Library, a series of VIs for using LabVIEW with National Instruments DAQ hardware, is included with LabVIEW. The LabVIEW Data Acquisition VI Library is functionally equivalent to NI-DAQ software.

LabWindows/CVI features interactive graphics, state-of-the-art user interface, and uses the ANSI standard C programming language. The LabWindows/CVI Data Acquisition Library, a series of functions for using LabWindows/CVI with National Instruments DAQ hardware, is included with the NI-DAQ software kit. The LabWindows/CVI Data Acquisition Library is functionally equivalent to the NI-DAQ software.

VirtualBench features virtual instruments that combine DAQ products, software, and your computer to create a stand-alone instrument with the added benefit of the processing, display, and storage capabilities of your computer. VirtualBench instruments load and save waveform data to disk in the same forms that can be used in popular spreadsheet programs and word processors.

Using ComponentWorks, LabVIEW, LabWindows/CVI, or VirtualBench software will greatly reduce the development time for your data acquisition and control application.

NI-DAQ Driver Software

The NI-DAQ driver software is included at no charge with all National Instruments DAQ hardware. NI-DAQ is not packaged with SCXI or accessory products, except for the SCXI-1200. NI-DAQ has an extensive library of functions that you can call from your application programming environment. These functions include routines for analog input (A/D conversion), buffered data acquisition (high-speed A/D conversion), analog output (D/A conversion), waveform generation (timed D/A conversion), digital I/O, counter/timer operations, SCXI,

RTSI, self-calibration, messaging, and acquiring data to extended memory.

NI-DAQ has both high-level DAQ I/O functions for maximum ease of use and low-level DAQ I/O functions for maximum flexibility and performance. Examples of high-level functions are streaming data to disk or acquiring a certain number of data points. An example of a low-level function is writing directly to registers on the DAQ device. NI-DAQ does not sacrifice the performance of National Instruments DAQ devices because it lets multiple devices operate at their peak.

NI-DAQ also internally addresses many of the complex issues between the computer and the DAQ hardware such as programming interrupts and DMA controllers. NI-DAQ maintains a consistent software interface among its different versions so that you can change platforms with minimal modifications to your code. Whether you are using conventional programming languages or National Instruments application software, your application uses the NI-DAQ driver software, as illustrated in Figure 1-1.

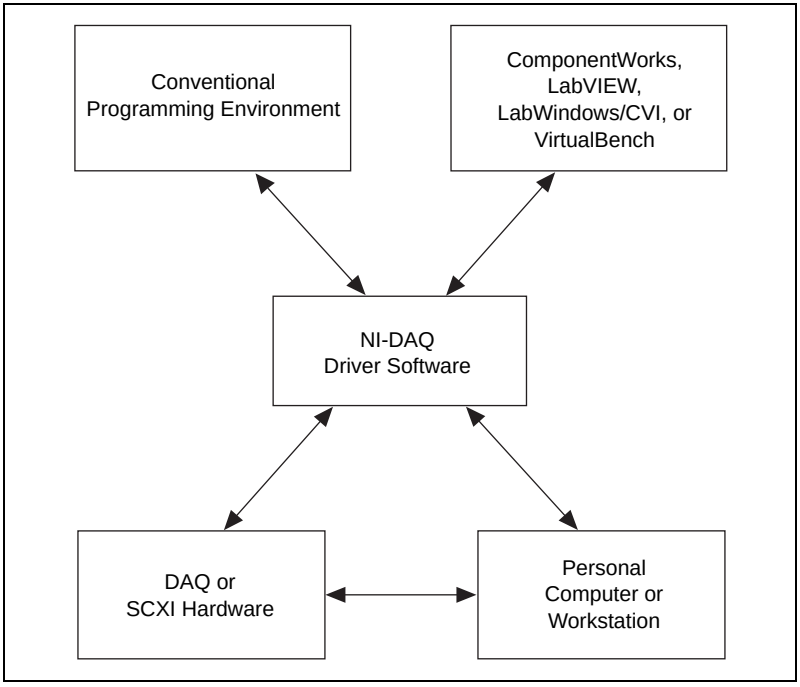


Figure 1-1. The Relationship between the Programming Environment, NI-DAQ, and Your Hardware

Register-Level Programming

The final option for programming any National Instruments DAQ hardware is to write register-level software. Writing register-level programming software can be very time-consuming and inefficient, and is not recommended for most users.

Even if you are an experienced register-level programmer, using NI-DAQ or application software to program your National Instruments DAQ hardware is easier than, and as flexible as, register-level programming, and can save weeks of development time.

Optional Equipment

National Instruments offers a variety of products to use with your PCI E Series board, including cables, connector blocks, and other accessories, as follows:

- Cables and cable assemblies, shielded and ribbon
- Connector blocks, shielded and unshielded 50 and 68-pin screw terminals
- Real Time System Integration (RTSI) bus cables
- SCXI modules and accessories for isolating, amplifying, exciting, and multiplexing signals for relays and analog output. With SCXI you can condition and acquire up to 3,072 channels.
- Low channel count signal conditioning modules, boards, and accessories, including conditioning for strain gauges and RTDs, simultaneous sample and hold, and relays

For more specific information about these products, refer to your National Instruments catalogue or call the office nearest you.

Custom Cabling

National Instruments offers cables and accessories for you to prototype your application or to use if you frequently change board interconnections.

If you want to develop your own cable, however, the following guidelines may be useful:

- For the analog input signals, shielded twisted-pair wires for each analog input pair yield the best results, assuming that you use differential inputs. Tie the shield for each signal pair to the ground reference at the source.
- You should route the analog lines separately from the digital lines.
- When using a cable shield, use separate shields for the analog and digital halves of the cable. Failure to do so results in noise coupling into the analog signals from transient digital signals.

The following list gives recommended part numbers for connectors that mate to the I/O connector on your PCI E Series board.

Mating connectors and a backshell kit for making custom 68-pin cables are available from National Instruments (part number 776832-01)

♦ PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-10, PCI-6032E, and the PCI-MIO-16XE-50

Honda 68-position, solder cup, female connector (part number PCS-E68FS)

Honda backshell (part number PCS-E68LKPA)

♦ PCI-6031E, PCI-6033E, and the PCI-6071E

AMP 100-position IDC male connector (part number 1-750913-9)

AMP backshell, 0.50 max O.D. cable (part number 749081-1)

AMP backshell, 0.55 max O.D. cable, (part number 749854-1)

Unpacking

Your PCI E Series board is shipped in an antistatic package to prevent electrostatic damage to the board. Electrostatic discharge can damage several components on the board. To avoid such damage in handling the board, take the following precautions:

- Ground yourself via a grounding strap or by holding a grounded object.
- Touch the antistatic package to a metal part of your computer chassis before removing the board from the package.
- Remove the board from the package and inspect the board for loose components or any other sign of damage. Notify National Instruments if the board appears damaged in any way. Do *not* install a damaged board into your computer.
- *Never* touch the exposed pins of connectors.

Installation and Configuration

Chapter 2

This chapter explains how to install and configure your PCI E Series board.

Software Installation

Install your software before you install your PCI E Series board. Refer to the appropriate release notes indicated below for specific instructions on the software installation sequence.

If you are using NI-DAQ, refer to your NI-DAQ release notes. Find the installation section for your operating system and follow the instructions given there.

If you are using LabVIEW, LabWindows/CVI, or other National Instruments application software packages, refer to the appropriate release notes. After you have installed your application software, refer to your NI-DAQ release notes and follow the instructions given there for your operating system and application software package.

If you are a register-level programmer, refer to the *PCI E Series Register-Level Programmer Manual* and the *DAQ-STC Technical Reference Manual* for software configuration information.

Hardware Installation

You can install a PCI E Series board in any available expansion slot in your computer. However, to achieve best noise performance, leave as much room as possible between the PCI E Series board and other boards and hardware. The following are general installation instructions, but consult your computer user manual or technical reference manual for specific instructions and warnings.

1. Write down the PCI E Series board serial number in the *PCI E Series Hardware and Software Configuration Form* in Appendix D, *Customer Communication*, of this manual.
2. Turn off and unplug your computer.

3. Remove the top cover or access port to the I/O channel.
4. Remove the expansion slot cover on the back panel of the computer.
5. Insert the PCI E Series board into a 5 V PCI slot. Gently rock the board to ease it into place. It may be a tight fit, but *do not force* the board into place.
6. If required, screw the mounting bracket of the PCI E Series board to the back panel rail of the computer.
7. Replace the cover.
8. Plug in and turn on your computer.

The PCI E Series board is installed. You are now ready to configure your software. Refer to your software documentation for configuration instructions.

Board Configuration

Due to the National Instruments standard architecture for data acquisition and the PCI bus specification, the PCI E Series boards are completely software configurable. You must perform two types of configuration on the PCI E Series boards—bus-related and data acquisition-related configuration.

The PCI E Series boards are fully compatible with the industry standard *PCI Local Bus Specification Revision 2.0*. This allows the PCI system to automatically perform all bus-related configurations and requires no user interaction. Bus-related configuration includes setting the board base memory address and interrupt channel.

Data-acquisition-related configuration includes such settings as analog input polarity and range, analog input mode, and others. You can modify these settings through application level software, such as NI-DAQ, ComponentWorks, LabVIEW, LabWindows/CVI, and VirtualBench.

Chapter 3

Hardware Overview

This chapter presents an overview of the hardware functions on your PCI E Series board.

Figure 3-1 shows a block diagram for the PCI-MIO-16E-1, PCI-MIO-16E-4, and the PCI-6071E.

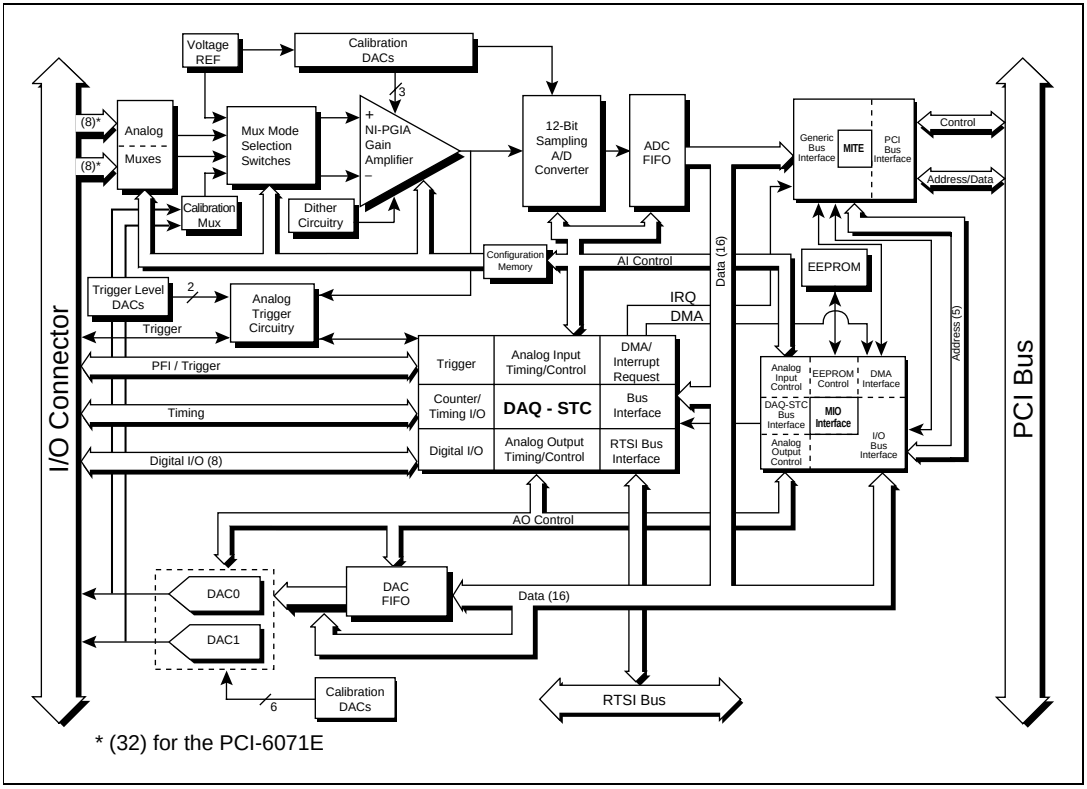


Figure 3-1. PCI-MIO-16E-1, PCI-MIO-16E-4 and PCI-6071E Block Diagram

Figure 3-2 shows a block diagram for the PCI-MIO-16XE-10 and PCI-6031E.

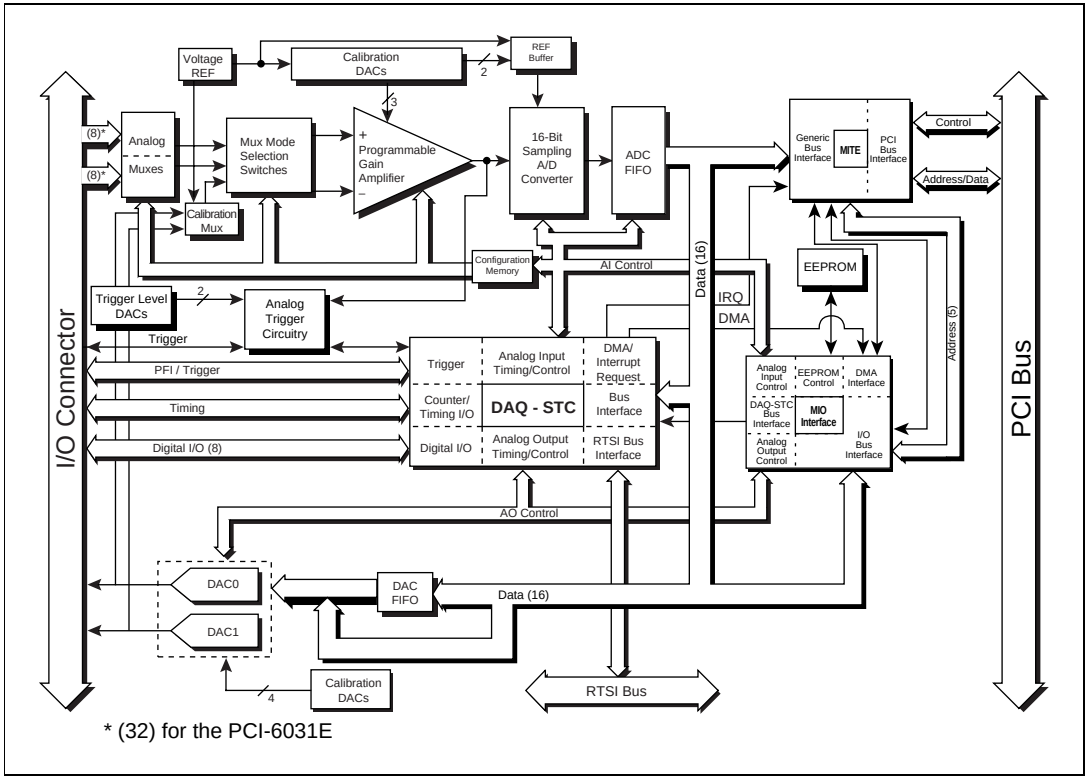


Figure 3-2. PCI-MIO-16XE-10 and PCI-6031E Block Diagram

Figure 3-3 shows a block diagram for the PCI-6032E and PCI-6033E.

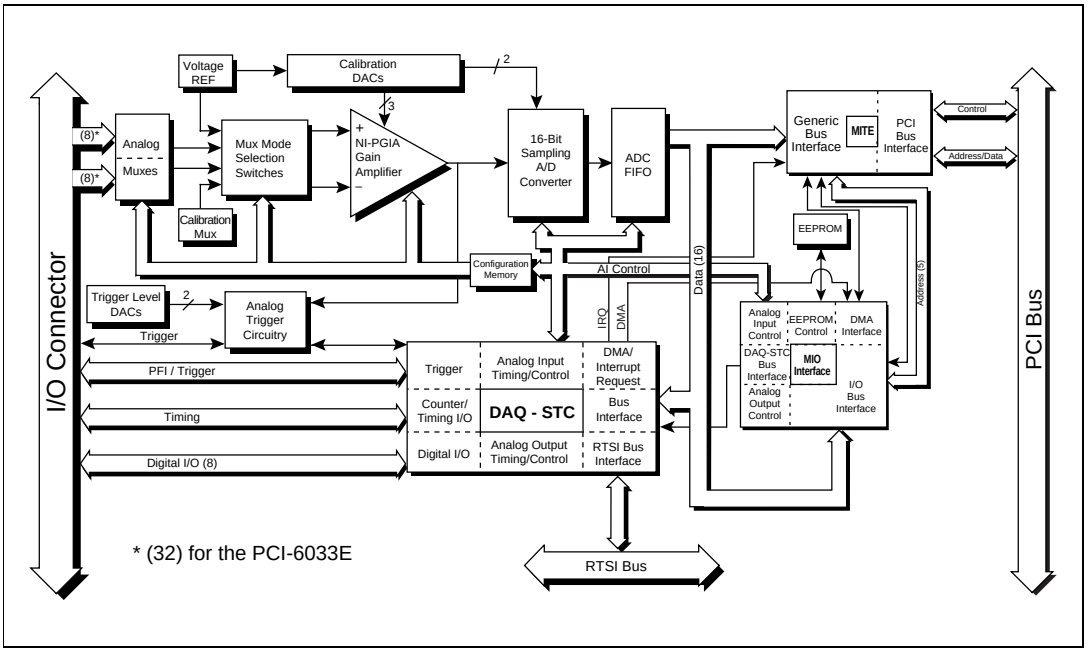


Figure 3-3. PCI-6032E and PCI-6033E Block Diagram

Figure 3-4 shows a block diagram for the PCI-MIO-16XE-50.

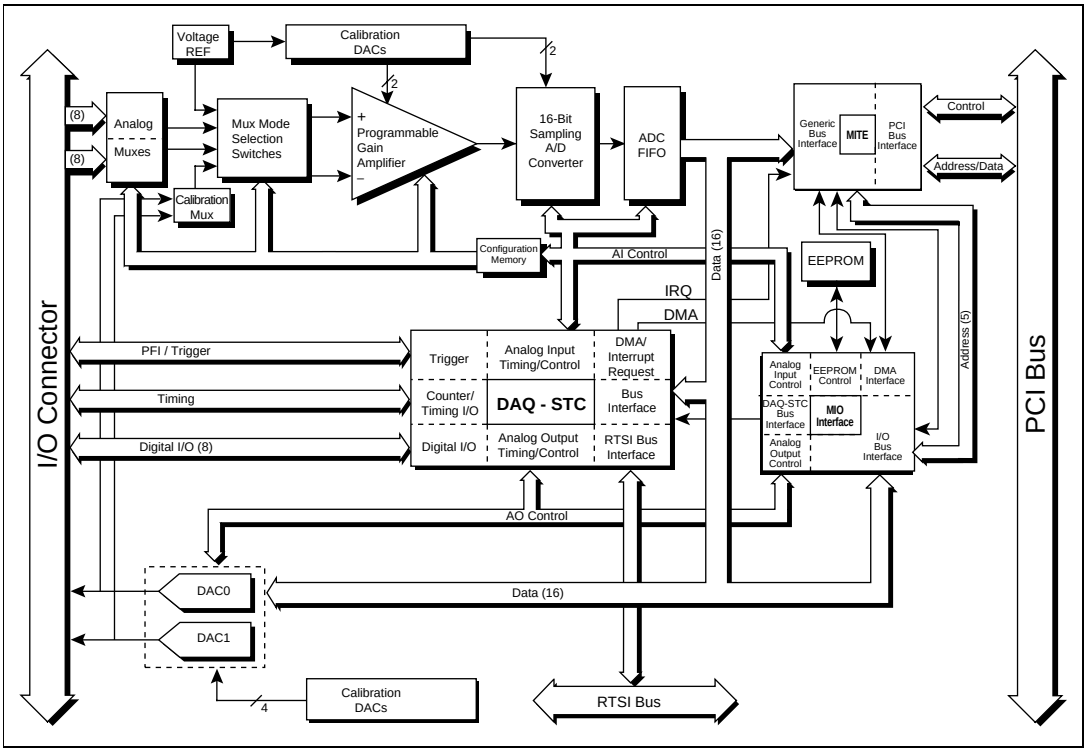


Figure 3-4. PCI-MIO-16XE-50 Block Diagram

Analog Input

The analog input section of each PCI E Series board is software configurable. You can select different analog input configurations through application software designed to control the PCI E Series boards. The following sections describe in detail each of the analog input categories.

Input Mode

The PCI E Series boards have three different input modes—nonreferenced single-ended (NRSE) input, referenced single-ended (RSE) input, and differential (DIFF) input. The single-ended input configurations provide up to 16 channels (64 channels on the PCI-6031E, PCI-6033E, and PCI-6071E). The DIFF input

configuration provides up to 8 channels (32 channels on the PCI-6031E, PCI-6033E, and the PCI-6071E). Input modes are programmed on a per channel basis for multimode scanning. For example, you can configure the circuitry to scan 12 channels—four differentially-configured channels and eight single-ended channels. Table 3-1 describes the three input configurations.

Table 3-1. Available Input Configurations for the PCI E Series

Configuration	Description
DIFF	A channel configured in DIFF mode uses two analog channel input lines. One line connects to the positive input of the board programmable gain instrumentation amplifier (PGIA), and the other connects to the negative input of the PGIA.
RSE	A channel configured in RSE mode uses one analog channel input line, which connects to the positive input of the PGIA. The negative input of the PGIA is internally tied to analog input ground (AIGND).
NRSE	A channel configured in NRSE mode uses one analog channel input line, which connects to the positive input of the PGIA. The negative input of the PGIA connects to the analog input sense (AISENSE) input.

For more information about the three types of input configuration, refer to the *Analog Input Signal Connections* section in Chapter 4, *Signal Connections*, which contains diagrams showing the signal paths for the three configurations.

Input Polarity and Input Range

- PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E

These boards have two input polarities—unipolar and bipolar. Unipolar input means that the input voltage range is between 0 and V_{ref}, where V_{ref} is a positive reference voltage. Bipolar input means that the input voltage range is between $-V_{ref}/2$ and $+V_{ref}/2$. So, these boards have a unipolar input range of 10 V (0 to 10 V) and a bipolar input range of 10 V (±5 V).

You can program polarity and range settings on a per channel basis so that you can configure each input channel uniquely.

The software-programmable gain on these boards increases their overall flexibility by matching the input signal ranges to those that the ADC can accommodate. They have gains of 0.5, 1, 2, 5, 10, 20, 50, and 100 and are suited for a wide variety of signal levels. With the proper gain setting, you can use the full resolution of the ADC to measure the input signal. Table 3-2 shows the overall input range and precision according to the input range configuration and gain used.

Table 3-2. Actual Range and Measurement Precision, PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E

Range Configuration	Gain	Actual Input Range	Precision[1]
0 to +10 V	1.0	0 to +10 V	2.44 mV
	2.0	0 to +5 V	1.22 mV
	5.0	0 to +2 V	488.28 µV
	10.0	0 to +1 V	244.14 µV
	20.0	0 to +500 mV	122.07 µV
	50.0	0 to +200 mV	48.83 µV
	100.0	0 to +100 mV	24.41 µV
-5 to +5 V	0.5	–10 to +10 V	4.88 mV
	1.0	–5 to +5 V	2.44 mV
	2.0	–2.5 to +2.5 V	1.22 mV
	5.0	–1 to +1 V	488.28 µV
	10.0	–500 to +500 mV	244.14 µV
	20.0	–250 to +250 mV	122.07 µV
	50.0	–100 to +100 mV	48.83 µV
	100.0	–50 to +50 mV	24.41 µV

[1] The value of 1 LSB of the 12-bit ADC; that is, the voltage increment corresponding to a change of one count in the ADC 12-bit count.

Note: ***See Appendix A**, Specifications, **for absolute maximum ratings**.*

- PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E, PCI-6032E, and PCI-6033E

  These boards have two input polarities—unipolar and bipolar. Unipolar input means that the input voltage range is between 0 and V_{ref}, where V_{ref} is a positive reference voltage. Bipolar input means that the input voltage range is between $-V_{ref}$ and $+V_{ref}$. So, these boards have a unipolar input range of 10 V (0 to 10 V) and a bipolar input range of 20 V (±10 V). You can program polarity and range settings on a per channel basis so that you can configure each input channel uniquely.

☞ **Note:** ***You can calibrate your PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E, PCI-6032E, and PCI-6033E analog input circuitry for either a unipolar or bipolar polarity. If you mix unipolar and bipolar channels in your scan list and you are using NI-DAQ, then NI-DAQ will load the calibration constants appropriate to the polarity for which analog input channel 0 is configured.***

The software-programmable gain on these boards increases their overall flexibility by matching the input signal ranges to those that the ADC can accommodate. The PCI-MIO-16XE-50 has gains of 1, 2, 10, and 100 and the other boards have gains of 1, 2, 5, 10, 20, 50, and 100. These gains are suited for a wide variety of signal levels. With the proper gain setting, you can use the full resolution of the ADC to measure the input signal.

Table 3-3 shows the overall input range and precision according to the input range configuration and gain used.

Table 3-3. Actual Range and Measurement Precision, PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E, PCI-6032E, and PCI-6033E

Range Configuration	Gain	Actual Input Range	Precision[1]
0 to +10 V	1.0	0 to +10 V	152.59 µV
	2.0	0 to +5 V	76.29 µV
	5.0[2]	0 to +2 V	30.52 µV
	10.0	0 to +1 V	15.26 µV
	20.0[2]	0 to +500 mV	7.63µV
	50.0[2]	0 to +200 mV	3.05 µV
	100.0	0 to 100 mV	1.53 µV
-10 to +10 V	1.0	–10 to +10 V	305.18 µV
	2.0	–5 to +5 V	152.59 µV
	5.0[2]	–2 to +2 V	61.04 µV
	10.0	–1 to +1 V	30.52 µV
	20.0[2]	–500 to +500 mV	15.26 µV
	50.0[2]	–200 to +200 mV	6.10 µV
	100.0	–100 to +100 mV	3.05 µV

[1] The value of 1 LSB of the 16-bit ADC; that is, the voltage increment corresponding to a change of one count in the ADC 16-bit count

[2] Not available on the PCI-MIO-16XE-50

Note: ***See Appendix A**, Specifications, **for absolute maximum ratings**.*

Considerations for Selecting Input Ranges

Which input polarity and range you select depends on the expected range of the incoming signal. A large input range can accommodate a large signal variation but reduces the voltage resolution. Choosing a smaller input range improves the voltage resolution but may result in the input signal going out of range. For best results, match the input range as closely as possible to the expected range of the input signal. For example, if you are certain the input signal will not be negative (below 0 V), unipolar input polarity is best. However, if the signal is negative or equal to zero, you will get inaccurate readings if you use unipolar input polarity.

Dither

When you enable dither, you add approximately 0.5 LSBrms of white Gaussian noise to the signal to be converted by the ADC. This addition is useful for applications involving averaging to increase the resolution of your PCI E Series board, as in calibration or spectral analysis. In such applications, noise modulation is decreased and differential linearity is improved by the addition of the dither. When taking DC measurements, such as when checking the board calibration, you should enable dither and average about 1,000 points to take a single reading. This process removes the effects of quantization and reduces measurement noise, resulting in improved resolution. For high-speed applications not involving averaging or spectral analysis, you may want to disable the dither to reduce noise. Your software enables and disables the dither circuitry.

Figure 3-5 illustrates the effect of dither on signal acquisition. Figure 3-5a shows a small (±4 LSB) sine wave acquired with dither off. The ADC quantization is clearly visible. Figure 3-5b shows what happens when 50 such acquisitions are averaged together; quantization is still plainly visible. In Figure 3-5c, the sine wave is acquired with dither on. There is a considerable amount of visible noise. But averaging about 50 such acquisitions, as shown in Figure 3-5d, eliminates both the added noise and the effects of quantization. Dither has the effect of forcing quantization noise to become a zero-mean random variable rather than a deterministic function of the input signal.

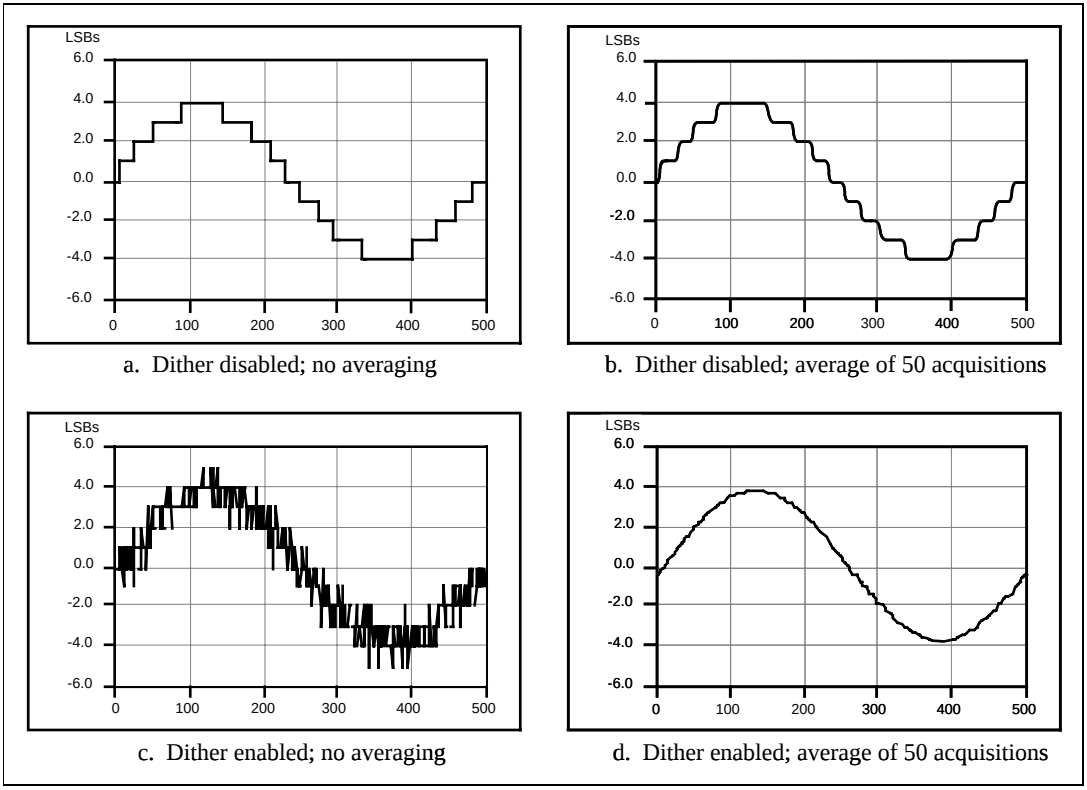


Figure 3-5. Dither

You cannot disable dither on the PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E, PCI-6032E, or PCI-6033E. This is because the ADC resolution is so fine that the ADC and the PGIA inherently produce almost 0.5 LSBrms of noise. This is equivalent to having a dither circuit that is always enabled.

Multichannel Scanning Considerations

Most of the PCI E Series boards can scan multichannels at the same maximum rate as their single-channel rate; however, pay careful attention to the settling times for each of the boards. The settling time for most of the PCI E Series boards is independent of the selected gain, even at the maximum sampling rate. The settling time for the very high-speed boards is gain dependent, which can affect the useful sampling rate for a given gain. No extra settling time is necessary

between channels as long as the gain is constant and source impedances are low. Refer to Appendix A, *Specifications*, for a complete listing of settling times for each of the PCI E Series boards.

When scanning among channels at various gains, the settling times may increase. When the PGIA switches to a higher gain, the signal on the previous channel may be well outside the new, smaller range. For instance, suppose a 4 V signal is connected to channel 0 and a 1 mV signal is connected to channel 1, and suppose the PGIA is programmed to apply a gain of one to channel 0 and a gain of 100 to channel 1. When the multiplexer switches to channel 1 and the PGIA switches to a gain of 100, the new full-scale range is 100 mV (if the ADC is in unipolar mode).

The approximately 4 V step from 4 V to 1 mV is 4,000% of the new full-scale range. For a 16-bit board to settle within 0.0015% (15 ppm or 1 LSB) of the 100 mV full-scale range on channel 1, the input circuitry has to settle within 0.00004% (0.4 ppm or 1/400 LSB) of the 4 V step. It may take as long as 200 µs for the circuitry to settle this much. In general, this extra settling time is not needed when the PGIA is switching to a lower gain.

Settling times can also increase when scanning high-impedance signals due to a phenomenon called *charge injection*, where the analog input multiplexer injects a small amount of charge into each signal source when that source is selected. If the impedance of the source is not low enough, the effect of the charge—a voltage error—will not have decayed by the time the ADC samples the signal. For this reason, keep source impedances under 1 kΩ to perform high-speed scanning.

Due to the previously described limitations of settling times resulting from these conditions, multichannel scanning is not recommended unless sampling rates are low enough or it is necessary to sample several signals as nearly simultaneously as possible. The data is much more accurate and channel-to-channel independent if you acquire data from each channel independently (for example, 100 points from channel 0, then 100 points from channel 1, then 100 points from channel 2, and so on).

Analog Output

- PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E

  These boards supply two channels of analog output voltage at the I/O connector. The reference and range for the analog output circuitry is software selectable. The reference can be either internal or external, whereas the range can be either bipolar or unipolar.

- PCI-MIO-16XE-10 and PCI-6031E

  These boards supply two channels of analog output voltage at the I/O connector. The range is software-selectable between unipolar (0 to 10 V) and bipolar (±10 V).

- PCI-MIO-16XE-50

  This board supplies two channels of analog output voltage at the I/O connector. The range is fixed at bipolar ±10 V.

Analog Output Reference Selection

- PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E

  You can connect each D/A converter (DAC) to these PCI E Series boards' internal reference of 10 V or to the external reference signal connected to the external reference (EXTREF) pin on the I/O connector. This signal applied to EXTREF should be within ±11 V. You do not need to configure both channels for the same mode.

Analog Output Polarity Selection

- PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E

  You can configure each analog output channel for either unipolar or bipolar output. A unipolar configuration has a range of 0 to V_{ref} at the analog output. A bipolar configuration has a range of $-V_{ref}$ to $+V_{ref}$ at the analog output. V_{ref} is the voltage reference used by the DACs in the analog output circuitry and can be either the +10 V onboard reference or an externally supplied reference within ±11 V. You do not need to configure both channels for the same range.

Selecting a bipolar range for a particular DAC means that any data written to that DAC will be interpreted as two's complement format. In two's complement mode, data values written to the analog output channel can be either positive or negative. If you select unipolar range, data is interpreted in straight binary format. In straight binary mode, data values written to the analog output channel range must be positive.

- PCI-MIO-16XE-10 and PCI-6031E

  You can configure each analog output channel for either unipolar or bipolar output. A unipolar configuration has a range of 0 to 10 V at the analog output. A bipolar configuration has a range of –10 to +10 V at the analog output. You do not need to configure both channels for the same range.

  Selecting a bipolar range for a particular DAC means that any data written to that DAC will be interpreted as two's complement format. In two's complement mode, data values written to the analog output channel can be either positive or negative. If you select unipolar range, data is interpreted in straight binary format. In straight binary mode, data values written to the analog output channel range must be positive.

Analog Output Reglitch Selection

- PCI-MIO-16E-1 and PCI-6071E

  In normal operation, a DAC output will glitch whenever it is updated with a new value. The glitch energy differs from code to code and appears as distortion in the frequency spectrum. Each analog output contains a reglitch circuit that generates uniform glitch energy at every code rather than large glitches at the major code transitions. This uniform glitch energy appears as a multiple of the update rate in the frequency spectrum. Notice that this reglitch circuit does *not* eliminate the glitches; it only makes them more uniform in size. Reglitching is normally disabled at startup and your software can independently enable each channel.

Analog Trigger

- PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, PCI-6033E, and PCI-6071E

  In addition to supporting internal software triggering and external digital triggering to initiate a data acquisition sequence, these boards also support analog triggering. You can configure the analog trigger circuitry to accept either a direct analog input from the PFI0/TRIG1 pin on the I/O connector or a postgain signal from the output of the PGIA, as shown in Figure 3-6. The trigger-level range for the direct analog channel is ±10 V in 78 mV steps for the PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E, and ±10 V in 4.9 mV steps for the PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, and PCI-6033E. The range for the post-PGIA trigger selection is simply the full-scale range of the selected channel, and the resolution is that range divided by 256 for the PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E and divided by 4,096 for the PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, and PCI-6033E.

☞ **Note:** ***The PFI0/TRIG1 pin is an analog input when configured as an analog trigger. Therefore, it is susceptible to crosstalk from adjacent pins, which can result in false triggering when the pin is left unconnected. To avoid false triggering, make sure this pin is connected to a low-impedance signal source (less than 1 kΩ source impedance) if you plan to enable this input via software.***

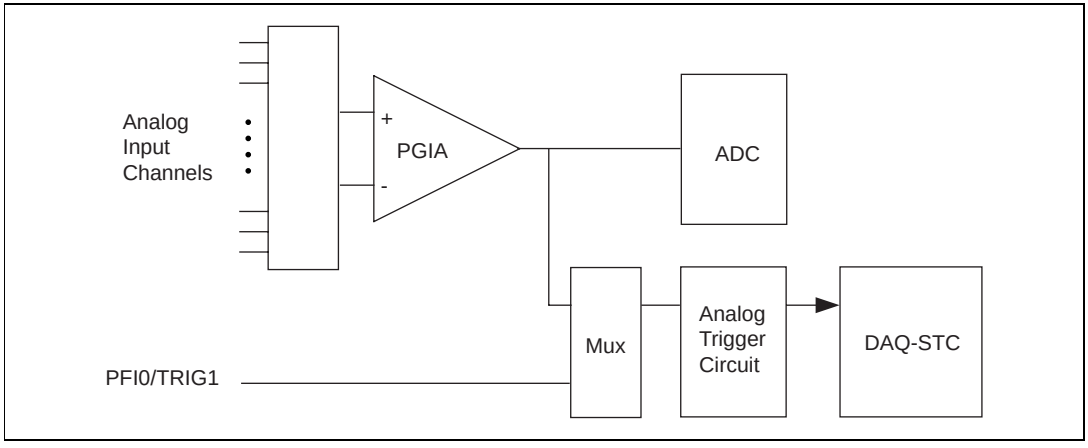


Figure 3-6. Analog Trigger Block Diagram

There are five analog triggering modes available, as shown in Figures 3-7 through 3-11. You can set **lowValue** and **highValue** independently in software.

In below-low-level analog triggering mode, the trigger is generated when the signal value is less than **lowValue**. **HighValue** is unused.

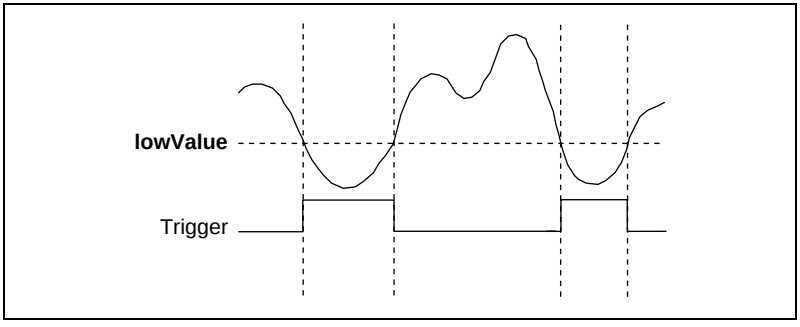


Figure 3-7. Below-Low-Level Analog Triggering Mode

In above-high-level analog triggering mode, the trigger is generated when the signal value is greater than **highValue**. **LowValue** is unused.

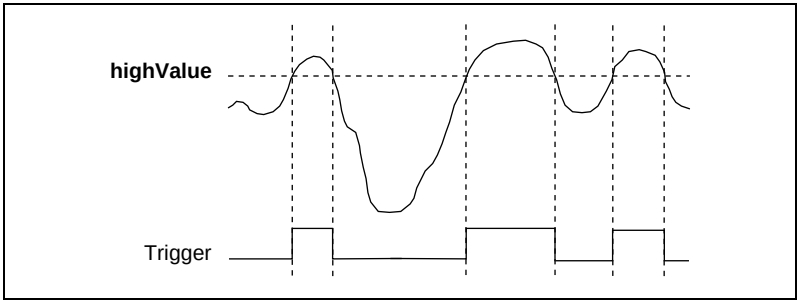


Figure 3-8. Above-High-Level Analog Triggering Mode

In inside-region analog triggering mode, the trigger is generated when the signal value is between the **lowValue** and the **highValue.**

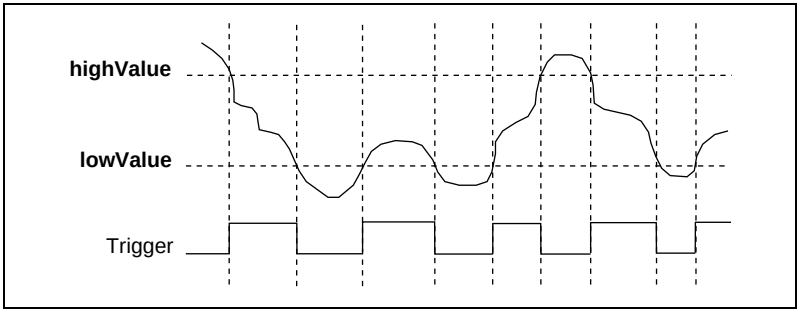


Figure 3-9. Inside-Region Analog Triggering Mode

In high-hysteresis analog triggering mode, the trigger is generated when the signal value is greater than **highValue**, with the hysteresis specified by **lowValue**.

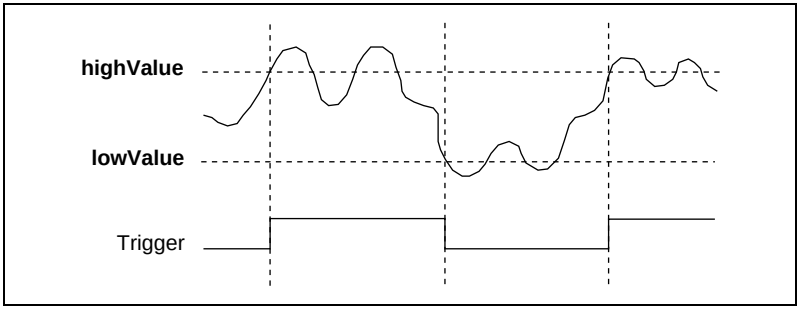


Figure 3-10. High-Hysteresis Analog Triggering Mode

In low-hysteresis analog triggering mode, the trigger is generated when the signal value is less than **lowValue**, with the hysteresis specified by **highValue.**

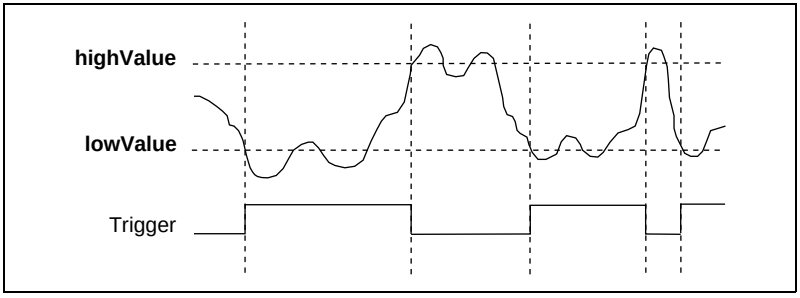


Figure 3-11. Low-Hysteresis Analog Triggering Mode

The analog trigger circuit generates an internal digital trigger based on the analog input signal and the user-defined trigger levels. This digital trigger can be used by any of the timing sections of the DAQ-STC, including the analog input, analog output, and general-purpose counter/timer sections. For example, the analog input section can be configured to acquire *n* scans after the analog input signal crosses a specific threshold. As another example, the analog output section can be configured to update its outputs whenever the analog input signal crosses a specific threshold.

Digital I/O

The PCI E Series boards contain eight lines of digital I/O for general-purpose use. You can individually software-configure each line for either input or output. At system startup and reset, the digital I/O ports are all high impedance.

The hardware up/down control for general-purpose counters 0 and 1 are connected onboard to DIO6 and DIO7, respectively. Thus, you can use DIO6 and DIO7 to control the general-purpose counters. The up/down control signals are input only and do not affect the operation of the DIO lines.

Timing Signal Routing

The DAQ-STC provides a very flexible interface for connecting timing signals to other boards or external circuitry. Your PCI E Series board uses the RTSI bus to interconnect timing signals between boards, and the Programmable Function Input (PFI) pins on the I/O connector to connect the board to external circuitry. These connections are designed

to enable the PCI E Series board to both control and be controlled by other boards and circuits.

There are a total of 13 timing signals internal to the DAQ-STC that can be controlled by an external source. These timing signals can also be controlled by signals generated internally to the DAQ-STC, and these selections are fully software configurable. For example, the signal routing multiplexer for controlling the CONVERT* signal is shown in Figure 3-12.

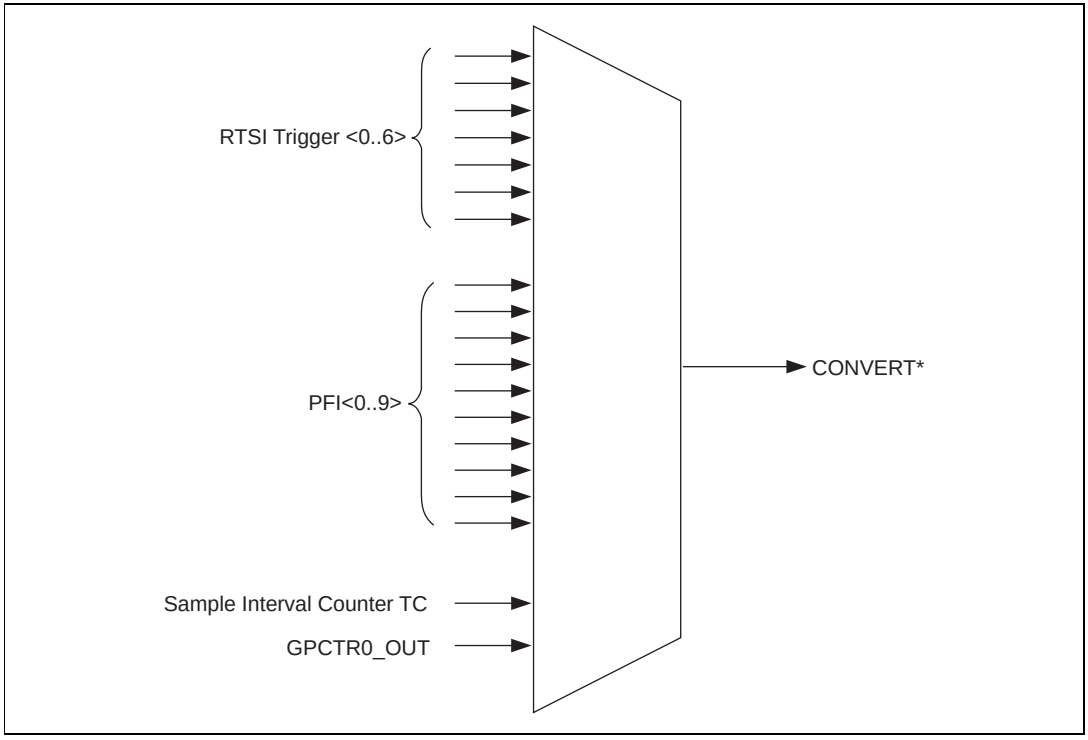


Figure 3-12. CONVERT* Signal Routing

This figure shows that CONVERT* can be generated from a number of sources, including the external signals RTSI<0..6> and PFI<0..9> and the internal signals Sample Interval Counter TC and GPCTR0_OUT.

Many of these timing signals are also available as outputs on the RTSI pins, as indicated in the *RTSI Triggers* section later in this chapter, and on the PFI pins, as indicated in Chapter 4, *Signal Connections*.

Programmable Function Inputs

The 10 PFIs are connected to the signal routing multiplexer for each timing signal, and software can select one of the PFIs as the external source for a given timing signal. It is important to note that any of the PFIs can be used as an input by any of the timing signals and that multiple timing signals can use the same PFI simultaneously. This flexible routing scheme reduces the need to change physical connections to the I/O connector for different applications. You can also individually enable each of the PFI pins to output a specific internal timing signal. For example, if you need the UPDATE* signal as an output on the I/O connector, software can turn on the output driver for the PFI5/UPDATE* pin.

Board and RTSI Clocks

Many functions performed by the PCI E Series boards require a frequency timebase to generate the necessary timing signals for controlling A/D conversions, DAC updates, or general-purpose signals at the I/O connector.

A PCI E Series board can use either its internal 20 MHz timebase or a timebase received over the RTSI bus. In addition, if you configure the board to use the internal timebase, you can also program the board to drive its internal timebase over the RTSI bus to another board that is programmed to receive this timebase signal. This clock source, whether local or from the RTSI bus, is used directly by the board as the primary frequency source. The default configuration at startup is to use the internal timebase without driving the RTSI bus timebase signal. This timebase is software selectable.

RTSI Triggers

The seven RTSI trigger lines on the RTSI bus provide a very flexible interconnection scheme for any PCI E Series board sharing the RTSI bus. These bidirectional lines can drive any of eight timing signals onto the RTSI bus and can receive any of these timing signals. This signal connection scheme is shown in Figure 3-13.

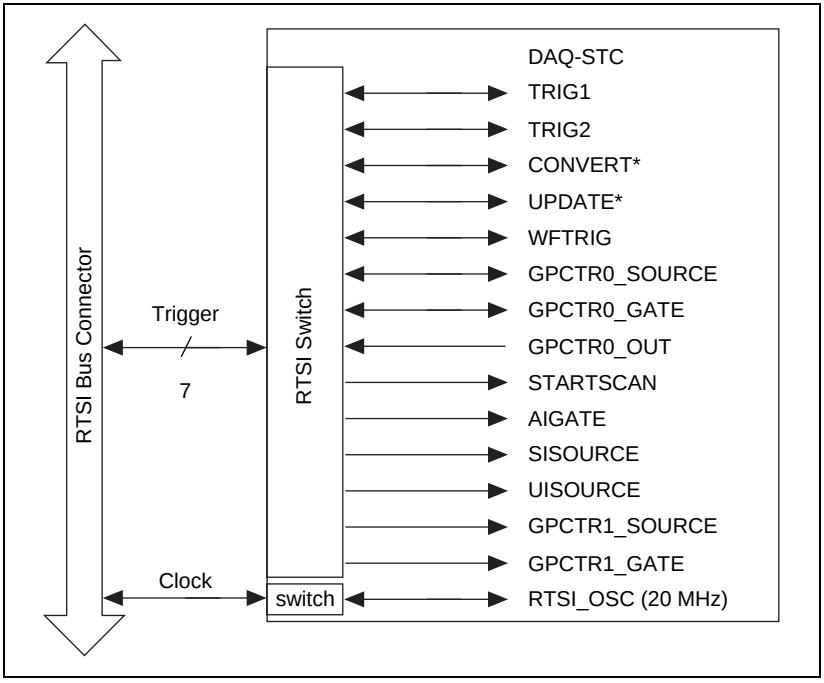


Figure 3-13. RTSI Bus Signal Connection

Refer to the *Timing Connections* section of Chapter 4, *Signal Connections*, for a description of the signals shown in Figure 3-13.

Chapter 4

Signal Connections

This chapter describes how to make input and output signal connections to your PCI E Series board via the board I/O connector.

The I/O connector for the PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-10, PCI-MIO-16XE-50, and PCI-6032E has 68 pins that you can connect to 68-pin accessories with the SH6868 shielded cable or the R6868 ribbon cable. With the SH6850 shielded cable or R6850 ribbon cable, you can connect your board to 50-pin signal conditioning modules and terminal blocks.

The I/O connector for the PCI-6031E, PCI-6033E, and PCI-6071E has 100 pins that you can connect to 100-pin accessories with the SH100100 shielded cable. With the SH1006868 shielded cable you can connect your board to 68-pin accessories, and with the R1005050 ribbon cable you can connect your board to 50-pin accessories.

I/O Connector

Figure 4-1 shows the pin assignments for the 68-pin I/O connector on the PCI-MIO-16XE-10, PCI-6032E, PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-MIO-16XE-50. Figure 4-2 shows the pin assignments for the 100-pin I/O connector on the PCI-6031E, PCI-6033E, and PCI-6071E. Refer to Appendix B, *Optional Cable Connector Descriptions*, for the pin assignments for the 50-pin connector. A signal description follows the connector pinouts.

Caution: ***Connections that exceed any of the maximum ratings of input or output signals on the PCI E Series boards can damage the PCI E Series board and the computer. Maximum input ratings for each signal are given in the*** *Protection* ***column of Tables 4-1, 4-2, and 4-3. National Instruments is NOT liable for any damages resulting from such signal connections.***

ACH8	34	68	ACH0
ACH1	33	67	AIGND
AIGND	32	66	ACH9
ACH10	31	65	ACH2
ACH3	30	64	AIGND
AIGND	29	63	ACH11
ACH4	28	62	AISENSE
AIGND	27	61	ACH12
ACH13	26	60	ACH5
ACH6	25	59	AIGND
AIGND	24	58	ACH14
ACH15	23	57	ACH7
DAC0OUT[1]	22	56	AIGND
DAC1OUT[1]	21	55	AOGND
EXTREF[2]	20	54	AOGND
DIO4	19	53	DGND
DGND	18	52	DIO0
DIO1	17	51	DIO5
DIO6	16	50	DGND
DGND	15	49	DIO2
+5 V	14	48	DIO7
DGND	13	47	DIO3
DGND	12	46	SCANCLK
PFI0/TRIG1	11	45	EXTSTROBE*
PFI1/TRIG2	10	44	DGND
DGND	9	43	PFI2/CONVERT*
+5 V	8	42	PFI3/GPCTR1_SOURCE
DGND	7	41	PFI4/GPCTR1_GATE
PFI5/UPDATE*	6	40	GPCTR1_OUT
PFI6/WFTRIG	5	39	DGND
DGND	4	38	PFI7/STARTSCAN
PFI9/GPCTR0_GATE	3	37	PFI8/GPCTR0_SOURCE
GPCTR0_OUT	2	36	DGND
FREQ_OUT	1	35	DGND

[1] Not available on the PCI-6032E

[2] Not available on the PCI-MIO-16XE-10, PCI-MIO-16XE-50, or PCI-6032E

Figure 4-1. I/O Connector Pin Assignment for the PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-50, PCI-MIO-16XE-10, and PCI-6032E

AIGND	1	51	ACH16
AIGND	2	52	ACH24
ACH0	3	53	ACH17
ACH8	4	54	ACH25
ACH1	5	55	ACH18
ACH9	6	56	ACH26
ACH2	7	57	ACH19
ACH10	8	58	ACH27
ACH3	9	59	ACH20
ACH11	10	60	ACH28
ACH4	11	61	ACH21
ACH12	12	62	ACH29
ACH5	13	63	ACH22
ACH13	14	64	ACH30
ACH6	15	65	ACH23
ACH14	16	66	ACH31
ACH7	17	67	ACH32
ACH15	18	68	ACH40
AISENSE	19	69	ACH33
DAC0OUT[1]	20	70	ACH41
DAC1OUT[1]	21	71	ACH34
EXTREF[2]	22	72	ACH42
AOGND	23	73	ACH35
DGND	24	74	ACH43
DIO0	25	75	AISENSE2
DIO4	26	76	AIGND
DIO1	27	77	ACH36
DIO5	28	78	ACH44
DIO2	29	79	ACH37
DIO6	30	80	ACH45
DIO3	31	81	ACH38
DIO7	32	82	ACH46
DGND	33	83	ACH39
+5 V	34	84	ACH47
+5 V	35	85	ACH48
SCANCLK	36	86	ACH56
EXTSTROBE*	37	87	ACH49
PFI0/TRIG1	38	88	ACH57
PFI1/TRIG2	39	89	ACH50
PFI2/CONVERT*	40	90	ACH58
PFI3/GPCTR1_SOURCE	41	91	ACH51
PFI4/GPCTR1_GATE	42	92	ACH59
GPCTR1_OUT	43	93	ACH52
PFI5/UPDATE*	44	94	ACH60
PFI6/WFTRIG	45	95	ACH53
PFI7/STARTSCAN	46	96	ACH61
PFI8/GPCTR0_SOURCE	47	97	ACH54
PFI9/GPCTR0_GATE	48	98	ACH62
GPCTR0_OUT	49	99	ACH55
FREQ_OUT	50	100	ACH63

[1] Not available on the PCI-6033E

[2] Not available on the PCI-6031E or PCI-6033E

Figure 4-2. I/O Connector Pin assignment for the PCI-6071E, 6031E, and 6033E

I/O Connector Signal Descriptions

Signal Name	Reference	Direction	Description
AIGND	—	—	Analog Input Ground—These pins are the reference point for single-ended measurements in RSE configuration and the bias current return point for differential measurements. All three ground references—AIGND, AOGND, and DGND—are connected together on your PCI E Series board.
ACH<0..15>	AIGND	Input	Analog Input Channels 0 through 15—Each channel pair, ACH<*i*, *i*+8> (*i* = 0..7), can be configured as either one differential input or two single-ended inputs.
ACH<16..63>	AIGND	Input	Analog Input Channels 16 through 63 (PCI-6031E, PCI-6033E, PCI-6071E only)—Each channel pair, ACH<*i*, *i*+8> (*i* = 16..23, 32..39, 48..55), can be configured as either one differential input or two single-ended inputs.
AISENSE	AIGND	Input	Analog Input Sense—This pin serves as the reference node for any of channels ACH <0..15> in NRSE configuration.
AISENSE2	AIGND	Input	Analog Input Sense (PCI-6031E, PCI-6033E, and PCI-6071E only)—This pin serves as the reference node for any of channels ACH <16..63> in NRSE configuration.
DAC0OUT	AOGND	Output	Analog Channel 0 Output—This pin supplies the voltage output of analog output channel 0. This pin is *not* available on the PCI-6032E or PCI-6033E.
DAC1OUT	AOGND	Output	Analog Channel 1 Output—This pin supplies the voltage output of analog output channel 1. This pin is *not* available on the PCI-6032E or PCI-6033E.
EXTREF	A0GND	Input	External Reference—This is the external reference input for the analog output circuitry. This pin is *not* available on the PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E, PCI-6032E, or PCI-6033E.
AOGND	—	—	Analog Output Ground—The analog output voltages are referenced to this node. All three ground references—AIGND, AOGND, and DGND—are connected together on your PCI E Series board.
DGND	—	—	Digital Ground—This pin supplies the reference for the digital signals at the I/O connector as well as the +5 VDC supply. All three ground references—AIGND, AOGND, and DGND—are connected together on your PCI E Series board.

Signal Name	Reference	Direction	Description
DIO<0..7>	DGND	Input or Output	Digital I/O signals—DIO6 and 7 can control the up/down signal of general-purpose counters 0 and 1, respectively.
+5 V	DGND	Output	+5 VDC Source—These pins are fused for up to 1 A of +5 V supply. The fuse is self-resetting.
SCANCLK	DGND	Output	Scan Clock—This pin pulses once for each A/D conversion in the scanning modes when enabled. The low-to-high edge indicates when the input signal can be removed from the input or switched to another signal.
EXTSTROBE*	DGND	Output	External Strobe—This output can be toggled under software control to latch signals or trigger events on external devices.
PFI0/TRIG1	DGND	Input	PFI0/Trigger 1—As an input, this is either one of the Programmable Function Inputs (PFIs) or the source for the hardware analog trigger. PFI signals are explained in the Timing Connections section later in this chapter. The hardware analog trigger is explained in the *Analog Trigger* section in Chapter 2, *Installation and Configuration*. Analog trigger is available only on the PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, PCI-6033E, and the PCI-6071E.
		Output	As an output, this is the TRIG1 signal. In posttrigger data acquisition sequences, a low-to-high transition indicates the initiation of the acquisition sequence. In pretrigger applications, a low-to-high transition indicates the initiation of the pretrigger conversions.
PFI1/TRIG2	DGND	Input	PFI1/Trigger 2—As an input, this is one of the PFIs.
		Output	As an output, this is the TRIG2 signal. In pretrigger applications, a low-to-high transition indicates the initiation of the posttrigger conversions. TRIG2 is not used in posttrigger applications.
PFI2/CONVERT*	DGND	Input	PFI2/Convert—As an input, this is one of the PFIs.
		Output	As an output, this is the CONVERT* signal. A high-to-low edge on CONVERT* indicates that an A/D conversion is occurring.
PFI3/GPCTR1_SOURCE	DGND	Input	PFI3/Counter 1 Source—As an input, this is one of the PFIs.
		Output	As an output, this is the GPCTR1_SOURCE signal. This signal reflects the actual source connected to the general-purpose counter 1.

Signal Name	Reference	Direction	Description
PFI4/GPCTR1_GATE	DGND	Input	PFI4/Counter 1 Gate—As an input, this is one of the PFIs.
		Output	As an output, this is the GPCTR1_GATE signal. This signal reflects the actual gate signal connected to the general-purpose counter 1.
GPCTR1_OUT	DGND	Output	Counter 1 Output—This output is from the general-purpose counter 1 output.
PFI5/UPDATE*	DGND	Input	PFI5/Update—As an input, this is one of the PFIs.
		Output	As an output, this is the UPDATE* signal. A high-to-low edge on UPDATE* indicates that the analog output primary group is being updated.
PFI6/WFTRIG	DGND	Input	PFI6/Waveform Trigger—As an input, this is one of the PFIs.
		Output	As an output, this is the WFTRIG signal. In timed analog output sequences, a low-to-high transition indicates the initiation of the waveform generation.
PFI7/STARTSCAN	DGND	Input	PFI7/Start of Scan—As an input, this is one of the PFIs.
		Output	As an output, this is the STARTSCAN signal. This pin pulses once at the start of each analog input scan in the interval scan. A low-to-high transition indicates the start of the scan.
PFI8/GPCTR0_SOURCE	DGND	Input	PFI8/Counter 0 Source—As an input, this is one of the PFIs.
		Output	As an output, this is the GPCTR0_SOURCE signal. This signal reflects the actual source connected to the general-purpose counter 0.
PFI9/GPCTR0_GATE	DGND	Input	PFI9/Counter 0 Gate—As an input, this is one of the PFIs.
		Output	As an output, this is the GPCTR0_GATE signal. This signal reflects the actual gate signal connected to the general-purpose counter 0.
GPCTR0_OUT	DGND	Output	Counter 0 Output—This output is from the general-purpose counter 0 output.
FREQ_OUT	DGND	Output	Frequency Output—This output is from the frequency generator output.

Table 4-1 shows the I/O signal summary for the PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E.

Table 4-1. I/O Signal Summary, PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E

Signal Name	Signal Type and Direction	Impedance Input/ Output	Protection (Volts) On/Off	Source (mA at V)	Sink (mA at V)	Rise Time (ns)	Bias
ACH<0..63>	AI	100 GΩ in parallel with 100 pF	25/15	—	—	—	±200 pA
AISENSE, AISENSE2	AI	100 GΩ in parallel with 100 pF	25/15	—	—	—	±200 pA
AIGND	AO	—	—	—	—	—	—
DAC0OUT	AO	0.1 Ω	Short-circuit to ground	5 at 10	5 at -10	20 V/µs	—
DAC1OUT	AO	0.1 Ω	Short-circuit to ground	5 at 10	5 at -10	20 V/µs	—
EXTREF	AI	10 kΩ	25/15	—	—	—	—
AOGND	AO	—	—	—	—	—	—
DGND	DO	—	—	—	—	—	—
VCC	DO	0.1 Ω	Short-circuit to ground	1A	—	—	—
DIO<0..7>	DIO	—	V_{cc} +0.5	13 at (V_{cc} -0.4)	24 at 0.4	1.1	50 kΩ pu
SCANCLK	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
EXTSTROBE*	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI0/TRIG1	AI DIO	10 kΩ	±35 V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	9 kΩ pu and 10 kΩ pd
PFI1/TRIG2	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI2/CONVERT*	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu

Table 4-1. I/O Signal Summary, PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E (Continued)

Signal Name	Signal Type and Direction	Impedance Input/ Output	Protection (Volts) On/Off	Source (mA at V)	Sink (mA at V)	Rise Time (ns)	Bias
PFI3/GPCTR1_SOURCE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI4/GPCTR1_GATE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
GPCTR1_OUT	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI5/UPDATE*	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI6/WFTRIG	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI7/STARTSCAN	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI8/GPCTR0_SOURCE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI9/GPCTR0_GATE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
GPCTR0_OUT	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
FREQ_OUT	DO	—	—	3.5 at (V_{cc}-0.4)	5 at 0.4	1.5	50 kΩ pu

AI = Analog Input DIO = Digital Input/Output pu = pullup
AO = Analog Output DO = Digital Output AI/DIO = Analog/Digital Input/Output

Note: ***The tolerance on the 50 kΩ pullup and pulldown resistors is very large. Actual value may range between 17 kΩ and 100 kΩ.***

Table 4-2 shows the I/O signal summary for the PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, and PCI-6033E.

Table 4-2. I/O Signal Summary, PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, and PCI-6033E

Signal Name	Signal Type and Direction	Impedance Input/ Output	Protection (Volts) On/Off	Source (mA at V)	Sink (mA at V)	Rise Time (ns)	Bias
ACH<0..63>	AI	100 GΩ in parallel with 100 pF	25/15	—	—	—	±1 nA
AISENSE, AISENSE2	AI	100 GΩ in parallel with 100 pF	25/15	—	—	—	±1 nA

Table 4-2. I/O Signal Summary, PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, and PCI-6033E (Continued)

Signal Name	Signal Type and Direction	Impedance Input/ Output	Protection (Volts) On/Off	Source (mA at V)	Sink (mA at V)	Rise Time (ns)	Bias
AIGND	AO	—	—	—	—	—	—
DAC0OUT[1]	AO	0.1 Ω	Short-circuit to ground	5 at 10	5 at -10	5 V/ µs	—
DAC1OUT[1]	AO	0.1 Ω	Short-circuit to ground	5 at 10	5 at -10	5 V/ µs	—
AOGND	AO	—	—	—	—	—	—
DGND	DO	—	—	—	—	—	—
VCC	DO	0.1 Ω	Short-circuit to ground	1 A	—	—	—
DIO<0..7>	DIO	—	V_{cc} +0.5	13 at (V_{cc} -0.4)	24 at 0.4	1.1	50 kΩ pu
SCANCLK	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
EXTSTROBE*	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI0/TRIG1	AI DIO	10 kΩ	±35 V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	9 kΩ pu and 10 kΩ pd
PFI1/TRIG2	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI2/CONVERT*	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI3/GPCTR1_SOURCE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI4/GPCTR1_GATE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
GPCTR1_OUT	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI5/UPDATE*	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI6/WFTRIG	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI7/STARTSCAN	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI8/GPCTR0_SOURCE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI9/GPCTR0_GATE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu

Table 4-2. I/O Signal Summary, PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, and PCI-6033E (Continued)

Signal Name	Signal Type and Direction	Impedance Input/ Output	Protection (Volts) On/Off	Source (mA at V)	Sink (mA at V)	Rise Time (ns)	Bias
GPCTR0_OUT	DO	—	—	3.5 at (V_{CC} -0.4)	5 at 0.4	1.5	50 kΩ pu
FREQ_OUT	DO	—	—	3.5 at (V_{CC}-0.4)	5 at 0.4	1.5	50 kΩ pu

AI = Analog Input DIO = Digital Input/Output pu = pullup
AO = Analog Output DO = Digital Output

[1] Not available on PCI-6032E and PCI-6033E

Note: ***The tolerance on the 50 kΩ pullup and pulldown resistors is very large. Actual value may range between 17 kΩ and 100 kΩ.***

Table 4-3 shows the I/O signal summary for the PCI-MIO-16XE-50.

Table 4-3. I/O Signal Summary, PCI-MIO-16XE-50

Signal Name	Signal Type and Direction	Impedance Input/ Output	Protection (Volts) On/Off	Source (mA at V)	Sink (mA at V)	Rise Time (ns)	Bias
ACH<0..15>	AI	20 GΩ in parallel with 100 pF	25/15	—	—	—	±3 nA
AISENSE	AI	20 GΩ in parallel with 100 pF	25/15	—	—	—	±3 nA
AIGND	AO	—	—	—	—	—	—
DAC0OUT	AO	0.1 Ω	Short-circuit to ground	5 at -10	5 at -10	2 V/µs	—
DAC1OUT	AO	0.1 Ω	Short-circuit to ground	5 at -10	5 at -10	2 V/µs	—
AOGND	AO	—	—	—	—	—	—
DGND	DO	—	—	—	—	—	—
VCC	DO	0.1Ω	Short-circuit to ground	1A	—	—	—

Table 4-3. I/O Signal Summary, PCI-MIO-16XE-50 (Continued)

Signal Name	Signal Type and Direction	Impedance Input/ Output	Protection (Volts) On/Off	Source (mA at V)	Sink (mA at V)	Rise Time (ns)	Bias
DIO<0..7>	DIO	—	V_{cc} +0.5	13 at (V_{cc} -0.4)	24 at 0.4	1.1	50 kΩ pu
SCANCLK	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
EXTSTROBE*	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI0/TRIG1	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI1/TRIG2	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI2/CONVERT*	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI3/GPCTR1_SOURCE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI4/GPCTR1_GATE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
GPCTR1_OUT	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI5/UPDATE*	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI6/WFTRIG	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI7/STARTSCAN	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI8/GPCTR0_SOURCE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
PFI9/GPCTR0_GATE	DIO	—	V_{cc} +0.5	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
GPCTR0_OUT	DO	—	—	3.5 at (V_{cc} -0.4)	5 at 0.4	1.5	50 kΩ pu
FREQ_OUT	DO	—	—	3.5 at (V_{cc}-0.4)	5 at 0.4	1.5	50 kΩ pu

AI = Analog Input
AO = Analog Output
DIO = Digital Input/Output
DO = Digital Output
pu = pullup

Analog Input Signal Connections

- PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-50, PCI-MIO-16XE-10, and PCI-6032E

  The analog input signals for the PCI E Series boards are ACH<0..15>, AISENSE, and AIGND. The ACH<0..15> signals are tied to the 16 analog input channels of your PCI E Series board. In single-ended mode, signals connected to ACH<0..15> are routed to the positive input of the board PGIA. In differential mode, signals connected to ACH<0..7> are routed to the positive input of the PGIA, and signals connected to ACH<8..15> are routed to the negative input of the PGIA.

- PCI-6031E, PCI-6033E, and PCI-6071E

  The analog input signals are ACH<0..63>, AISENSE, AISENSE2, and AIGND. The ACH<0..63> signals are tied to the 64 analog input channels of the boards. In single-ended mode, signals connected to ACH<0..63> are routed to the positive input of the PGIA. In differential mode, signals connected to ACH<0..7, 16..23, 32..39, 48..55> are routed to the positive input of the PGIA, and signals connected to ACH<8..15, 24..31, 40..47, 56..63> are routed to the negative input of the PGIA.

Caution: ***Exceeding the differential and common-mode input ranges distorts your input signals. Exceeding the maximum input voltage rating can damage the PCI E Series board and the computer. National Instruments is NOT liable for any damages resulting from such signal connections. The maximum input voltage ratings are listed in the*** *Protection* ***column of Tables 4-1 to 4-3.***

In NRSE mode, the AISENSE signal is connected internally to the negative input of the PCI E Series board PGIA when their corresponding channels are selected. In DIFF and RSE modes, this signal is left unconnected.

AIGND is an analog input common signal that is routed directly to the ground tie point on the PCI E Series boards. You can use this signal for a general analog ground tie point to your PCI E Series board if necessary.

Connection of analog input signals to your PCI E Series board depends on the configuration of the analog input channels you are using and the

type of input signal source. With the different configurations, you can use the PGIA in different ways. Figure 4-3 shows a diagram of your PCI E Series board PGIA.

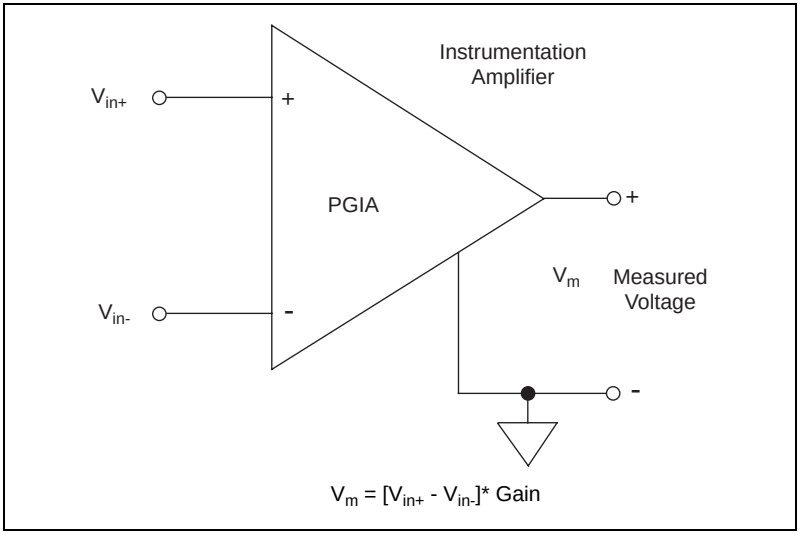


Figure 4-3. PCI E Series PGIA

The PGIA applies gain and common-mode voltage rejection and presents high input impedance to the analog input signals connected to your PCI E Series board. Signals are routed to the positive and negative inputs of the PGIA through input multiplexers on the board. The PGIA converts two input signals to a signal that is the difference between the two input signals multiplied by the gain setting of the amplifier. The amplifier output voltage is referenced to the ground for the board. Your PCI E Series board A/D converter (ADC) measures this output voltage when it performs A/D conversions.

You must reference all signals to ground either at the source device or at the board. If you have a floating source, you should reference the signal to ground by using the RSE input mode or the DIFF input configuration with bias resistors (see the *Differential Connections for Nonreferenced or Floating Signal Sources* section later in this chapter). If you have a grounded source, you should not reference the signal to AIGND. You can avoid this reference by using DIFF or NRSE input configurations.

Types of Signal Sources

When configuring the input channels and making signal connections, you must first determine whether the signal sources are floating or ground-referenced. The following sections describe these two types of signals.

Floating Signal Sources

A floating signal source is not connected in any way to the building ground system but, rather, has an isolated ground-reference point. Some examples of floating signal sources are outputs of transformers, thermocouples, battery-powered devices, optical isolator outputs, and isolation amplifiers. An instrument or device that has an isolated output is a floating signal source. You must tie the ground reference of a floating signal to your PCI E Series board analog input ground to establish a local or onboard reference for the signal. Otherwise, the measured input signal varies as the source floats out of the common-mode input range.

Ground-Referenced Signal Sources

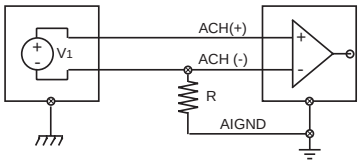
A ground-referenced signal source is connected in some way to the building system ground and is, therefore, already connected to a common ground point with respect to the PCI E Series board, assuming that the computer is plugged into the same power system. Nonisolated outputs of instruments and devices that plug into the building power system fall into this category.

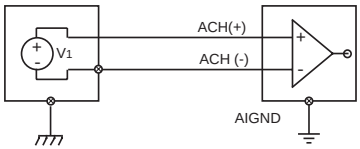
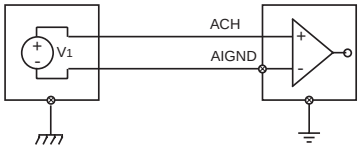
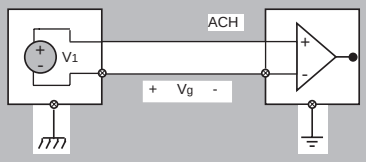
The difference in ground potential between two instruments connected to the same building power system is typically between 1 and 100 mV but can be much higher if power distribution circuits are not properly connected. If a grounded signal source is improperly measured, this difference may appear as an error in the measurement. The connection instructions for grounded signal sources are designed to eliminate this ground potential difference from the measured signal.

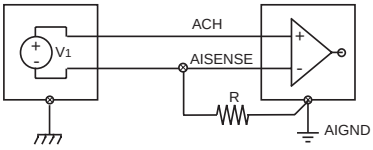
Input Configurations

You can configure your PCI E Series board for one of three input modes—NRSE, RSE, or DIFF. The following sections discuss the use of single-ended and differential measurements and considerations for measuring both floating and ground-referenced signal sources.

Figure 4-4 summarizes the recommended input configuration for both types of signal sources.

<table>
<tr><td rowspan="2">Input</td><td colspan="2">Signal Source Type</td></tr>
<tr><td>Floating Signal Source
(Not Connected to Building Ground)</td><td>Grounded Signal Source</td></tr>
<tr><td></td><td>Examples
• Ungrounded Thermocouples
• Signal conditioning with isolated outputs
• Battery devices</td><td>Examples
• Plug-in instruments with nonisolated outputs</td></tr>
<tr><td>Differential (DIFF)</td><td> 

See text for information on bias resistors.</td><td> 
</td></tr>
<tr><td>Single-Ended — Ground Referenced (RSE)</td><td> 
</td><td>NOT RECOMMENDED
 

Ground-loop losses, Vg, are added to measured signal</td></tr>
<tr><td>Single-Ended — Nonreferenced (NRSE)</td><td> 

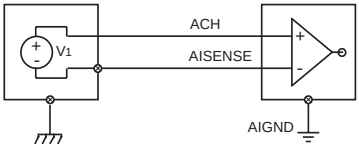
See text for information on bias resistors.</td><td> 
</td></tr>
</table>

Figure 4-4. Summary of Analog Input Connections

Differential Connection Considerations (DIFF Input Configuration)

A differential connection is one in which the PCI E Series board analog input signal has its own reference signal or signal return path. These connections are available when the selected channel is configured in DIFF input mode. The input signal is tied to the positive input of the PGIA, and its reference signal, or return, is tied to the negative input of the PGIA.

When you configure a channel for differential input, each signal uses two multiplexer inputs—one for the signal and one for its reference signal. Therefore, with a differential configuration for every channel, up to eight analog input channels are available (up to 32 channels on the PCI-6031E, PCI-6033E, and the PCI-6071E).

You should use differential input connections for any channel that meets any of the following conditions:

- The input signal is low level (less than 1 V).
- The leads connecting the signal to the PCI-MIO E Series board are greater than 10 ft (3 m).
- The input signal requires a separate ground-reference point or return signal.
- The signal leads travel through noisy environments.

Differential signal connections reduce picked up noise and increase common-mode noise rejection. Differential signal connections also allow input signals to float within the common-mode limits of the PGIA.

Differential Connections for Ground-Referenced Signal Sources

Figure 4-5 shows how to connect a ground-referenced signal source to a channel on the PCI E Series board configured in DIFF input mode.

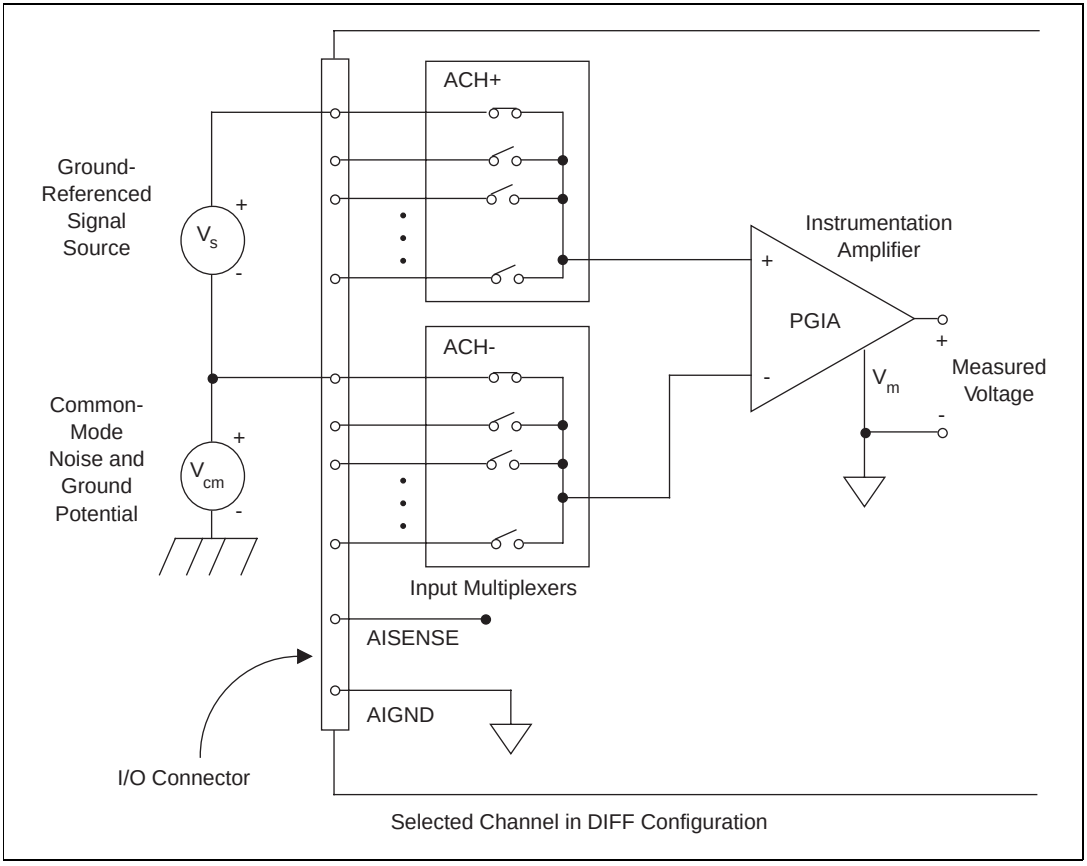


Figure 4-5. Differential Input Connections for Ground-Referenced Signals

With this type of connection, the PGIA rejects both the common-mode noise in the signal and the ground potential difference between the signal source and the PCI E Series board ground, shown as V_{cm} in Figure 4-5.

Differential Connections for Nonreferenced or Floating Signal Sources

Figure 4-6 shows how to connect a floating signal source to a channel on the PCI E Series board configured in DIFF input mode.

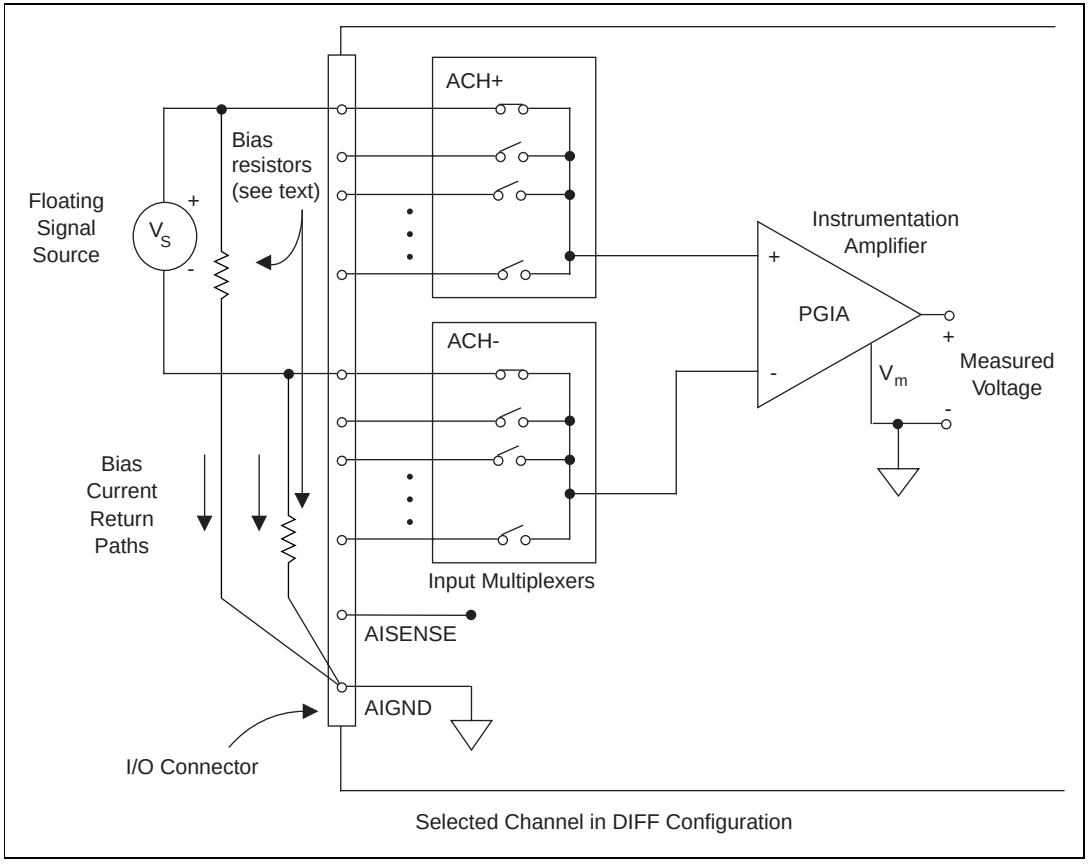


Figure 4-6. Differential Input Connections for Nonreferenced Signals

Figure 4-6 shows two bias resistors connected in parallel with the signal leads of a floating signal source. If you do not use the resistors and the source is truly floating, the source is not likely to remain within the common-mode signal range of the PGIA, and the PGIA will saturate, causing erroneous readings. You must reference the source to AIGND. The easiest way is simply to connect the positive side of the signal to the positive input of the PGIA and connect the negative side of the

signal to AIGND as well as to the negative input of the PGIA, without any resistors at all. This connection works well for DC-coupled sources with low source impedance (less than 100 Ω).

However, for larger source impedances, this connection leaves the differential signal path significantly out of balance. Noise that couples electrostatically onto the positive line does not couple onto the negative line because it is connected to ground. Hence, this noise appears as a differential-mode signal instead of a common-mode signal, and the PGIA does not reject it. In this case, instead of directly connecting the negative line to AIGND, connect it to AIGND through a resistor that is about 100 times the equivalent source impedance. The resistor puts the signal path nearly in balance, so that about the same amount of noise couples onto both connections, yielding better rejection of electrostatically coupled noise. Also, this configuration does not load down the source (other than the very high input impedance of the PGIA).

You can fully balance the signal path by connecting another resistor of the same value between the positive input and AIGND, as shown in Figure 4-6. This fully-balanced configuration offers slightly better noise rejection but has the disadvantage of loading the source down with the series combination (sum) of the two resistors. If, for example, the source impedance is 2 kΩ and each of the two resistors is 100 kΩ, the resistors load down the source with 200 kΩ and produce a –1% gain error.

Both inputs of the PGIA require a DC path to ground in order for the PGIA to work. If the source is AC coupled (capacitively coupled), the PGIA needs a resistor between the positive input and AIGND. If the source has low impedance, choose a resistor that is large enough not to significantly load the source but small enough not to produce significant input offset voltage as a result of input bias current (typically 100 kΩ to 1 MΩ). In this case, you can tie the negative input directly to AIGND. If the source has high output impedance, you should balance the signal path as previously described using the same value resistor on both the positive and negative inputs; you should be aware that there is some gain error from loading down the source.

Single-Ended Connection Considerations

A single-ended connection is one in which the PCI E Series board analog input signal is referenced to a ground that can be shared with other input signals. The input signal is tied to the positive input of the PGIA, and the ground is tied to the negative input of the PGIA.

When every channel is configured for single-ended input, up to 16 analog input channels are available (up to 64 on the PCI-6031E, PCI-6033E, and the PCI-6071E).

You can use single-ended input connections for any input signal that meets the following conditions:

- The input signal is high level (greater than 1 V).
- The leads connecting the signal to the PCI E Series board are less than 10 ft (3 m).
- The input signal can share a common reference point with other signals.

DIFF input connections are recommended for greater signal integrity for any input signal that does not meet the preceding conditions.

You can software configure the PCI E Series board channels for two different types of single-ended connections—RSE configuration and NRSE configuration. The RSE configuration is used for floating signal sources; in this case, the PCI E Series board provides the reference ground point for the external signal. The NRSE input configuration is used for ground-referenced signal sources; in this case, the external signal supplies its own reference ground point and the PCI E Series board should not supply one.

In single-ended configurations, more electrostatic and magnetic noise couples into the signal connections than in differential configurations. The coupling is the result of differences in the signal path. Magnetic coupling is proportional to the area between the two signal conductors. Electrical coupling is a function of how much the electric field differs between the two conductors.

Single-Ended Connections for Floating Signal Sources (RSE Configuration)

Figure 4-7 shows how to connect a floating signal source to a channel on the PCI E Series board configured for RSE mode.

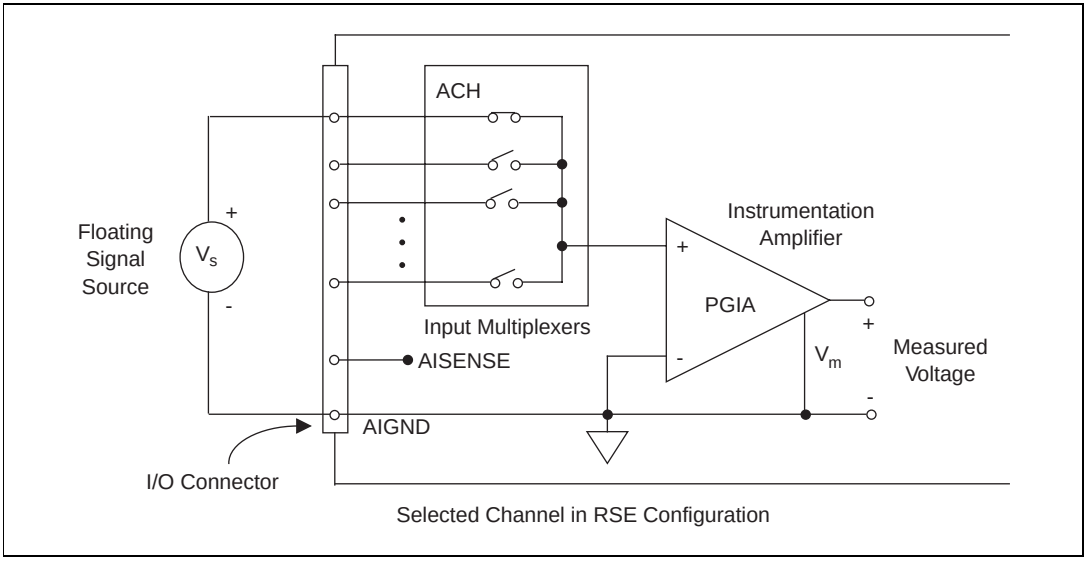


Figure 4-7. Single-Ended Input Connections for Nonreferenced or Floating Signals

Single-Ended Connections for Grounded Signal Sources (NRSE Configuration)

To measure a grounded signal source with a single-ended configuration, you must configure your PCI E Series board in the NRSE input configuration. The signal is then connected to the positive input of the PCI E Series PGIA, and the signal local ground reference is connected to the negative input of the PGIA. The ground point of the signal should, therefore, be connected to the AISENSE pin. Any potential difference between the PCI E Series ground and the signal ground appears as a common-mode signal at both the positive and negative inputs of the PGIA, and this difference is rejected by the amplifier. If the input circuitry of a PCI E Series board were referenced to ground, in this situation as in the RSE input configuration, this difference in ground potentials would appear as an error in the measured voltage.

Figure 4-8 shows how to connect a grounded signal source to a channel on the PCI E Series board configured for NRSE mode.

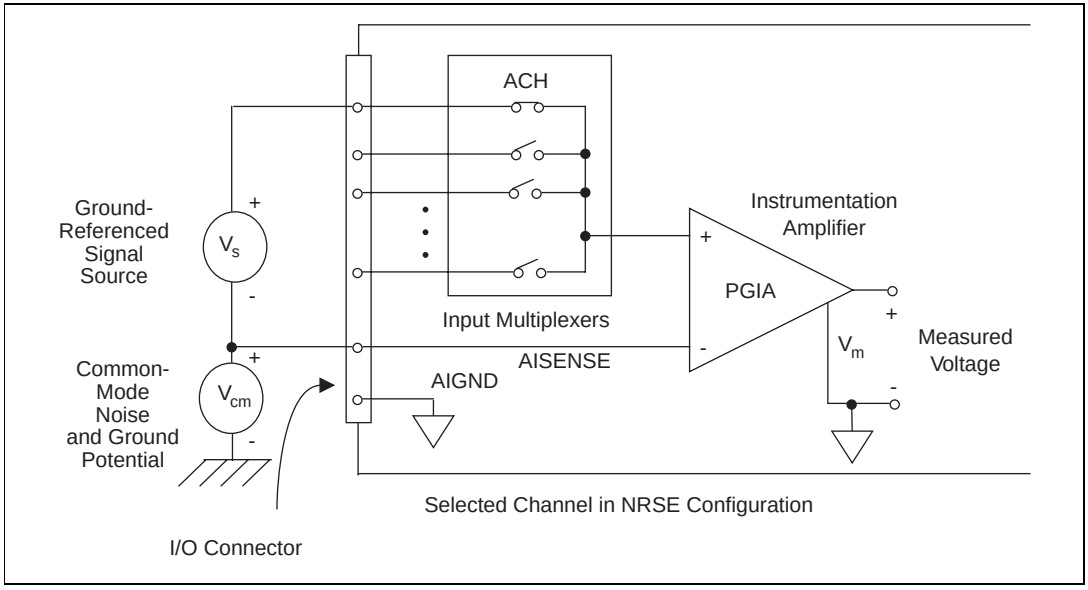


Figure 4-8. Single-Ended Input Connections for Ground-Referenced Signals

Common-Mode Signal Rejection Considerations

Figures 4-5 and 4-8 show connections for signal sources that are already referenced to some ground point with respect to the PCI E Series board. In these cases, the PGIA can reject any voltage caused by ground potential differences between the signal source and the board. In addition, with differential input connections, the PGIA can reject common-mode noise pickup in the leads connecting the signal sources to the board. The PGIA can reject common-mode signals as long as V^+_{in} and V^-_{in} (input signals) are both within ±11 V of AIGND. *The PCI-MIO-16XE-50 has the additional restriction that (V^+_{in} + V^-_{in}) added to the gain times (V^+_{in} - V^-_{in}) must be within ±26 V of AIGND. At gains of 10 and 100, this is roughly equivalent to restricting the two input voltages to within ±8 V of AIGND.*

Analog Output Signal Connections

The analog output signals are DAC0OUT, DAC1OUT, EXTREF, and AOGND. *DAC0OUT and DAC1OUT are not available on the PCI-6032E and PCI-6033E. EXTREF is not available on the PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E, PCI-6032E, or the PCI-6033E.*

DAC0OUT is the voltage output signal for analog output channel 0. DAC1OUT is the voltage output signal for analog output channel 1.

EXTREF is the external reference input for both analog output channels. You must configure each analog output channel individually for external reference selection in order for the signal applied at the external reference input to be used by that channel. If you do not specify an external reference, the channel will use the internal reference. Analog output configuration options are explained in the *Analog Output* section in Chapter 3, *Hardware Overview*. The following ranges and ratings apply to the EXTREF input:

- Usable input voltage range: ±11 V peak with respect to AOGND
- Absolute maximum ratings: ±15 V peak with respect to AOGND

AOGND is the ground reference signal for both analog output channels and the external reference signal.

Figure 4-9 shows how to make analog output connections and the external reference input connection to your PCI E Series board.

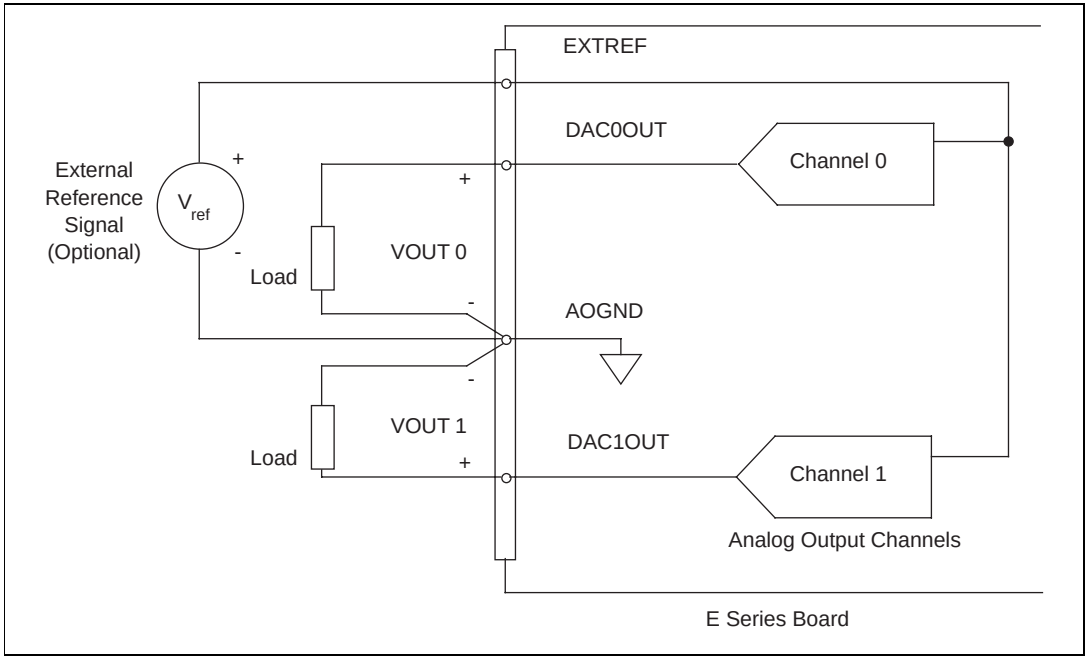


Figure 4-9. Analog Output Connections

The external reference signal can be either a DC or an AC signal. The board multiplies this reference signal by the DAC code (divided by the full-scale DAC code) to generate the output voltage.

Digital I/O Signal Connections

The digital I/O signals are DIO<0..7> and DGND. DIO<0..7> are the signals making up the DIO port, and DGND is the ground reference signal for the DIO port. You can program all lines individually to be inputs or outputs.

Caution: ***Exceeding the maximum input voltage ratings, which are listed in Tables 4-1, 4-2, and 4-3 can damage the PCI E Series board and the computer. National Instruments is NOT liable for any damages resulting from such signal connections.***

Figure 4-10 shows signal connections for three typical digital I/O applications.

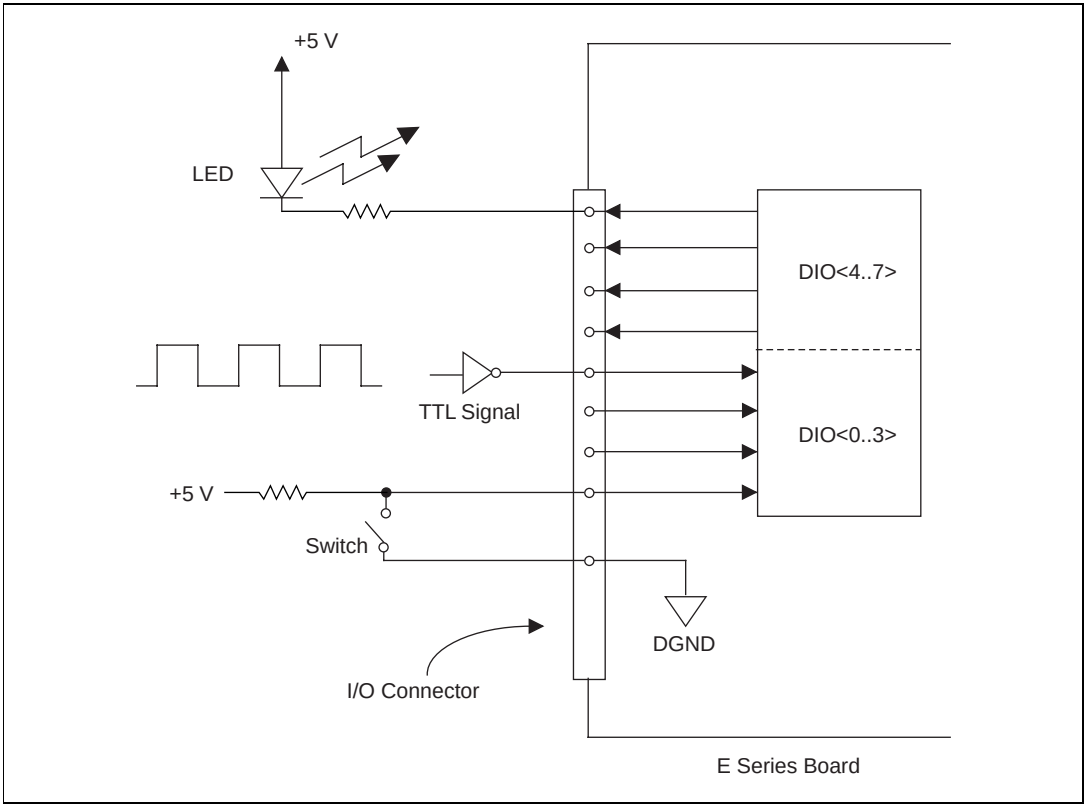


Figure 4-10. Digital I/O Connections

Figure 4-10 shows DIO<0..3> configured for digital input and DIO<4..7> configured for digital output. Digital input applications include receiving TTL signals and sensing external device states such as the state of the switch shown in the figure. Digital output applications include sending TTL signals and driving external devices such as the LED shown in the figure.

Power Connections

Two pins on the I/0 connector supply +5 V from the computer power supply via a self-resetting fuse. The fuse will reset automatically within a few seconds after the overcurrent condition is removed. These pins are referenced to DGND and can be used to power external digital circuitry.

- Power rating +4.65 to +5.25 VDC at 1 A

Caution: ***Under no circumstances should you connect these +5 V power pins directly to analog or digital ground or to any other voltage source on the PCI E Series board or any other device. Doing so can damage the PCI E Series board and the computer. National Instruments is NOT liable for damages resulting from such a connection.***

Timing Connections

Caution: ***Exceeding the maximum input voltage ratings, which are listed in Tables 4-1, 4-2, and 4-3 can damage the PCI E Series board and the computer. National Instruments is NOT liable for any damages resulting from such signal connections.***

All external control over the timing of your PCI E Series board is routed through the 10 programmable function inputs labeled PFI0 through PFI9. These signals are explained in detail in the next section, *Programmable Function Input Connections*. These PFIs are bidirectional; as outputs they are not programmable and reflect the state of many DAQ, waveform generation, and general-purpose timing signals. There are five other dedicated outputs for the remainder of the timing signals. As inputs, the PFI signals are programmable and can control any DAQ, waveform generation, and general-purpose timing signals.

The DAQ signals are explained in the *DAQ Timing Connections* section later in this chapter. The waveform generation signals are explained in the *Waveform Generation Timing Connections* section later in this chapter. The general-purpose timing signals are explained in the *General-Purpose Timing Signal Connections* section later in this chapter.

All digital timing connections are referenced to DGND. This reference is demonstrated in Figure 4-11, which shows how to connect an external TRIG1 source and an external CONVERT* source to two PCI E Series board PFI pins.

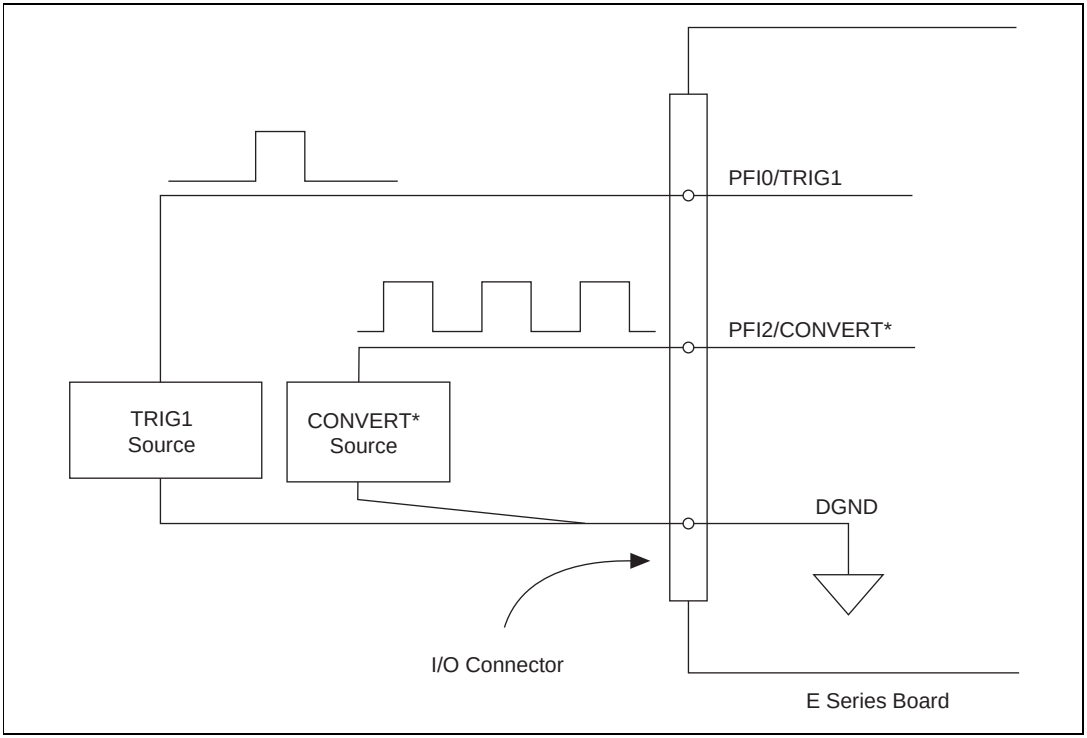


Figure 4-11. Timing I/O Connections

Programmable Function Input Connections

There are a total of 13 internal timing signals that you can externally control from the PFI pins. The source for each of these signals is software-selectable from any of the PFIs when you want external control. This flexible routing scheme reduces the need to change the physical wiring to the board I/O connector for different applications requiring alternative wiring.

You can individually enable each of the PFI pins to output a specific internal timing signal. For example, if you need the CONVERT* signal as an output on the I/O connector, software can turn on the output driver

for the PFI2/CONVERT* pin. Be careful not to drive a PFI signal externally when it is configured as an output.

As an input, you can individually configure each PFI for edge or level detection and for polarity selection, as well. You can use the polarity selection for any of the 13 timing signals, but the edge or level detection will depend upon the particular timing signal being controlled. The detection requirements for each timing signal are listed within the section that discusses that individual signal.

In edge-detection mode, the minimum pulse width required is 10 ns. This applies for both rising-edge and falling-edge polarity settings. There is no maximum pulse-width requirement in edge-detect mode.

In level-detection mode, there are no minimum or maximum pulse-width requirements imposed by the PFIs themselves, but there may be limits imposed by the particular timing signal being controlled. These requirements are listed later in this chapter.

DAQ Timing Connections

The DAQ timing signals are SCANCLK, EXTSTROBE*, TRIG1, TRIG2, STARTSCAN, CONVERT*, AIGATE, and SISOURCE.

Posttriggered data acquisition allows you to view only data that is acquired after a trigger event is received. A typical posttriggered DAQ sequence is shown in Figure 4-12. Pretriggered data acquisition allows you to view data that is acquired before the trigger of interest in addition to data acquired after the trigger. Figure 4-13 shows a typical pretriggered DAQ sequence. The description for each signal shown in these figures is included later in this chapter.

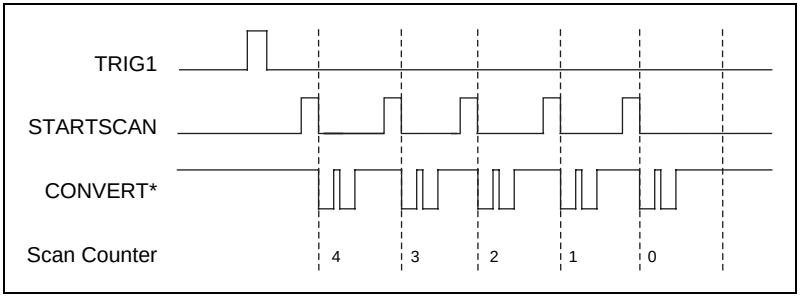


Figure 4-12. Typical Posttriggered Acquisition

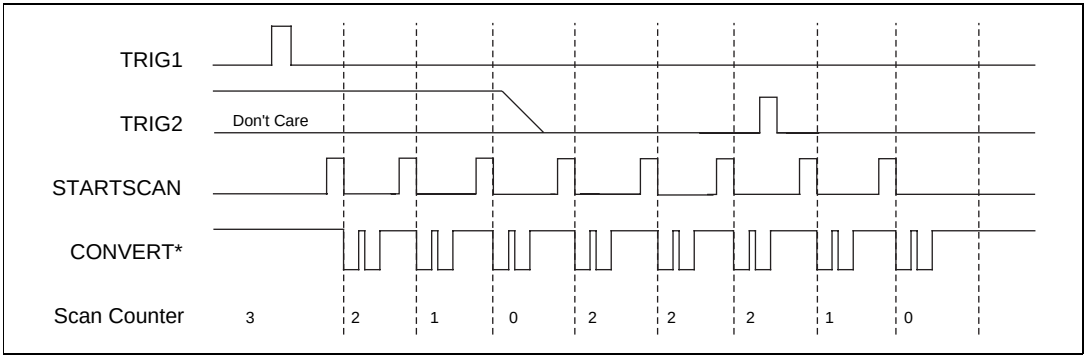


Figure 4-13. Typical Pretriggered Acquisition

SCANCLK Signal

SCANCLK is an output-only signal that generates a pulse with the leading edge occurring approximately 50 to 100 ns after an A/D conversion begins. The polarity of this output is software-selectable but is typically configured so that a low-to-high leading edge can clock external analog input multiplexers indicating when the input signal has been sampled and can be removed. This signal has a 400 to 500 ns pulse width and is software enabled. Figure 4-14 shows the timing for the SCANCLK signal.

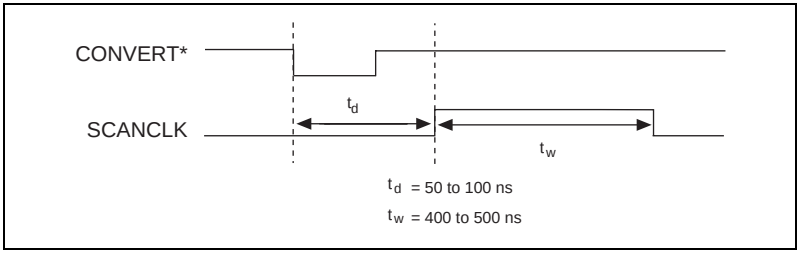


Figure 4-14. SCANCLK Signal Timing

EXTSTROBE* Signal

EXTSTROBE* is an output-only signal that generates either a single pulse or a sequence of eight pulses in the hardware-strobe mode. An external device can use this signal to latch signals or to trigger events. In the single-pulse mode, software controls the level of the EXTSTROBE* signal. A 10 µs and a 1.2 µs clock are available for generating a sequence of eight pulses in the hardware-strobe mode.

Figure 4-15 shows the timing for the hardware-strobe mode EXTSTROBE* signal.

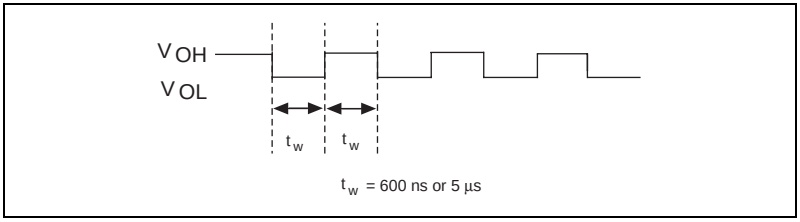


Figure 4-15. EXTSTROBE* Signal Timing

TRIG1 Signal

Any PFI pin can externally input the TRIG1 signal, which is available as an output on the PFI0/TRIG1 pin.

Refer to Figures 4-12 and 4-13 for the relationship of TRIG1 to the DAQ sequence.

As an input, the TRIG1 signal is configured in the edge-detection mode. You can select any PFI pin as the source for TRIG1 and configure the polarity selection for either rising or falling edge. The selected edge of the TRIG1 signal starts the data acquisition sequence for both posttriggered and pretriggered acquisitions. The PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, PCI-6033E, and PCI-6071E, support analog triggering on the PFI0/TRIG1 pin. See Chapter 3, *Hardware Overview*, for more information on analog triggering.

As an output, the TRIG1 signal reflects the action that initiates a DAQ sequence. This is true even if the acquisition is being externally triggered by another PFI. The output is an active high pulse with a pulse width of 50 to 100 ns. This output is set to tri-state at startup.

Figures 4-16 and 4-17 show the input and output timing requirements for the TRIG1 signal.

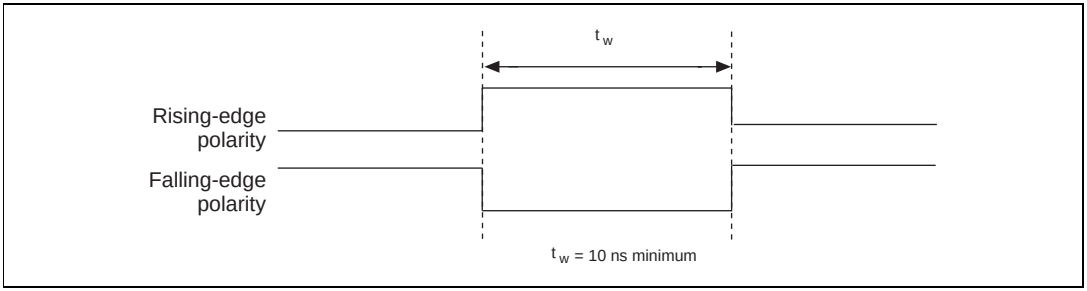


Figure 4-16. TRIG1 Input Signal Timing

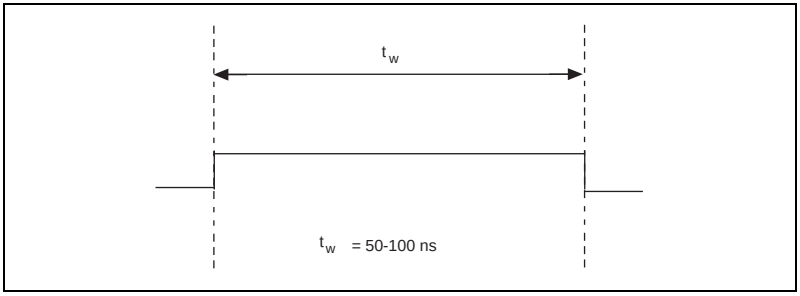


Figure 4-17. TRIG1 Output Signal Timing

The board also uses the TRIG1 signal to initiate pretriggered DAQ operations. In most pretriggered applications, the TRIG1 signal is generated by a software trigger. Refer to the TRIG2 signal description for a complete description of the use of TRIG1 and TRIG2 in a pretriggered DAQ operation.

TRIG2 Signal

Any PFI pin can externally input the TRIG2 signal, which is available as an output on the PFI1/TRIG2 pin. Refer to Figure 4-13 for the relationship of TRIG2 to the DAQ sequence.

As an input, the TRIG2 signal is configured in the edge-detection mode. You can select any PFI pin as the source for TRIG2 and configure the polarity selection for either rising or falling edge. The selected edge of the TRIG2 signal initiates the posttriggered phase of a pretriggered acquisition sequence. In pretriggered mode, the TRIG1 signal initiates the data acquisition. The scan counter indicates the minimum number

of scans before TRIG2 can be recognized. After the scan counter decrements to zero, it is loaded with the number of posttrigger scans to acquire while the acquisition continues. The board ignores the TRIG2 signal if it is asserted prior to the scan counter decrementing to zero. After the selected edge of TRIG2 is received, the board will acquire a fixed number of scans and the acquisition will stop. This mode acquires data both before and after receiving TRIG2.

As an output, the TRIG2 signal reflects the posttrigger in a pretriggered acquisition sequence. This is true even if the acquisition is being externally triggered by another PFI. The TRIG2 signal is not used in posttriggered data acquisition. The output is an active high pulse with a pulse width of 50 to 100 ns. This output is set to tri-state at startup.

Figures 4-18 and 4-19 show the input and output timing requirements for the TRIG2 signal.

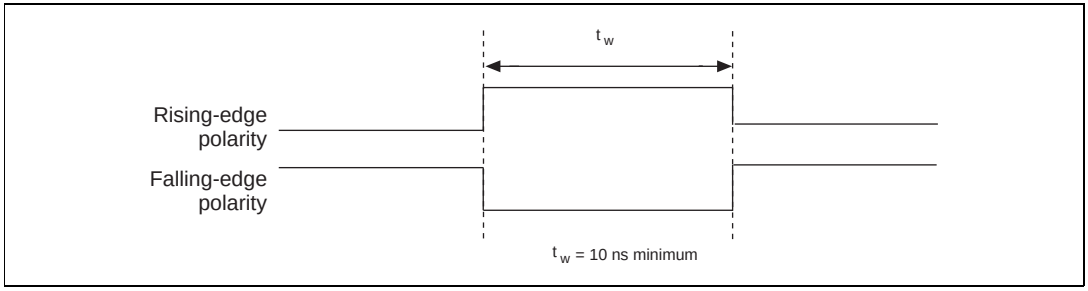


Figure 4-18. TRIG2 Input Signal Timing

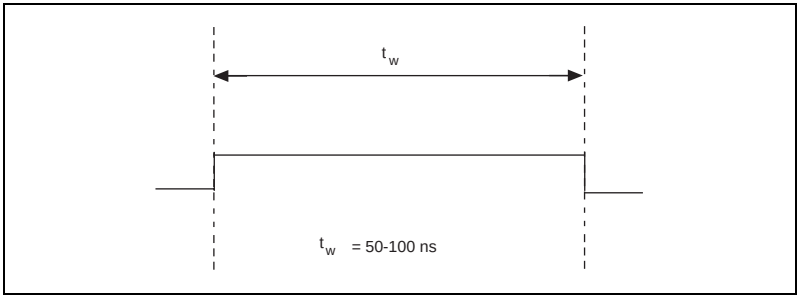


Figure 4-19. TRIG2 Output Signal Timing

STARTSCAN Signal

Any PFI pin can externally input the STARTSCAN signal, which is available as an output on the PFI7/STARTSCAN pin. Refer to Figures 4-12 and 4-13 for the relationship of STARTSCAN to the DAQ sequence.

As an input, the STARTSCAN signal is configured in the edge-detection mode. You can select any PFI pin as the source for STARTSCAN and configure the polarity selection for either rising or falling edge. The selected edge of the STARTSCAN signal initiates a scan. The sample interval counter starts if you select internally triggered CONVERT*.

As an output, the STARTSCAN signal reflects the actual start pulse that initiates a scan. This is true even if the starts are being externally triggered by another PFI. You have two output options. The first is an active high pulse with a pulse width of 50 to 100 ns, which indicates the start of the scan. The second action is an active high pulse that terminates at the start of the last conversion in the scan, which indicates a scan in progress. STARTSCAN will be deasserted t_{off} after the last conversion in the scan is initiated. This output is set to tri-state at startup.

Figures 4-20 and 4-21 show the input and output timing requirements for the STARTSCAN signal.

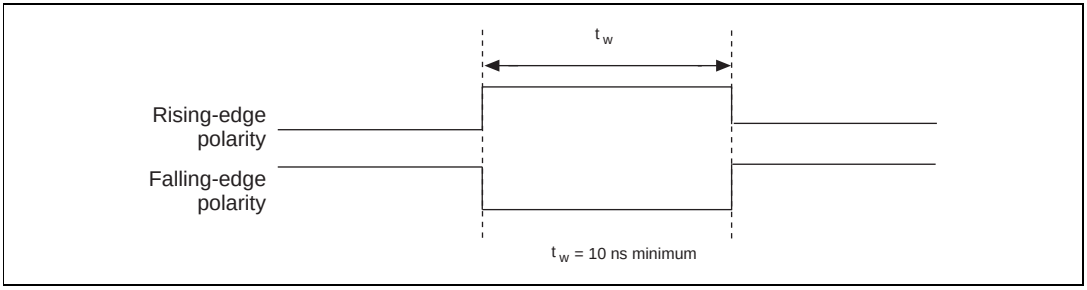


Figure 4-20. STARTSCAN Input Signal Timing

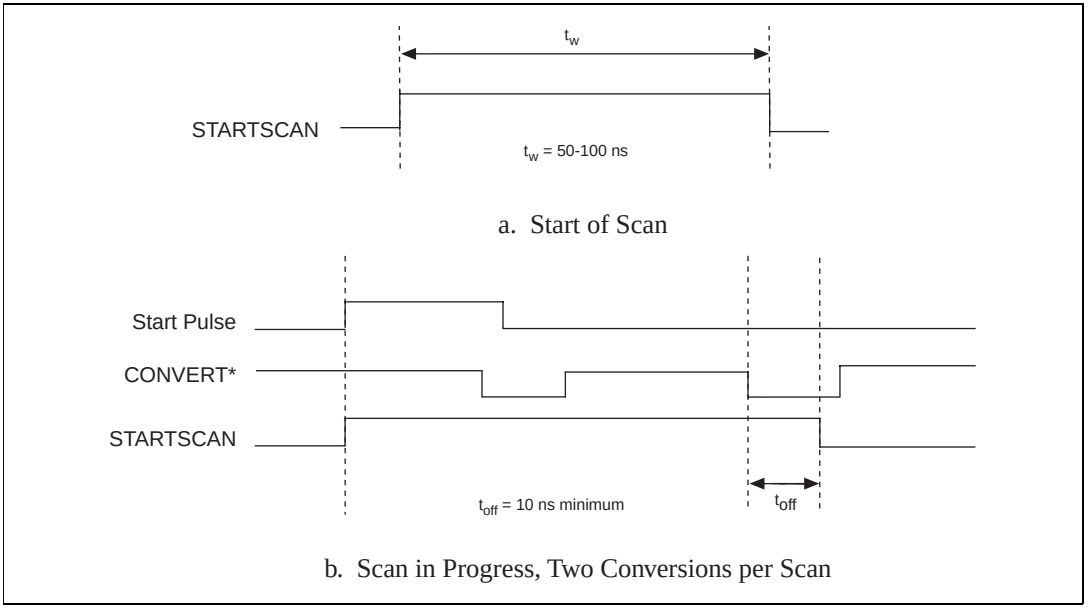


Figure 4-21. STARTSCAN Output Signal Timing

The CONVERT* pulses are masked off until the board generates the STARTSCAN signal. If you are using internally generated conversions, the first CONVERT* appears when the onboard sample interval counter reaches zero. If you select an external CONVERT*, the first external pulse after STARTSCAN generates a conversion. The STARTSCAN pulses should be separated by at least one scan period.

A counter on your PCI E Series board internally generates the STARTSCAN signal unless you select some external source. This counter is started by the TRIG1 signal and is stopped either by software or by the sample counter.

Scans generated by either an internal or external STARTSCAN signal are inhibited unless they occur within a DAQ sequence. Scans occurring within a DAQ sequence may be gated by either the hardware (AIGATE) signal or software command register gate.

CONVERT* Signal

Any PFI pin can externally input the CONVERT* signal, which is available as an output on the PFI2/CONVERT* pin.

Refer to Figures 4-12 and 4-13 for the relationship of STARTSCAN to the DAQ sequence.

As an input, the CONVERT* signal is configured in the edge-detection mode. You can select any PFI pin as the source for CONVERT* and configure the polarity selection for either rising or falling edge. The selected edge of the CONVERT* signal initiates an A/D conversion.

As an output, the CONVERT* signal reflects the actual convert pulse that is connected to the ADC. This is true even if the conversions are being externally generated by another PFI. The output is an active low pulse with a pulse width of 50 to 100 ns. This output is set to tri-state at startup.

Figures 4-22 and 4-23 show the input and output timing requirements for the CONVERT* signal.

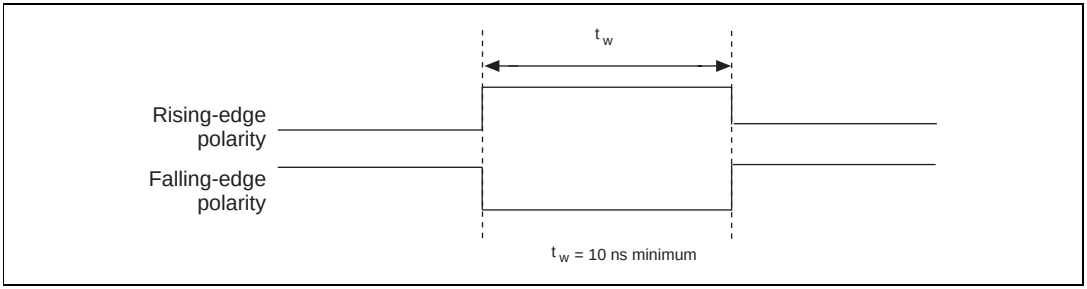


Figure 4-22. CONVERT* Input Signal Timing

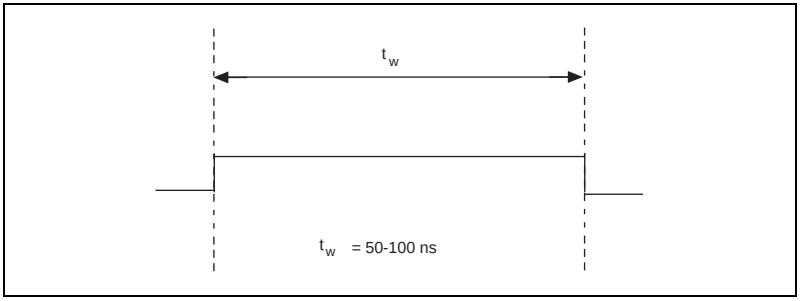


Figure 4-23. CONVERT* Output Signal Timing

The ADC switches to hold mode within 60 ns of the selected edge. This hold-mode delay time is a function of temperature and does not vary from one conversion to the next. Separate the CONVERT* pulses by at least one conversion period.

The sample interval counter on the PCI E Series board normally generates the CONVERT* signal unless you select some external source. The counter is started by the STARTSCAN signal and continues to count down and reload itself until the scan is finished. It then reloads itself in preparation for the next STARTSCAN pulse.

A/D conversions generated by either an internal or external CONVERT* signal are inhibited unless they occur within a DAQ sequence. Scans occurring within a DAQ sequence may be gated by either the hardware (AIGATE) signal or software command register gate.

AIGATE Signal

Any PFI pin can externally input the AIGATE signal, which is not available as an output on the I/O connector. The AIGATE signal can mask off scans in a DAQ sequence. You can configure the PFI pin you select as the source for the AIGATE signal in either the level-detection or edge-detection mode. You can configure the polarity selection for the PFI pin for either active high or active low.

In the level-detection mode if AIGATE is active, the STARTSCAN signal is masked off and no scans can occur. In the edge-detection mode, the first active edge disables the STARTSCAN signal, and the second active edge enables STARTSCAN.

The AIGATE signal can neither stop a scan in progress nor continue a previously gated-off scan; in other words, once a scan has started, AIGATE does not gate off conversions until the beginning of the next scan and, conversely, if conversions are being gated off, AIGATE does not gate them back on until the beginning of the next scan.

SISOURCE Signal

Any PFI pin can externally input the SISOURCE signal, which is not available as an output on the I/O connector. The onboard scan interval counter uses the SISOURCE signal as a clock to time the generation of the STARTSCAN signal. You must configure the PFI pin you select as the source for the SISOURCE signal in the level-detection mode. You can configure the polarity selection for the PFI pin for either active high or active low.

The maximum allowed frequency is 20 MHz, with a minimum pulse width of 23 ns high or low. There is no minimum frequency limitation.

Either the 20 MHz or 100 kHz internal timebase generates the SISOURCE signal unless you select some external source. Figure 4-24 shows the timing requirements for the SISOURCE signal.

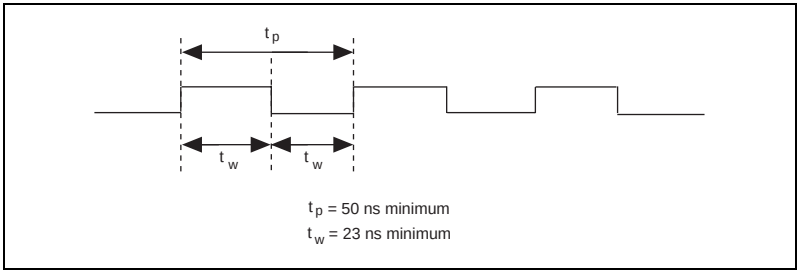


Figure 4-24. SISOURCE Signal Timing

Waveform Generation Timing Connections

The analog group defined for your PCI E Series board is controlled by WFTRIG, UPDATE*, and UISOURCE.

WFTRIG Signal

Any PFI pin can externally input the WFTRIG signal, which is available as an output on the PFI6/WFTRIG pin.

As an input, the WFTRIG signal is configured in the edge-detection mode. You can select any PFI pin as the source for WFTRIG and configure the polarity selection for either rising or falling edge. The selected edge of the WFTRIG signal starts the waveform generation for the DACs. The update interval (UI) counter is started if you select internally generated UPDATE*.

As an output, the WFTRIG signal reflects the trigger that initiates waveform generation. This is true even if the waveform generation is being externally triggered by another PFI. The output is an active high pulse with a pulse width of 50 to 100 ns. This output is set to tri-state at startup.

Figures 4-25 and 4-26 show the input and output timing requirements for the WFTRIG signal.

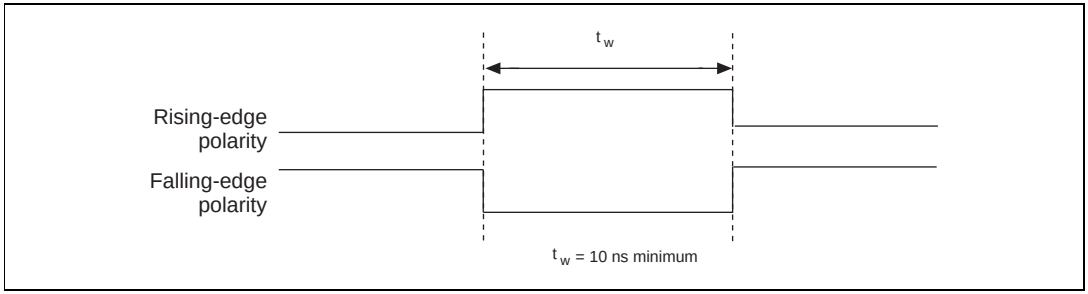


Figure 4-25. WFTRIG Input Signal Timing

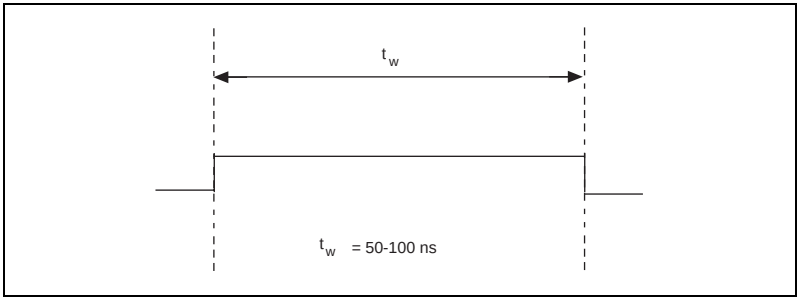


Figure 4-26. WFTRIG Output Signal Timing

UPDATE* Signal

Any PFI pin can externally input the UPDATE* signal, which is available as an output on the PFI5/UPDATE* pin.

As an input, the UPDATE* signal is configured in the edge-detection mode. You can select any PFI pin as the source for UPDATE* and configure the polarity selection for either rising or falling edge. The selected edge of the UPDATE* signal updates the outputs of the DACs. In order to use UPDATE*, you must set the DACs to posted-update mode.

As an output, the UPDATE* signal reflects the actual update pulse that is connected to the DACs. This is true even if the updates are being externally generated by another PFI. The output is an active low pulse with a pulse width of 300 to 350 ns. This output is set to tri-state at startup.

Figures 4-27 and 4-28 show the input and output timing requirements for the UPDATE* signal.

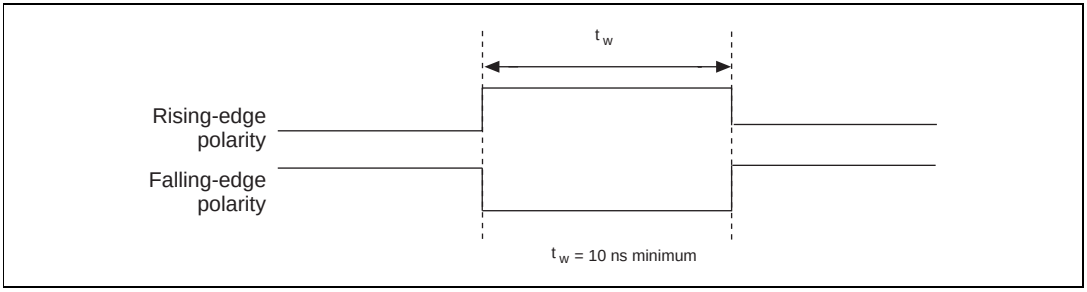


Figure 4-27. UPDATE* Input Signal Timing

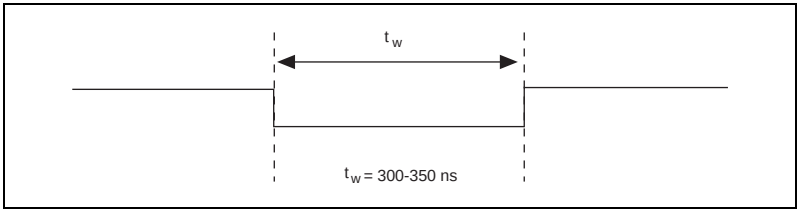


Figure 4-28. UPDATE* Output Signal Timing

The DACs are updated within 100 ns of the leading edge. Separate the UPDATE* pulses with enough time that new data can be written to the DAC latches.

The PCI E Series board UI counter normally generates the UPDATE* signal unless you select some external source. The UI counter is started by the WFTRIG signal and can be stopped by software or the internal Buffer Counter.

D/A conversions generated by either an internal or external UPDATE* signal do not occur when gated by the software command register gate.

UISOURCE Signal

Any PFI pin can externally input the UISOURCE signal, which is not available as an output on the I/O connector. The UI counter uses the UISOURCE signal as a clock to time the generation of the UPDATE* signal. You must configure the PFI pin you select as the source for the UISOURCE signal in the level-detection mode. You can configure the polarity selection for the PFI pin for either active high or active low. Figure 4-29 shows the timing requirements for the UISOURCE signal.

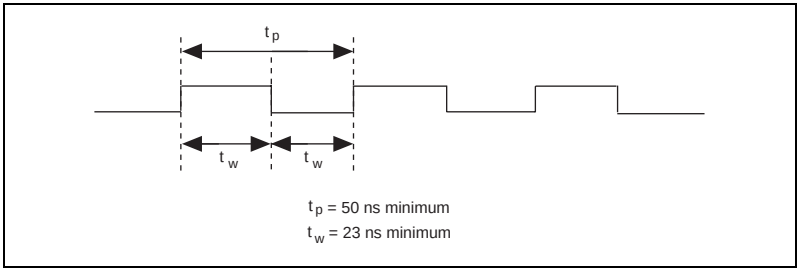


Figure 4-29. UISOURCE Signal Timing

The maximum allowed frequency is 20 MHz, with a minimum pulse width of 23 ns high or low. There is no minimum frequency limitation.

Either the 20 MHz or 100 kHz internal timebase normally generates the UISOURCE signal unless you select some external source.

General-Purpose Timing Signal Connections

The general-purpose timing signals are GPCTR0_SOURCE, GPCTR0_GATE, GPCTR0_OUT, GPCTR0_UP_DOWN, GPCTR1_SOURCE, GPCTR1_GATE, GPCTR1_OUT, GPCTR1_UP_DOWN, and FREQ_OUT.

GPCTR0_SOURCE Signal

Any PFI pin can externally input the GPCTR0_SOURCE signal, which is available as an output on the PFI8/GPCTR0_SOURCE pin.

As an input, the GPCTR0_SOURCE signal is configured in the edge-detection mode. You can select any PFI pin as the source for GPCTR0_SOURCE and configure the polarity selection for either rising or falling edge.

As an output, the GPCTR0_SOURCE signal reflects the actual clock connected to general-purpose counter 0. This is true even if another PFI is externally inputting the source clock. This output is set to tri-state at startup.

Figure 4-30 shows the timing requirements for the GPCTR0_SOURCE signal.

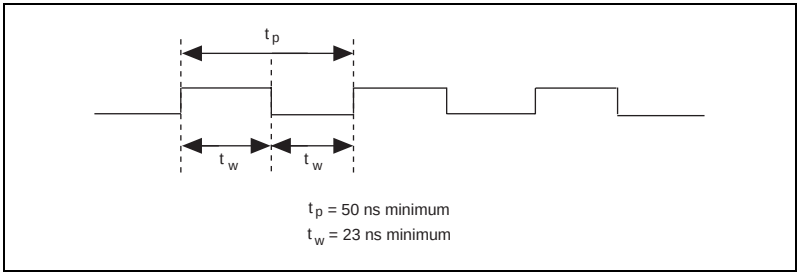


Figure 4-30. GPCTR0_SOURCE Signal Timing

The maximum allowed frequency is 20 MHz, with a minimum pulse width of 23 ns high or low. There is no minimum frequency limitation.

The 20 MHz or 100 kHz timebase normally generates the GPCTR0_SOURCE signal unless you select some external source.

GPCTR0_GATE Signal

Any PFI pin can externally input the GPCTR0_GATE signal, which is available as an output on the PFI9/GPCTR0_GATE pin.

As an input, the GPCTR0_GATE signal is configured in the edge-detection mode. You can select any PFI pin as the source for GPCTR0_GATE and configure the polarity selection for either rising or falling edge. You can use the gate signal in a variety of different applications to perform actions such as starting and stopping the counter, generating interrupts, saving the counter contents, and so on.

As an output, the GPCTR0_GATE signal reflects the actual gate signal connected to general-purpose counter 0. This is true even if the gate is being externally generated by another PFI. This output is set to tri-state at startup.

Figure 4-31 shows the timing requirements for the GPCTR0_GATE signal.

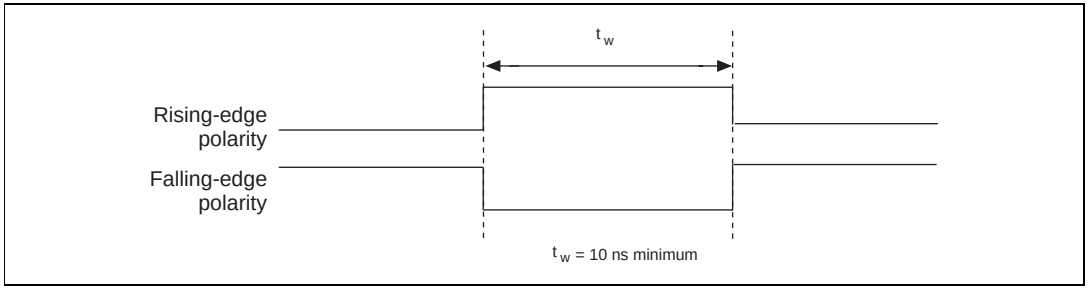


Figure 4-31. GPCTR0_GATE Signal Timing in Edge-Detection Mode

GPCTR0_OUT Signal

This signal is available only as an output on the GPCTR0_OUT pin. The GPCTR0_OUT signal reflects the terminal count (TC) of general-purpose counter 0. You have two software-selectable output options—pulse on TC and toggle output polarity on TC. The output polarity is software selectable for both options. This output is set to tri-state at startup. Figure 4-32 shows the timing of the GPCTR0_OUT signal.

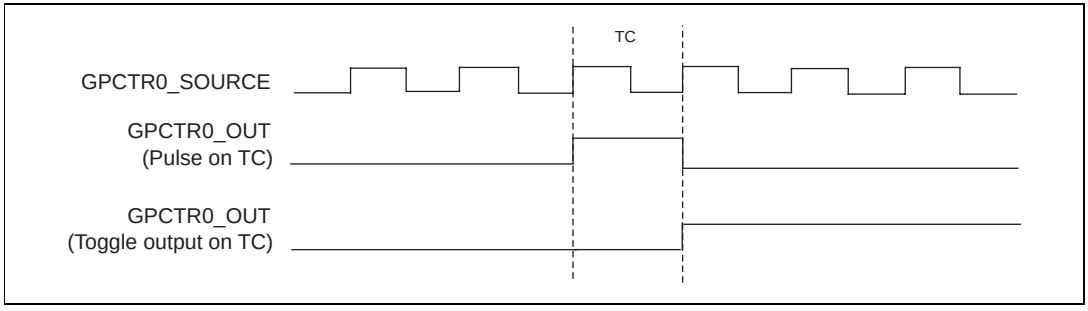


Figure 4-32. GPCTR0_OUT Signal Timing

GPCTR0_UP_DOWN Signal

This signal can be externally input on the DIO6 pin and is not available as an output on the I/O connector. The general-purpose counter 0 will count down when this pin is at a logic low and count up when it is at a logic high. You can disable this input so that software can control the up-down functionality and leave the DIO6 pin free for general use.

GPCTR1_SOURCE Signal

Any PFI pin can externally input the GPCTR1_SOURCE signal, which is available as an output on the PFI3/GPCTR1_SOURCE pin.

As an input, the GPCTR1_SOURCE signal is configured in the edge-detection mode. You can select any PFI pin as the source for GPCTR1_SOURCE and configure the polarity selection for either rising or falling edge.

As an output, the GPCTR1_SOURCE monitors the actual clock connected to general-purpose counter 1. This is true even if the source clock is being externally generated by another PFI. This output is set to tri-state at startup.

Figure 4-33 shows the timing requirements for the GPCTR1_SOURCE signal.

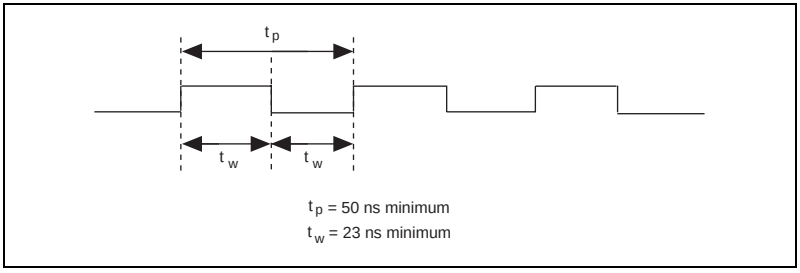


Figure 4-33. GPCTR1_SOURCE Signal Timing

The maximum allowed frequency is 20 MHz, with a minimum pulse width of 23 ns high or low. There is no minimum frequency limitation.

The 20 MHz or 100 kHz timebase normally generates the GPCTR1_SOURCE unless you select some external source.

GPCTR1_GATE Signal

Any PFI pin can externally input the GPCTR1_GATE signal, which is available as an output on the PFI4/GPCTR1_GATE pin.

As an input, the GPCTR1_GATE signal is configured in edge-detection mode. You can select any PFI pin as the source for GPCTR1_GATE and configure the polarity selection for either rising or falling edge. You can use the gate signal in a variety of different applications to perform such

actions as starting and stopping the counter, generating interrupts, saving the counter contents, and so on.

As an output, the GPCTR1_GATE signal monitors the actual gate signal connected to general-purpose counter 1. This is true even if the gate is being externally generated by another PFI. This output is set to tri-state at startup.

Figure 4-34 shows the timing requirements for the GPCTR1_GATE signal.

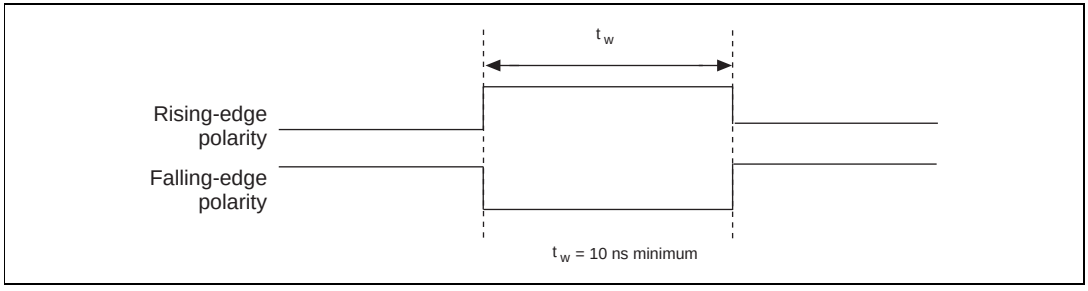


Figure 4-34. GPCTR1_GATE Signal Timing in Edge-Detection Mode

GPCTR1_OUT Signal

This signal is available only as an output on the GPCTR1_OUT pin. The GPCTR1_OUT signal monitors the TC board general-purpose counter 1. You have two software-selectable output options—pulse on TC and toggle output polarity on TC. The output polarity is software selectable for both options. This output is set to tri-state at startup. Figure 4-35 shows the timing requirements for the GPCTR1_OUT signal.

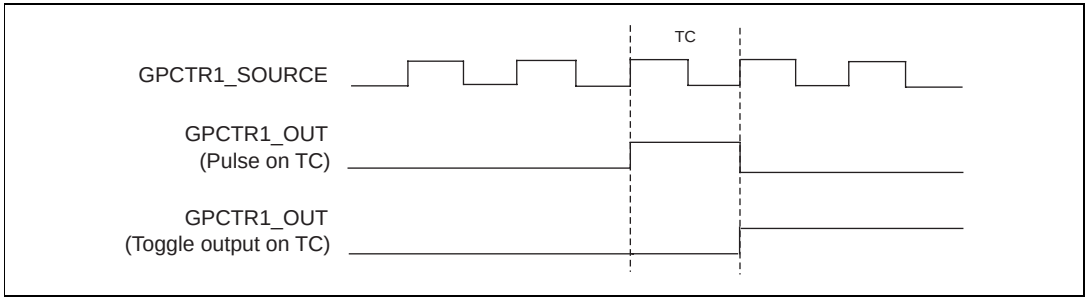


Figure 4-35. GPCTR1_OUT Signal Timing

GPCTR1_UP_DOWN Signal

This signal can be externally input on the DIO7 pin and is not available as an output on the I/O connector. General-purpose counter 1 counts down when this pin is at a logic low and counts up at a logic high. This input can be disabled so that software can control the up-down functionality and leave the DIO7 pin free for general use. Figure 4-36 shows the timing requirements for the GATE and SOURCE input signals and the timing specifications for the OUT output signals of your PCI E Series board.

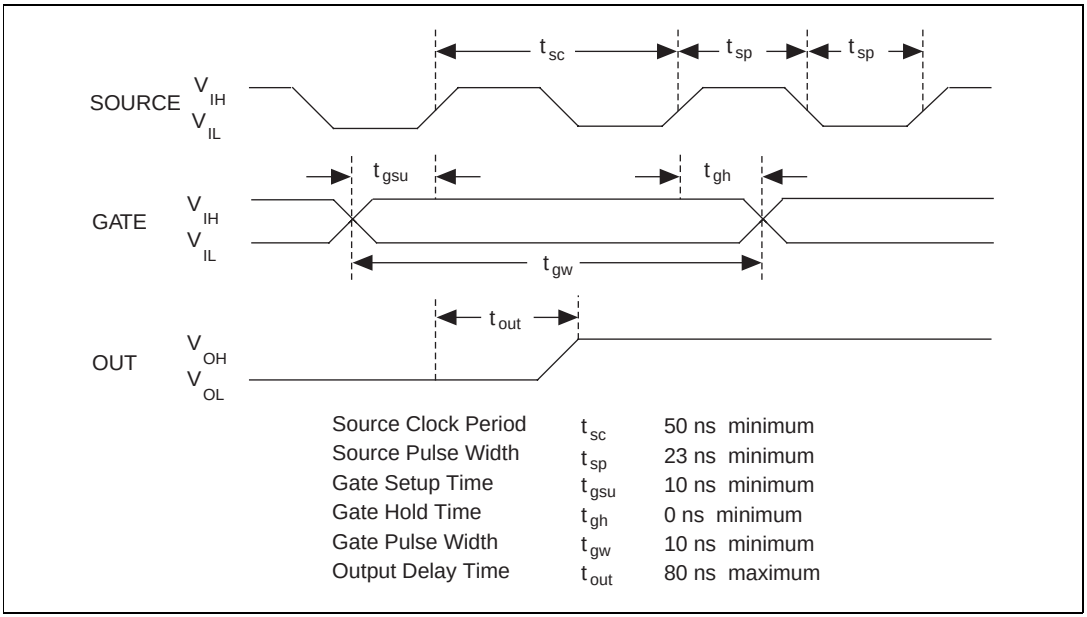


Figure 4-36. GPCTR Timing Summary

The GATE and OUT signal transitions shown in Figure 4-36 are referenced to the rising edge of the SOURCE signal. This timing diagram assumes that the counters are programmed to count rising edges. The same timing diagram, but with the source signal inverted and referenced to the falling edge of the source signal, would apply when the counter is programmed to count falling edges.

The GATE input timing parameters are referenced to the signal at the SOURCE input or to one of the internally generated signals on your PCI E Series board. Figure 4-36 shows the GATE signal referenced to the rising edge of a source signal. The gate must be valid (either high or

low) for at least 10 ns before the rising or falling edge of a source signal for the gate to take effect at that source edge, as shown by t_{gsu} and t_{gh} in Figure 4-36. The gate signal is not required to be held after the active edge of the source signal.

If you use an internal timebase clock, the gate signal cannot be synchronized with the clock. In this case, gates applied close to a source edge take effect either on that source edge or on the next one. This arrangement results in an uncertainty of one source clock period with respect to unsynchronized gating sources.

The OUT output timing parameters are referenced to the signal at the SOURCE input or to one of the internally generated clock signals on the PCI E Series boards. Figure 4-36 shows the OUT signal referenced to the rising edge of a source signal. Any OUT signal state changes occur within 80 ns after the rising or falling edge of the source signal.

FREQ_OUT Signal

This signal is available only as an output on the FREQ_OUT pin. The PCI E Series board frequency generator outputs the FREQ_OUT pin. The frequency generator is a 4-bit counter that can divide its input clock by the numbers 1 through 16. The input clock of the frequency generator is software- selectable from the internal 10 MHz and 100 kHz timebases. The output polarity is software selectable. This output is set to tri-state at startup.

Field Wiring Considerations

Environmental noise can seriously affect the accuracy of measurements made with your PCI E Series board if you do not take proper care when running signal wires between signal sources and the board. The following recommendations apply mainly to analog input signal routing to the board, although they also apply to signal routing in general.

Minimize noise pickup and maximize measurement accuracy by taking the following precautions:

- Use differential analog input connections to reject common-mode noise.
- Use individually shielded, twisted-pair wires to connect analog input signals to the board. With this type of wire, the signals attached to the CH+ and CH- inputs are twisted together and then covered with a shield. You then connect this shield only at one

point to the signal source ground. This kind of connection is required for signals traveling through areas with large magnetic fields or high electromagnetic interference.

- Route signals to the board carefully. Keep cabling away from noise sources. The most common noise source in a PCI data acquisition system is the video monitor. Separate the monitor from the analog signals as much as possible.

The following recommendations apply for all signal connections to your PCI E Series board:

- Separate PCI E Series board signal lines from high-current or high-voltage lines. These lines can induce currents in or voltages on the PCI E Series board signal lines if they run in parallel paths at a close distance. To reduce the magnetic coupling between lines, separate them by a reasonable distance if they run in parallel, or run the lines at right angles to each other.
- Do not run signal lines through conduits that also contain power lines.
- Protect signal lines from magnetic fields caused by electric motors, welding equipment, breakers, or transformers by running them through special metal conduits.

For more information, refer to the application note, *Field Wiring and Noise Consideration for Analog Signals,* available from National Instruments.

Chapter 5

Calibration

This chapter discusses the calibration procedures for your PCI E Series board. If you are using the NI-DAQ device driver, that software includes calibration functions for performing all of the steps in the calibration process.

Calibration refers to the process of minimizing measurement and output voltage errors by making small circuit adjustments. On the PCI E Series boards, these adjustments take the form of writing values to onboard calibration DACs (CalDACs).

Some form of board calibration is required for all but the most forgiving applications. If you do not calibrate your board, your signals and measurements could have very large offset, gain, and linearity errors.

Three levels of calibration are available to you and described in this chapter. The first level is the fastest, easiest, and least accurate, whereas the last level is the slowest, most difficult, and most accurate.

Loading Calibration Constants

Your PCI E Series board is factory calibrated before shipment at approximately 25° C to the levels indicated in Appendix A, *Specifications*. The associated calibration constants—the values that were written to the CalDACs to achieve calibration in the factory—are stored in the onboard nonvolatile memory (EEPROM). Because the CalDACs have no memory capability, they do not retain calibration information when the board is unpowered. Loading calibration constants refers to the process of loading the CalDACs with the values stored in the EEPROM. NI-DAQ software determines when this is necessary and does it automatically. If you are not using NI-DAQ, you must load these values yourself.

In the EEPROM there is a user-modifiable calibration area in addition to the permanent factory calibration area. This means that you can load the CalDACs with values either from the original factory calibration or from a calibration that you subsequently performed.

This method of calibration is not very accurate because it does not take into account the fact that the board measurement and output voltage errors can vary with time and temperature. It is better to self-calibrate when the board is installed in the environment in which it will be used.

Self-Calibration

Your PCI E Series board can measure and correct for almost all of its calibration-related errors without any external signal connections. Your National Instruments software provides a self-calibration method. This self-calibration process, which generally takes less than a minute, is the preferred method of assuring accuracy in your application. Initiate self-calibration to minimize the effects of any offset, gain, and linearity drifts, particularly those due to warmup.

Immediately after self-calibration, the only significant residual calibration error could be gain error due to time or temperature drift of the onboard voltage reference. This error is addressed by external calibration, which is discussed in the following section. If you are interested primarily in relative measurements, you can ignore a small amount of gain error, and self-calibration should be sufficient.

External Calibration

Your PCI E Series board has an onboard calibration reference to ensure the accuracy of self-calibration. Its specifications are listed in Appendix A, *Specifications*. The reference voltage is measured at the factory and stored in the EEPROM for subsequent self-calibrations. This voltage is stable enough for most applications, but if you are using your board at an extreme temperature or if the onboard reference has not been measured for a year or more, you may wish to externally calibrate your board.

An external calibration refers to calibrating your board with a known external reference rather than relying on the onboard reference. Redetermining the value of the onboard reference is part of this process and the results can be saved in the EEPROM, so you should not have to perform an external calibration very often. You can externally calibrate your board by calling the NI-DAQ calibration function.

To externally calibrate your board, be sure to use a very accurate external reference. The reference should be several times more accurate

than the board itself. For example, to calibrate a 16-bit board, the external reference should be at least ±0.001% (±10 ppm) accurate.

Other Considerations

The CalDACs adjust the gain error of each analog output channel by adjusting the value of the reference voltage supplied to that channel. This calibration mechanism is designed to work only with the internal 10 V reference. Thus, in general, it is not possible to calibrate the analog output gain error when using an external reference. In this case, it is advisable to account for the nominal gain error of the analog output channel either in software or with external hardware. See Appendix A, *Specifications*, for analog output gain error information.

Specifications

Appendix A

This appendix lists the specifications of each PCI E Series board. These specifications are typical at 25° C unless otherwise noted.

PCI-MIO-16E-1, PCI-MIO-16E-4, and PCI-6071E

Analog Input

Input Characteristics

Number of channels

PCI-MIO-16E-1, PCI-MIO-16E-4 ..... 16 single-ended or 8 differential (software-selectable per channel)

PCI-6071E ..... 64 single-ended or 32 differential (software-selectable per channel)

Type of ADC ..... Successive approximation

Resolution ..... 12 bits, 1 in 4,096

Max sampling rate (single-channel)[1]

PCI-MIO-16E-1, PCI-6071E ..... 1.25 MS/s

PCI-MIO-16E-4 ..... 500 kS/s

1. See settling time table in *Dynamic Characteristics* for multichannel rates.

Input signal ranges

Channel Gain (Software-Selectable)	Board Range (Software-Selectable)	
	Bipolar	Unipolar
0.5	±10 V	—
1	±5 V	0 to 10 V
2	±2.5 V	0 to 5 V
5	±1 V	0 to 2 V
10	±500 mV	0 to 1 V
20	±250 mV	0 to 500 mV
50	±100 mV	0 to 200 mV
100	±50 mV	0 to 100 mV

Input coupling ..... DC

Max working voltage

(signal and common mode)..... Each input should remain within ±11 V of ground

Overvoltage protection ..... ±25 V powered on, ±15 V powered off

Inputs protected

PCI-MIO-16E-1, PCI-MIO-16E-4 ..... ACH<0..15>, AISENSE

PCI-6071E ..... ACH<0..63>, AISENSE, AISENSE2

FIFO buffer size ..... 512 S

Data transfers ..... DMA, interrupts, programmed I/O

DMA modes .....Scatter-gather

Configuration memory size.....512 words

Transfer Characteristics

Relative accuracy.....±0.5 LSB typ dithered,
±1.5 LSB max undithered

DNL.....±0.5 LSB typ, ±1 LSB max

No missing codes.....12 bits, guaranteed

Offset error

State	PCI-MIO-16E-1 PCI-6071E	PCI-MIO-16E-4
Pregain error after calibration	±12 µV max	±16 µV max
Pregain error before calibration	±2.5 mV max	±4.0 mV max
Postgain error after calibration	±0.5 mV max	±0.8 mV max
Postgain error before calibration	±100 mV max	±200 mV max

Gain error (relative to calibration reference)

After calibration (gain = 1).....±0.02% of reading max

Before calibration.....±2.5% of reading max

Gain ≠ 1 with gain error
adjusted to 0 at gain = 1 .....±0.02% of reading max

Amplifier Characteristics

Input impedance

Normal powered on.....100 GΩ in parallel with 100 pF

Powered off.....820 Ω min.

Overload .....820 Ω min.

Input bias current.....±200 pA

Input offset current .....±100 pA

CMRR, all input ranges, DC to 60 Hz

Gain	CMRR	
	PCI-MIO-16E-1 PCI-6071E	PCI-MIO-16E-4
0.5	95 dB	90 dB
1	100 dB	95 dB
≥2	106 dB	100 dB

Dynamic Characteristics

Bandwidth

Signal	Bandwidth	
	PCI-MIO-16E-1 PCI-6071E	PCI-MIO-16E-4
Small (-3 dB)	1.6 MHz	600 kHz
Large (1% THD)	1 MHz	350 kHz

Settling time to full-scale step

Board	Gain	Accuracy		
		±0.012% (±0.5 LSB)	±0.024% (±1 LSB)	±0.098% (±4 LSB)
PCI-MIO-16E-1	0.5	2 µS typ, 3 µS max	1.5 µS typ, 2 µS max	1.5 µS typ, 2 µS max
	1	2 µS typ, 3 µS max	1.5 µS typ, 2 µS max	1.3 µS typ, 1.5 µS max
	2 to 50	2 µS typ, 3 µS max	1.5 µS typ, 2 µS max	0.9 µS typ, 1 µS max
	100	2 µS typ, 3 µS max	1.5 µS typ, 2 µS max	1 µS typ, 1.5 µS max

Board	Gain	Accuracy		
		±0.012% (±0.5 LSB)	**±0.024% (±1 LSB)**	**±0.098% (±4 LSB)**
PCI-MIO-16E-4	All	4 µS typ, 8 µS max	4 µS max	4 µS max
PCI-6071E	0.5	3 µS typ, 5 µS max	1.9 µS typ, 2.5 µS max	1.9 µS typ, 2 µS max
	1	3 µS typ, 5 µS max	1.9 µS typ, 2.5 µS max	1.2 µS typ, 1.4 µS max
	2 to 50	3 µS typ, 5 µS max	1.9 µS typ, 2.5 µS max	1.2 µS typ, 1.3 µS max
	100	3 µS typ, 5 µS max	1.9 µS typ, 2.5 µS max	1.2 µS typ, 1.4 µS max

System noise (LSBrms, not including quantization)

Board	Gain	Dither Off	Dither On
PCI-MIO-16E-1, PCI-6071E	0.5 to 10	0.25	0.5
	20	0.4	0.6
	50	0.5	0.7
	100	0.8	0.9
PCI-MIO-16E-4	0.5 to 5	0.15	0.5
	10 to 20	0.2	0.5
	50	0.35	0.6
	100	0.6	0.8

Crosstalk.....–80 dB, DC to 100 kHz

Stability

Offset temperature coefficient

- Pregain ..... ±5 µV/°C
- Postgain ..... ±240 µV/°C

Gain temperature coefficient ..... ±20 ppm/°C

Analog Output

Output Characteristics

Number of channels ..... 2 voltage

Resolution ..... 12 bits, 1 in 4,096

Max update rate

- 1 channel ..... 1 MS/s
- 2 channel ..... 600 kS/s–1 MS/s (system-dependent)

Type of DAC ..... Double-buffered, multiplying

FIFO buffer size

- PCI-MIO-16E-1, PCI-6071E ..... 2,048 S
- PCI-MIO-16E-4 ..... 512 S

Data transfers ..... DMA, interrupts, programmed I/O

DMA modes ..... Scatter gather

Transfer Characteristics

Relative accuracy (INL)

- After calibration ..... ±0.3 LSB typ, ±0.5 LSB max
- Before calibration ..... ±4 LSB max

DNL

- After calibration ..... ±0.3 LSB typ, ±1.0 LSB max
- Before calibration ..... ±3 LSB max

Monotonicity ..... 12 bits, guaranteed after calibration

Offset error

- After calibration ..... ±1.0 mV max
- Before calibration ..... ±200 mV max

Gain error (relative to internal reference)

- After calibration ..... ±0.01% of output max
- Before calibration ..... ±0.5% of output max

Gain error (relative to external reference) ..... +0% to +0.5% of output max, not adjustable

Voltage Output

Ranges ..... ±10 V, 0 to 10 V, ±EXTREF, 0 to EXTREF (software selectable)

Output coupling ..... DC

Output impedance ..... 0.1 Ω max

Current drive ..... ±5 mA max

Protection ..... Short-circuit to ground

Power-on state ..... 0 V

External reference input

- Range ..... ±11 V

Overvoltage protection ..... ±25 V powered on,
±15 V powered off
Input impedance ..... 10 kΩ
Bandwidth (–3 dB) ..... 1 MHz

Dynamic Characteristics

Settling time for full-scale step ..... 3 µs to ±0.5 LSB accuracy

Slew rate ..... 20 V/µs

Noise ..... 200 µVrms, DC to 1 MHz

Glitch energy (at midscale transition)
Magnitude
Reglitching disabled ..... ±20 mV
Reglitching enabled ..... ±4 mV
Duration ..... 1.5 µs

Stability

Offset temperature coefficient ..... ±50 µV/°C

Gain temperature coefficient
Internal reference ..... ±25 ppm/°C
External reference ..... ±25 ppm/°C

Digital I/O

Number of channels ..... 8 input/output

Compatibility ..... TTL/CMOS

Digital logic levels

Level	Min	Max
Input low voltage	0.0 V	0.8 V
Input high voltage	2.0 V	5.0 V
Input low current (V_{in} = 0 V)	—	-320 µA
Input high current (V_{in} = 5 V)	—	10 µA
Output low voltage (I_{OL} = 24 mA)	—	0.4 V
Output high voltage (I_{OH} = 13 mA)	4.35 V	—

Power-on state .....Input (High-Z)

Data transfers.....Programmed I/O

Timing I/O

Number of channels .....2 up/down counter/timers, 1 frequency scaler

Resolution

Counter/timers .....24 bits

Frequency scaler .....4 bits

Compatibility.....TTL/CMOS

Base clocks available

Counter/timers .....20 MHz, 100 kHz

Frequency scaler .....10 MHz, 100 kHz

Base clock accuracy.....±0.01%

Max source frequency.....20 MHz

Min source pulse duration .....10 ns, edge-detect mode

Min gate pulse duration ..... 10 ns, edge-detect mode

Data transfers ..... DMA, interrupts, programmed I/O

DMA modes ..... Scatter gather

Triggers

Analog Trigger

Source

PCI-MIO-16E-1, PCI-MIO-16E-4 ..... ACH<0..15>, external trigger (PFI0/TRIG1)

PCI-6071E ..... ACH<0..63>, external trigger (PFI0/TRIG1)

Level ..... ± full-scale, internal; ±10 V, external

Slope ..... Positive or negative (software selectable)

Resolution ..... 8 bits, 1 in 256

Hysteresis ..... Programmable

Bandwidth (-3 dB)

PCI-MIO-16E-1, PCI-6071E ..... 2 MHz internal, 7 MHz external

PCI-MIO-16E-4 ..... 650 kHz internal, 3.0 MHz external

External input (PFI0/TRIG1)

Impedance ..... 10 kΩ

Coupling ..... DC

Protection ..... –0.5 to V_{cc} + 0.5 V when configured as a digital signal, ±35 V when configured as an analog trigger signal or disabled, ±35 V powered off

Digital Trigger

Compatibility .....TTL

Response.....Rising or falling edge

Pulse width .....10 ns min

RTSI

Trigger Lines 7

Calibration

Recommended warm-up time ..... 15 min

Calibration interval .....1 year

External calibration reference .....>6 and <10 V

Onboard calibration reference

- Level .....5.000 V (±2.5 mV) (actual value stored in EEPROM)
- Temperature coefficient .....±5 ppm/°C max
- Long-term stability.....±15 ppm/$\sqrt{1,000\ \text{h}}$

Bus Interface

Type .....Master, slave

Power Requirement

+5 VDC (±5%)

- PCI-MIO-16E-1, PCI-6071E .....1.1 A
- PCI-MIO-16E-4 .....0.9 A

Power available at I/O connector .....+4.65 to +5.25 VDC at 1 A

Physical

Dimensions
(not including connectors) .....17.5 by 10.6 cm (6.9 by 4.2 in)

I/O connector

PCI-MIO-16E-1,
PCI-MIO-16E-4..... 68-pin male SCSI-II type
PCI-6071E..... 100-pin female 0.05 D-type

Environment

Operating temperature..... 0° to 55° C

Storage temperature ..... –55° to 150° C

Relative humidity..... 5% to 90% noncondensing

PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, and PCI-6033E

Analog Input

Input Characteristics

Number of channels

PCI-MIO-16XE-10, PCI-6032E ...16 single-ended or 8 differential (software-selectable)

PCI-6031E, PCI-6033E .....64 single-ended or 32 differential (software-selectable)

Type of ADC .....Successive approximation

Resolution.....16 bits, 1 in 65,536

Max sampling rate (single-channel)[1]...100 kS/s guaranteed

Input signal ranges

Gain (Software-Selectable)	Voltage Range (Software-Selectable)	
	Bipolar	Unipolar
1	±10 V	0 to 10 V
2	±5 V	0 to 5 V
5	±2 V	0 to 2 V
10	±1 V	0 to 1 V
20	±0.5 V	0 to 0.5 V
50	±0.2 V	0 to 0.2 V
100	±0.1 V	0 to 0.1 V

1. See settling time table in *Dynamic Characteristics* for multichannel rates.

Input coupling ..... DC

Max working voltage ..... Each input should remain within ±11 V of ground

Overvoltage protection ..... ±25 V powered on, ±15 V powered off

Inputs protected

PCI-MIO-16XE-10, PCI-6032E ..... ACH<0..15>, AISENSE

PCI-6031E, PCI-6033E ..... ACH<0..63>, AISENSE, AISENSE2

FIFO buffer size ..... 512 samples

Data transfers ..... DMA, interrupts, programmed I/O

DMA modes ..... Scatter gather

Configuration memory size ..... 512 words

Transfer Characteristics

Relative accuracy ..... ±0.75 LSB typ, ±1 LSB max

DNL ..... ±0.5 LSB typ, ±1 LSB max

No missing codes ..... 16 bits, guaranteed

Offset error

Pregain error after calibration ..... ±3 µV max

Pregain error before calibration ... ±2.2 mV max

Postgain error after calibration .... ±76 µV max

Postgain error before calibration.. ±102 mV max

Gain error (relative to calibration reference)

After calibration (gain = 1) ..... ±30.5 ppm of reading max

Before calibration ..... ±2,150 ppm of reading max

With gain error adjusted to 0 at gain = 1

Gain ≠ 1 ..... ±200 ppm of reading max

Amplifier Characteristics

Input impedance

Normal, powered on.....100 GΩ in parallel with 100 pF

Powered off.....820 Ω min

Overload .....820 Ω min

Input bias current.....±1 nA

Input offset current .....±2 nA

CMRR, DC to 60 Hz

Gain	CMRR
1	92 dB
2	97 dB
5	101 dB
10	104 dB
≥20	105 dB

Dynamic Characteristics

Bandwidth (–3 dB)

All gains.....255 kHz

Settling time for full-scale step (DC to all gains and ranges)

Board	Accuracy		
	±0.00076% (±0.5 LSB)	**±0.0015% (±1 LSB)**	**±0.0061% (±4 LSB)**
PCI-MIO-16XE-10 PCI-6032E	40 µs max	20 µs max	10 µs max
PCI-6031E PCI-6033E	50 µs max	25 µs max	10 µs max

System noise (including quantization noise)

Gain	±10 V Range	0 to 10 V Range
1 to 10	0.6 LSBrms	0.8 LSBrms
20	0.7 LSBrms	1.1 LSBrms
50	1.1 LSBrms	2.0 LSBrms
100	2.0 LSBrms	3.8 LSBrms

Dynamic range ..... 91.7 dB, ±10 V input with gain 1 to 10

Crosstalk ..... –70 dB max, DC to 100 kHz

Stability

Offset temperature coefficient

Pregain ..... ±5 µV/°C

Postgain ..... ±120 µV/°C

Gain temperature coefficient ..... ±8 ppm/°C

Analog Output (PCI-MIO-16XE-10 and PCI-6031E only)

Output Characteristics

Number of channels ..... 2 voltage

Resolution ..... 16 bits, 1 in 65,536

Max update rate ..... 100 kS/s

Type of DAC ..... Double-buffered

FIFO buffer size ..... 2,048 S

Data transfers ..... DMA, interrupts, programmed I/O

DMA modes ..... Scatter gather

Transfer Characteristics

Relative accuracy (INL).....±0.5 LSB typ, ±1 LSB max

DNL.....±1 LSB max

Monotonicity .....16 bits, guaranteed

Offset error

After calibration.....305 µV max

Before calibration.....20 mV max

Gain error (relative to internal reference)

After calibration.....±30.5 ppm max

Before calibration.....±2,000 ppm max

Voltage Output

Range.....±10 V, 0 to 10 V (software selectable)

Output coupling .....DC

Output impedance .....0.1 Ω max

Current drive.....±5 mA

Protection .....Short-circuit to ground

Power-on state .....0 V (±20 mV)

Dynamic Characteristics

Settling time for full-scale step .....10 µs to ±1 LSB accuracy

Slew rate.....5 V/µs

Noise .....60 µVrms, DC to 1 MHz

Stability

Offset temperature coefficient.....±50 µV/°C

Gain temperature coefficient.....±7.5 ppm/°C

Digital I/O

Number of channels ..... 8 input/output

Compatibility ..... TTL/CMOS

Digital logic levels

Level	Min	Max
Input low voltage	0 V	0.8 V
Input high voltage	2 V	5 V
Input low current	—	-320 µA
(V_{in} = 0 V)	—	10 µA
Input high current (V_{in} = 5 V)	—	
Output low voltage (I_{OUT} = 24 mA)	—	0.4 V
Output high voltage (I_{OUT} = 13 mA)	4.35 V	—

Power-on state..... Input (High-Z)

Data transfers ..... Programmed I/O

Timing I/O

Number of channels ..... 2 up/down counter/timers,
1 frequency scaler

Resolution

Counter/timers..... 24 bits

Frequency scaler..... 4 bits

Compatibility ..... TTL/CMOS

Base clocks available

Counter/timers..... 20 MHz, 100 kHz

Frequency scaler..... 10 MHz, 100 kHz

Base clock accuracy.....±0.01%

Max source frequency.....20 MHz

Min source pulse duration .....10 ns, edge-detect mode

Min gate pulse duration .....10 ns, edge-detect mode

Data transfers.....DMA, interrupts, programmed I/O

DMA modes .....Scatter gather

Triggers

Analog Trigger

Source

PCI-MIO-16XE-10 and PCI-6032E .....ACH<0..15>, PFI0/TRIG1

PCI-6031E and PCI-6033E .....ACH<0..63>, PFI0/TRIG1

Level.....± fullscale, internal; ±10 V, external

Slope.....Positive or negative (software selectable)

Resolution.....12 bits, 1 in 4,096

Hysteresis .....Programmable

Bandwidth (–3 dB).....255 kHz internal, 4 MHz external

External input (PFI0/TRIG1)

Impedance.....10 kΩ

Coupling .....DC

Protection.....0.5 to Vcc +0.5 V when configured as a digital signal; ±35 V when configured as an analog signal or disabled; ±35 V powered off

Accuracy ..... ±1% of fullscale range

Digital Trigger

Compatibility ..... TTL

Response ..... Rising or falling edge

Pulse width..... 10 ns min

RTSI

Trigger Lines..... 7

Calibration

Recommended warm-up time.....15 min

Calibration interval ..... 1 year

External calibration reference ..... >6 and <9.999 V

Onboard calibration reference

Level ..... 5.000 V (±2.0 mV) (actual value stored in EEPROM)

Temperature coefficient..... ±0.6 ppm/°C max

Long-term stability ..... ±6 ppm/ $\sqrt{1,000\ h}$

Bus Interface

Type ..... Master, slave

Power Requirement

+5 VDC (±5%)..... 1.5 A

Power available at I/O connector..... +4.65 to +5.25 VDC at 1 A

Physical

Dimensions
(not including connectors)..... 33.8 by 9.9 cm (13.3 by 3.9 in)

I/O connector

PCI-MIO-16XE-10,

PCI-6032E .....68-pin male SCSI-II type
PCI-6031E, PCI-6033E .....100-pin female 0.05 D-type

Environment

Operating temperature .....0 to 55° C

Storage temperature .....–55 to 150° C

Relative humidity .....5% to 90% noncondensing

PCI-MIO-16XE-50

Analog Input

Input Characteristics

Number of channels ..... 16 single-ended, or
8 differential
(software-selectable)

Type of ADC..... Successive approximation

Resolution ..... 16 bits, 1 in 65,536

Max sampling rate..... 20 kS/s guaranteed

Input signal ranges

Board Gain (Software-Selectable)	Board Range (Software-Selectable)	
	Bipolar	Unipolar
1	±10 V	0 to 10 V
2	±5 V	0 to 5 V
10	±1 V	0 to 1 V
100	±0.1 V	0 to 0.1 V

Input coupling ..... DC

Max working voltage

(signal and common mode)..... The common-mode signal (the average of two signals in a differential pair) should remain within ±8 V of ground, and each input should remain within ±11 V of ground.

Overvoltage protection.....±25 V powered on,
±15 V powered off

Inputs protected.....ACH<0..15>, AISENSE

FIFO buffer size.....2,048 samples

Data transfers.....DMA, interrupts,
programmed I/O

DMA modes .....Scatter-gather

Configuration memory size.....512 words

Transfer Characteristics

Relative accuracy.....±0.5 LSB typ, ±1 LSB max

DNL.....±0.5 LSB typ, ±1 LSB max

No missing codes.....16 bits, guaranteed

Offset error

Pregain error after calibration.....±3 µV max

Pregain error before calibration....±1 mV max

Postgain error after calibration .....±76 µV max

Postgain error before calibration ..±4 mV max

Gain error (relative to calibration reference)

After calibration (gain=1).....±30.5 ppm of reading max

Before calibration.....±2250 ppm of reading max

With gain error adjusted to 0 at gain = 1

Gain = 2, 10 .....±100 ppm of reading

Gain = 100 .....±2250 ppm of reading

Amplifier Characteristics

Input impedance

Normal, powered on.....7 GΩ in parallel with 100 pF

Powered off.....820 Ω min

Overload .....820 Ω min

Input bias current ..... ±10 nA

Input offset current..... ±20 nA

CMRR, DC to 60 Hz

Gain = 1 ..... 80 dB

Gain = 2 ..... 86 dB

Gain = 10..... 100 dB

Gain = 100..... 120 dB

Dynamic Characteristics

Bandwidth

Gain = 1, 2..... 63 kHz

Gain = 10..... 57 kHz

Gain = 100..... 33 kHz

Settling time for full-scale step

Gain = 1, 2, 10..... 50 µs max to ± 1 LSB

Gain = 100..... 75 µs max to ± 1 LSB

System noise (including quantization noise)

Gain = 1, 2, 10..... 0.5 LSB rms

Gain = 100..... 0.8 LSB rms bipolar,
1.4 LSB rms unipolar

Crosstalk ..... –85 dB max, DC to 20 kHz

Stability

Offset temperature coefficient

Pregain ..... ±1 µV/°C

Postgain..... ±12 µV/°C

Gain temperature coefficient ..... ±5 ppm/°C

Analog Output

Output Characteristics

Number of channels 2

Resolution.....12 bits, 1 in 4,096

Max update rate .....20 kS/s

Type of DAC .....Double-buffered

FIFO buffer size.....None

Data transfers.....DMA, interrupts, programmed I/O

DMA modes .....Scatter-gather

Transfer Characteristics

Relative accuracy (INL).....±0.5 LSB max

DNL.....±1 LSB max

Monotonicity .....12 bits, guaranteed

Offset error

- After calibration.....±0.5 mV max
- Before calibration.....±85 mV max

Gain error (relative to calibration reference)

- After calibration.....±0.01% of output max
- Before calibration.....±1% of output max

Voltage Output

Range.....±10 V

Output coupling .....DC

Output impedance .....0.1 Ω max

Current drive.....±5 mA

Protection .....Short-circuit to ground

Power-on state .....0 V (± 85 mV)

Dynamic Characteristics

Settling time to ±0.5 LSB (±0.01%)

for full-scale step ..... 50 µs

Slew rate ..... 2 V/µs

Noise..... 40 µVrms, DC to 1 MHz

Glitch energy (at midscale transition)

Magnitude ..... ±30 mV

Duration ..... 10 µs

Stability

Offset temperature coefficient ..... ±25 µV/°C

Gain temperature coefficient ..... ±15 ppm/°C

Digital I/O

Number of channels ..... 8 input/output

Compatibility ..... TTL/CMOS

Digital logic levels

Level	Min	Max
Input low voltage	0 V	0.8 V
Input high voltage	2 V	5 V
Input low current	—	-320 µA
Input high current	—	10 µA
Output low voltage (I_{OL} = 24 mA)	—	0.4 V
Output high voltage (I_{OH} = 13 mA)	4.35 V	—

Power-on state..... Input (High-Z)

Data transfers.....Programmed I/O

Timing I/O

Number of channels.....2 up/down counter/timers, 1 frequency scaler

Resolution

- Counter/timers.....24 bits
- Frequency scaler.....4 bits

Compatibility.....TTL/CMOS

Base clocks available

- Counter/timers.....20 MHz, 100 kHz
- Frequency scaler.....10 MHz, 100 kHz

Base clock accuracy.....±0.01%

Max source frequency.....20 MHz

Min source pulse duration.....10 ns, edge-detect mode

Min gate pulse duration.....10 ns, edge-detect mode

Data transfers.....DMA, interrupts, programmed I/O

DMA modes.....Scatter-gather

Triggers

Digital Trigger

Compatibility.....TTL

Response.....Rising or falling edge

Pulse width.....10 ns min

RTSI

Trigger Lines.....7

Calibration

Recommended warm-up time.....15 min

Calibration interval ..... 1 year

External calibration reference ..... >6 and <9.999 V

Onboard calibration reference

Level ..... 5.000 V (±2.0 mV) (actual value stored in EEPROM)

Temperature coefficient..... ±2 ppm/°C max

Long-term stability ..... ±15 ppm/ $\sqrt{1,000\ h}$

Bus Interface

Type ..... Master, slave

Power Requirement

+5 VDC (±5%)..... 1.0 A

Power available at I/O connector..... +4.65 to +5.25 VDC at 1 A

Physical

Dimensions
(not including connectors)..... 17.5 by 9.9 cm (6.9 by 3.9 in)

I/O connector ..... 68-pin male SCSI-II type

Environment

Operating temperature..... 0 to 55° C

Storage temperature ..... –55 to 150° C

Relative humidity..... 5% to 90% noncondensing

Optional Cable Connector Descriptions

Appendix
B

This appendix describes the connectors on the optional cables for the PCI E Series boards.

Figure B-1 shows the pin assignments for the 68-pin E Series connector. This connector is available when you use the SH6868 or R6868 cable assemblies with the PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-10, PCI-MIO-16XE-50, and PCI-6032E. It is also one of the two 68-pin connectors available when you use the SH1006868 cable assembly with the PCI-6031E, PCI-6033E, or PCI-6071E.

ACH8	34	68	ACH0
ACH1	33	67	AIGND
AIGND	32	66	ACH9
ACH10	31	65	ACH2
ACH3	30	64	AIGND
AIGND	29	63	ACH11
ACH4	28	62	AISENSE
AIGND	27	61	ACH12
ACH13	26	60	ACH5
ACH6	25	59	AIGND
AIGND	24	58	ACH14
ACH15	23	57	ACH7
DAC0OUT[1]	22	56	AIGND
DAC1OUT[1]	21	55	AOGND
EXTREF[2]	20	54	AOGND
DIO4	19	53	DGND
DGND	18	52	DIO0
DIO1	17	51	DIO5
DIO6	16	50	DGND
DGND	15	49	DIO2
+5 V	14	48	DIO7
DGND	13	47	DIO3
DGND	12	46	SCANCLK
PFI0/TRIG1	11	45	EXTSTROBE*
PFI1/TRIG2	10	44	DGND
DGND	9	43	PFI2/CONVERT*
+5 V	8	42	PFI3/GPCTR1_SOURCE
DGND	7	41	PFI4/GPCTR1_GATE
PFI5/UPDATE*	6	40	GPCTR1_OUT
PFI6/WFTRIG	5	39	DGND
DGND	4	38	PFI7/STARTSCAN
PFI9/GPCTR0_GATE	3	37	PFI8/GPCTR0_SOURCE
GPCTR0_OUT	2	36	DGND
FREQ_OUT	1	35	DGND

[1] Not available on the PCI-6032E or PCI-6033E

[2] Not available on the PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6032E, or PCI-6033E

Figure B-1. 68-Pin E Series Connector Pin Assignments

Figure B-2 shows the pin assignments for the 68-pin extended analog input connector. This is the other 68-pin connector available when you use the SH1006868 cable assembly with the PCI-6031E, PCI-6033E, or the PCI-6071E.

ACH 24	34	68	ACH 16
ACH 17	33	67	ACH 25
ACH 18	32	66	ACH 26
ACH 27	31	65	ACH 19
ACH 20	30	64	ACH 28
ACH 21	29	63	ACH 29
ACH 30	28	62	ACH 22
ACH 23	27	61	ACH 31
ACH 32	26	60	ACH 40
ACH 41	25	59	ACH 33
ACH 34	24	58	ACH 42
ACH 35	23	57	ACH 43
AIGND	22	56	AISENSE2
ACH 44	21	55	ACH 36
ACH 37	20	54	ACH 45
ACH 38	19	53	ACH 46
ACH 47	18	52	ACH 39
ACH 48	17	51	ACH 56
ACH 49	16	50	ACH 57
ACH 58	15	49	ACH 50
ACH 51	14	48	ACH 59
ACH 52	13	47	ACH 60
ACH 61	12	46	ACH 53
ACH 54	11	45	ACH 62
ACH 55	10	44	ACH 63
N/C	9	43	N/C
N/C	8	42	N/C
N/C	7	41	N/C
N/C	6	40	N/C
N/C	5	39	N/C
N/C	4	38	N/C
N/C	3	37	N/C
N/C	2	36	N/C
N/C	1	35	N/C

Figure B-2. 68-Pin Extended Analog Input Connector Pin Assignments

Figure B-3 shows the pin assignments for the 50-pin E Series connector. This connector is available when you use the SH6850 or R6850 cable assemblies with the PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-10, PCI-MIO-16XE-50, or PCI-6032E. It is also one of the two 50-pin connectors available when you use the RI005050 cable assembly with the PCI-6031E, PCI-6033E, or PCI-6071E.

AIGND	1	2	AIGND
ACH0	3	4	ACH8
ACH1	5	6	ACH9
ACH2	7	8	ACH10
ACH3	9	10	ACH11
ACH4	11	12	ACH12
ACH5	13	14	ACH13
ACH6	15	16	ACH14
ACH7	17	18	ACH15
AISENSE	19	20	DAC0OUT[1]
DAC1OUT[1]	21	22	EXTREF[2]
AOGND	23	24	DGND
DIO0	25	26	DIO4
DIO1	27	28	DIO5
DIO2	29	30	DIO6
DIO3	31	32	DIO7
DGND	33	34	+5 V
+5 V	35	36	SCANCLK
EXTSTROBE*	37	38	PFI0/TRIG1
PFI1/TRIG2	39	40	PFI2/CONVERT*
PFI3/GPCTR1_SOURCE	41	42	PFI4/GPCTR1_GATE
GPCTR1_OUT	43	44	PFI5/UPDATE*
PFI6/WFTRIG	45	46	PFI7/STARTSCAN
PFI8/GPCTR0_SOURCE	47	48	PFI9/GPCTR0_GATE
GPCTR0_OUT	49	50	FREQ_OUT

[1] Not available on the PCI-6032E or PCI-6033E

[2] Not available on the PCI-MIO-16XE-10, PCI-MIO-16XE-50, PCI-6031E, PCI-6032E, or PCI-6033E

Figure B-3. 50-Pin E Series Connector Pin Assignments

Figure B-4 shows the pin assignments for the 50-pin extended analog input connector. This is the other 50-pin connector available when you use the R1005050 cable assembly with the PCI-6031E, PCI-6033E, and PCI-6071E.

ACH16	1	2	ACH24
ACH17	3	4	ACH25
ACH18	5	6	ACH26
ACH19	7	8	ACH27
ACH20	9	10	ACH28
ACH21	11	12	ACH29
ACH22	13	14	ACH30
ACH23	15	16	ACH31
ACH32	17	18	ACH40
ACH33	19	20	ACH41
ACH34	21	22	ACH42
ACH35	23	24	ACH43
AISENSE2	25	26	AIGND
ACH36	27	28	ACH44
ACH37	29	30	ACH45
ACH38	31	32	ACH46
ACH39	33	34	ACH47
ACH48	35	36	ACH56
ACH49	37	38	ACH57
ACH50	39	40	ACH58
ACH51	41	42	ACH59
ACH52	43	44	ACH60
ACH53	45	46	ACH61
ACH54	47	48	ACH62
ACH55	49	50	ACH63

Figure B-4. 50-Pin Extended Analog Input Connector Pin Assignments

Common Questions

Appendix C

This appendix contains a list of commonly asked questions and their answers relating to usage and special features of your PCI E Series board.

General Information

What are the PCI E Series boards?

The PCI E Series boards are switchless and jumperless enhanced MIO boards that use the DAQ-STC for timing.

What is the DAQ-STC?

The DAQ-STC is the system timing control application-specific integrated circuit (ASIC) designed by National Instruments and is the backbone of the PCI E Series boards. The DAQ-STC contains seven 24-bit counters and three 16-bit counters. The counters are divided into the following three groups:

- Analog input—two 24-bit, two 16-bit counters
- Analog output—three 24-bit, one 16-bit counters
- General-purpose counter/timer functions—two 24-bit counters

The groups can be configured independently with timing resolutions of 50 ns or 10 µs. With the DAQ-STC, you can interconnect a wide variety of internal timing signals to other internal blocks. The interconnection scheme is quite flexible and completely software configurable. New capabilities such as buffered pulse generation, equivalent time sampling, and seamlessly changing the sampling rate are possible.

What does sampling rate mean to me?

It means that this is the fastest you can acquire data on your board and still achieve accurate results. For example, the PCI-MIO-16XE-50 has a sampling rate of 20 kS/s. This sampling rate is aggregate: one channel at 20 kS/s or two channels at 10 kS/s per channel illustrates the relationship. Notice, however, that some PCI E Series boards have

settling times that vary with gain and accuracy. See Appendix A for exact specifications.

What type of 5 V protection do the PCI E Series boards have?

The PCI E Series boards have 5 V lines equipped with a self-resetting 1 A fuse.

Installation and Configuration

How do you set the base address for a PCI E Series board?

The base address of a PCI E Series board is assigned automatically through the PCI bus protocol. This assignment is completely transparent to you.

What jumpers should I be aware of when configuring my PCI E Series board?

The PCI E Series boards are jumperless and switchless.

Which National Instruments document should I read first to get started using DAQ software?

Your NI-DAQ or application software release notes documentation is always the best starting place.

Analog Input and Output

I'm using my board in differential analog input mode and I have connected a differential input signal, but my readings are random and drift rapidly. What's wrong?

Check your ground reference connections. Your signal may be referenced to a level that is considered *floating* with reference to the board ground reference. Even if you are in differential mode, the signal *must* still be referenced to the same ground level as the board reference. There are various methods of achieving this while maintaining a high common-mode rejection ratio (CMRR). These methods are outlined in Chapter 4, *Signal Connections*.

I'm using the DACs to generate a waveform, but I discovered with a digital oscilloscope that there are glitches on the output signal. Is this normal?

When it switches from one voltage to another, any DAC produces glitches due to released charges. The largest glitches occur when the most significant bit (MSB) of the D/A code switches. You can build a lowpass deglitching filter to remove some of these glitches, depending on the frequency and nature of your output signal. The PCI-MIO-16E-1 and PCI-6071E boards have built-in reglitchers, which can be software-enabled, on its analog output channels. See the *Analog Output Reglitch Selection* section in Chapter 3, *Hardware Overview*, for more information about reglitching.

Can I synchronize a one-channel analog input data acquisition with a one-channel analog output waveform generation on my PCI E Series board?

Yes. One way to accomplish this is to use the waveform generation timing pulses to control the analog input data acquisition. To do this, follow steps 1 through 4 below, in addition to the usual steps for data acquisition and waveform generation configuration.

1. Enable the PFI5 line for output, as follows:
   - If you are using NI-DAQ, call `Select_Signal(deviceNumber, ND_PFI_5, ND_OUT_UPDATE, ND_HIGH_TO_LOW)`.
   - If you are using LabVIEW, invoke Route Signal VI with signal name set to PFI5 and signal source set to AO Update.
2. Set up data acquisition timing so that the timing signal for A/D conversion comes from PFI5, as follows:
   - If you are using NI-DAQ, call `Select_Signal(deviceNumber, ND_IN_CONVERT, ND_PFI_5, ND_HIGH_TO_LOW)`.
   - If you are using LabVIEW, invoke AI Clock Config VI with clock source code set to PFI pin, high to low, and clock source string set to 5.
3. Initiate analog input data acquisition, which will start only when the analog output waveform generation starts.
4. Initiate analog output waveform generation.

Timing and Digital I/O

What types of triggering can be hardware-implemented on my PCI E Series board?

Digital triggering is hardware-supported on every PCI E Series board. In addition, the PCI-MIO-16E-1, PCI-MIO-16E-4, PCI-MIO-16XE-10, PCI-6031E, PCI-6032E, PCI-6033E, and PCI-6071E support analog triggering in hardware.

What added functionality does the DAQ-STC make possible in contrast to the Am9513?

The DAQ-STC incorporates much more than just 10 Am9513-style counters within one chip. In fact, the DAQ-STC has the complexity of more than 24 chips. The DAQ-STC makes possible PFI lines, analog triggering, selectable logic level, and frequency shift keying. The DAQ-STC also makes buffered operations possible, such as direct up/down control, single or pulse train generation, equivalent time sampling, buffered period, and buffered semiperiod measurement.

What is the difference in timebases between the Am9513 counter/timer and the DAQ-STC?

The DAQ-STC-based MIO boards have a 20 MHz timebase. The Am9513-based MIO boards have a 1 MHz or 5 MHz timebase.

Will the counter/timer applications that I wrote previously work with the DAQ-STC?

If you are using NI-DAQ with LabVIEW, some of your applications drawn using the CTR VIs will still run. However, there are many differences in the counters between the PCI E Series and other boards; the counter numbers are different, timebase selections are different, and the DAQ-STC counters are 24-bit counters (unlike the 16-bit counters on boards without the DAQ-STC).

If you are using the NI-DAQ language interface or LabWindows/CVI, the answer is no, the counter/timer applications that you wrote previously will not work with the DAQ-STC. You must use the GPCTR functions; ICTR and CTR functions will not work with the DAQ-STC. The GPCTR functions have the same capabilities as the ICTR and CTR functions, plus more, but you must rewrite the application with the GPCTR function calls.

I'm using one of the general-purpose counter/timers on my PCI E Series board, but I do not see the counter/timer output on the I/O connector. What am I doing wrong?

If you are using the NI-DAQ language interface or LabWindows/CVI, you must configure the output line to output the signal to the I/O connector. Use the `Select_Signal` call in NI-DAQ to configure the output line. By default, all timing I/O lines except EXTSTROBE* are tri-stated.

What are the PFIs and how do I configure these lines?

PFIs are Programmable Function Inputs. These lines serve as connections to virtually all internal timing signals.

If you are using the NI-DAQ language interface or LabWindows/CVI, use the `Select_Signal` function to route internal signals to the I/O connector, route external signals to internal timing sources, or tie internal timing signals together.

If you are using NI-DAQ with LabVIEW and you want to connect external signal sources to the PFI lines, you can use AI Clock Config, AI Trigger Config, AO Clock Config, AO Trigger and Gate Config, CTR Mode Config, and CTR Pulse Config advanced level VIs to indicate which function the connected signal will serve. Use the Route Signal VI to enable the PFI lines to output internal signals.

Caution: ***If you enable a PFI line for output, do not connect any external signal source to it; if you do, you can damage the board, the computer, and the connected equipment.***

What are the power-on states of the PFI and DIO lines on the I/O connector?

At system power-on and reset, both the PFI and DIO lines are set to high impedance by the hardware. This means that the board circuitry is not actively driving the output either high or low. However, these lines may have pull-up or pull-down resistors connected to them as shown in Tables 4-1, 4-2, and 4-3. These resistors weakly pull the output to either a logic high or logic low state. For example, DIO(0) will be in the high impedance state after power on, and Table 4-1 shows that there is a 50 kΩ pull-up resistor. This pull-up resistor will set the DIO(0) pin to a logic high when the output is in a high impedance state.

Customer Communication

Appendix
D

For your convenience, this appendix contains forms to help you gather the information necessary to help us solve your technical problems and a form you can use to comment on the product documentation. When you contact us, we need the information on the Technical Support Form and the configuration form, if your manual contains one, about your system configuration to answer your questions as quickly as possible.

National Instruments has technical assistance through electronic, fax, and telephone systems to quickly provide the information you need. Our electronic services include a bulletin board service, an FTP site, a fax-on-demand system, and e-mail support. If you have a hardware or software problem, first try the electronic support systems. If the information available on these systems does not answer your questions, we offer fax and telephone support through our technical support centers, which are staffed by applications engineers.

Electronic Services

Bulletin Board Support

National Instruments has BBS and FTP sites dedicated for 24-hour support with a collection of files and documents to answer most common customer questions. From these sites, you can also download the latest instrument drivers, updates, and example programs. For recorded instructions on how to use the bulletin board and FTP services and for BBS automated information, call (512) 795-6990. You can access these services at:

United States: (512) 794-5422
Up to 14,400 baud, 8 data bits, 1 stop bit, no parity

United Kingdom: 01635 551422
Up to 9,600 baud, 8 data bits, 1 stop bit, no parity

France: 01 48 65 15 59
Up to 9,600 baud, 8 data bits, 1 stop bit, no parity

FTP Support

To access our FTP site, log on to our Internet host, `ftp.natinst.com`, as `anonymous` and use your Internet address, such as `joesmith@anywhere.com`, as your password. The support files and documents are located in the `/support` directories.

Fax-on-Demand Support

Fax-on-Demand is a 24-hour information retrieval system containing a library of documents on a wide range of technical information. You can access Fax-on-Demand from a touch-tone telephone at (512) 418-1111.

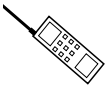
E-Mail Support (currently U.S. only)

You can submit technical support questions to the applications engineering team through e-mail at the Internet address listed below. Remember to include your name, address, and phone number so we can contact you with solutions and suggestions.

`support@natinst.com`

Telephone and Fax Support

National Instruments has branch offices all over the world. Use the list below to find the technical support number for your country. If there is no National Instruments office in your country, contact the source from which you purchased your software to obtain support.

	 Telephone	 Fax
Australia	03 9879 5166	03 9879 6277
Austria	0662 45 79 90 0	0662 45 79 90 19
Belgium	02 757 00 20	02 757 03 11
Canada (Ontario)	905 785 0085	905 785 0086
Canada (Quebec)	514 694 8521	514 694 4399
Denmark	45 76 26 00	45 76 26 02
Finland	09 725 725 11	09 725 725 55
France	01 48 14 24 24	01 48 14 24 14
Germany	089 741 31 30	089 714 60 35
Hong Kong	2645 3186	2686 8505
Israel	03 5734815	03 5734816
Italy	02 413091	02 41309215
Japan	03 5472 2970	03 5472 2977
Korea	02 596 7456	02 596 7455
Mexico	5 520 2635	5 520 3282
Netherlands	0348 433466	0348 430673
Norway	32 84 84 00	32 84 86 00
Singapore	2265886	2265887
Spain	91 640 0085	91 640 0533
Sweden	08 730 49 70	08 730 43 70
Switzerland	056 200 51 51	056 200 51 55
Taiwan	02 377 1200	02 737 4644
United Kingdom	01635 523545	01635 523154

Technical Support Form

Photocopy this form and update it each time you make changes to your software or hardware, and use the completed copy of this form as a reference for your current configuration. Completing this form accurately before contacting National Instruments for technical support helps our applications engineers answer your questions more efficiently.

If you are using any National Instruments hardware or software products related to this problem, include the configuration forms from their user manuals. Include additional pages if necessary.

Name _____

Company _____

Address _____

_____

Fax (___)_____ Phone (___) _____

Computer brand _____ Model _____ Processor_____

Operating system (include version number) _____

Clock speed _____MHz RAM _____MB Display adapter _____

Mouse ___yes ___no Other adapters installed _____

Hard disk capacity _____MB Brand _____

Instruments used _____

_____

National Instruments hardware product model _____ Revision _____

Configuration _____

National Instruments software product _____ Version _____

Configuration _____

The problem is: _____

_____

_____

_____

_____

List any error messages: _____

_____

_____

The following steps reproduce the problem:_____

_____

_____

_____

_____

_____

PCI E Series Hardware and Software Configuration Form

Record the settings and revisions of your hardware and software on the line to the right of each item. Complete a new copy of this form each time you revise your software or hardware configuration, and use this form as a reference for your current configuration. Completing this form accurately before contacting National Instruments for technical support helps our applications engineers answer your questions more efficiently.

National Instruments Products

PCI E Series board _____

PCI E Series board serial number _____

Base memory address of PCI E Series board _____

Interrupt level of PCI E Series board _____

Programming choice (NI-DAQ, LabVIEW, LabWindows/CVI, or other)_____

Software version _____

Other Products

Computer make and model _____

Microprocessor _____

Clock frequency or speed _____

Type of video board installed _____

Operating system (DOS or Windows) _____

Operating system version _____

Operating system mode _____

Programming language _____

Programming language version _____

Other boards in system _____

Base memory address of other boards _____

Interrupt level of other boards _____

Documentation Comment Form

National Instruments encourages you to comment on the documentation supplied with our products. This information helps us provide quality products to meet your needs.

Title: *PCI E Series User Manual*

Edition Date: January 1999

Part Number: 320945D-01

Please comment on the completeness, clarity, and organization of the manual.

_____

_____

_____

_____

_____

_____

_____

If you find errors in the manual, please record the page numbers and describe the errors.

_____

_____

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_____

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Thank you for your help.

Name _____

Title _____

Company _____

Address _____

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Prefix	Meaning	Value
p-	pico-	10^{-12}
n-	nano-	10^{-9}
µ-	micro-	10^{-6}
m-	milli-	10^{-3}
k-	kilo-	10^{3}
M-	mega-	10^{6}
G-	giga-	10^{9}

Symbols/Numbers

°	degrees
>	greater than
≥	greater than or equal to
<	less than
≤	less than or equal to
/	per
%	percent
±	plus or minus
+	positive of, or plus

–	negative of, or minus
Ω	ohms
$\sqrt{\ }$	square root of
+5 V	+5 VDC source signal

A

A	amperes
AC	alternating current
ACH	analog input channel signal
A/D	analog-to-digital
ADC	analog-to-digital converter—an electronic device, often an integrated circuit, that converts an analog voltage to a digital number
AI	analog input
AIGATE	analog input gate signal
AIGND	analog input ground signal
AISENSE	analog input sense signal
ANSI	American National Standards Institute
AO	analog output
AOGND	analog output ground signal
ASIC	Application-Specific Integrated Circuit—a proprietary semiconductor component designed and manufactured to perform a set of specific functions.

B

BIOS	basic input/output system—BIOS functions are the fundamental level of any PC or compatible computer. BIOS functions embody the basic operations needed for successful use of the computer's hardware resources.
bipolar	a signal range that includes both positive and negative values (for example, –5 V to +5 V)

C

C	Celsius
CalDAC	calibration DAC
CH	channel—pin or wire lead to which you apply or from which you read the analog or digital signal. Analog signals can be single-ended or differential. For digital signals, you group channels to form ports. Ports usually consist of either four or eight digital channels
cm	centimeter
CMOS	complementary metal-oxide semiconductor
CMRR	common-mode rejection ratio—a measure of an instrument's ability to reject interference from a common-mode signal, usually expressed in decibels (dB)
CONVERT*	convert signal
counter/timer	a circuit that counts external pulses or clock pulses (timing)
CTR	counter

D

D/A	digital-to-analog
DAC	digital-to-analog converter—an electronic device, often an integrated circuit, that converts a digital number into a corresponding analog voltage or current

DAC0OUT	analog channel 0 output signal
DAC1OUT	analog channel 1 output signal
DAQ	data acquisition—a system that uses the computer to collect, receive, and generate electrical signals
dB	decibel—the unit for expressing a logarithmic measure of the ratio of two signal levels: dB=20log10 V1/V2, for signals in volts
DC	direct current
DGND	digital ground signal
DIFF	differential mode
DIO	digital input/output
DIP	dual inline package
dithering	the addition of Gaussian noise to an analog input signal
DMA	direct memory access—a method by which data can be transferred to/from computer memory from/to a device or memory on the bus while the processor does something else. DMA is the fastest method of transferring data to/from computer memory.
DNL	differential nonlinearity—a measure in LSB of the worst-case deviation of code widths from their ideal value of 1 LSB
DO	digital output

E

EEPROM	electrically erasable programmable read-only memory—ROM that can be erased with an electrical signal and reprogrammed
EXTREF	external reference signal
EXTSTROBE	external strobe signal

F

FIFO	first-in first-out memory buffer—FIFOs are often used on DAQ devices to temporarily store incoming or outgoing data until that data can be read or written. For example, an analog input FIFO stores the results of A/D conversions until the data can be read into system memory. Programming the DMA controller and servicing interrupts can take several milliseconds in some cases. During this time, data accumulates in the FIFO for future retrieval. With a larger FIFO, longer latencies can be tolerated. In the case of analog output, a FIFO permits faster update rates, because the waveform data can be stored in the FIFO ahead of time. This again reduces the effect of latencies associated with getting the data from system memory to the DAQ device.
FREQ_OUT	frequency output signal
ft	feet

G

GATE	gate signal
GPCTR	general purpose counter
GPCTR0_GATE	general purpose counter 0 gate signal
GPCTR0_OUT	general purpose counter 0 output signal
GPCTR0_SOURCE	general purpose counter 0 clock source signal
GPCTR0_UP_DOWN	general purpose counter 0 up down
GPCTR1_GATE	general purpose counter 1 gate signal
GPCTR1_OUT	general purpose counter 1 output signal
GPCTR1_SOURCE	general purpose counter 1 clock source signal
GPCTR1_UP_DOWN	general purpose counter 1 up down

H

h	hour
hex	hexadecimal
Hz	hertz

I

I/O	input/output—the transfer of data to/from a computer system involving communications channels, operator interface devices, and/or data acquisition and control interfaces
I_{OH}	current, output high
I_{OL}	current, output low
INL	relative accuracy

L

LSB	least significant bit

M

m	meter
MB	megabytes of memory
MIO	multifunction I/O
MITE	MXI Interfaces to Everything
MSB	most significant bit
mux	multiplexer—a switching device with multiple inputs that sequentially connects each of its inputs to its output, typically at high speeds, in order to measure several signals with a single analog input channel

N

NC	normally closed, or not connected
NI-DAQ	NI driver software for DAQ hardware
noise	an undesirable electrical signal—Noise comes from external sources such as the AC power line, motors, generators, transformers, fluorescent lights, CRT displays, computers, electrical storms, welders, radio transmitters, and internal sources such as semiconductors, resistors, and capacitors. Noise corrupts signals you are trying to send or receive.
NRSE	nonreferenced single-ended mode—all measurements are made with respect to a common (NRSE) measurement system reference, but the voltage at this reference can vary with respect to the measurement system ground

O

OUT	output pin—a counter output pin where the counter can generate various TTL pulse waveforms

P

PCI	Peripheral Component Interconnect—a high-performance expansion bus architecture originally developed by Intel to replace ISA and EISA. It is achieving widespread acceptance as a standard for PCs and work-stations; it offers a theoretical maximum transfer rate of 132 MB/s.
PFI	Programmable Function Input
PFI0/TRIG1	PFI0/trigger 1
PFI1/TRIG2	PFI1/trigger 2
PFI2/CONVERT*	PFI2/convert
PFI3/GPCTR1_SOURCE	PFI3/general purpose counter 1 source
PFI4/GPCTR1_GATE	PFI4/general purpose counter 1 gate

PFI5/UPDATE*	PFI5/update
PFI6/WFTRIG	PFI6/waveform trigger
PFI7/STARTSCAN	PFI7/start of scan
PFI8/GPCTR0_SOURCE	PFI8/general purpose counter 0 source
PFI9/GPCTR0_GATE	PFI9/general purpose counter 0 gate
PGIA	Programmable Gain Instrumentation Amplifier
port	(1) a communications connection on a computer or a remote controller (2) a digital port, consisting of four or eight lines of digital input and/or output
ppm	parts per million
pu	pullup

R

RAM	random access memory
rms	root mean square
RSE	referenced single-ended mode—all measurements are made with respect to a common reference measurement system or a ground. Also called a grounded measurement system.
RTD	resistive temperature detector—a metallic probe that measures temperature based upon its coefficient of resistivity
RTSIbus	real-time system integration bus—the National Instruments timing bus that connects DAQ boards directly, by means of connectors on top of the boards, for precise synchronization of functions

S

s	seconds
S	samples
SCANCLK	scan clock signal

SCXI	Signal Conditioning eXtensions for Instrumentation—the National Instruments product line for conditioning low-level signals within an external chassis near sensors so only high-level signals are sent to DAQ boards in the noisy computer environment
SE	single-ended—a term used to describe an analog input that is measured with respect to a common ground
settling time	the amount of time required for a voltage to reach its final value within specified limits
signal conditioning	the manipulation of signals to prepare them for digitizing
SISOURCE	SI counter clock signal
SOURCE	source signal
S/s	samples per second—used to express the rate at which a DAQ board samples an analog signal
STARTSCAN	start scan signal
system noise	a measure of the amount of noise seen by an analog circuit or an ADC when the analog inputs are grounded

T

TC	terminal count—the ending value of a counter
t_{gh}	gate hold time
t_{gsu}	gate setup time
t_{gw}	gate pulse width
t_{out}	output delay time
THD	total harmonic distortion—the ratio of the total rms signal due to harmonic distortion to the overall rms signal, in dB or percent
thermocouple	a temperature sensor created by joining two dissimilar metals. The junction produces a small voltage as a function of the temperature.
TRIG	trigger signal

t_{sc}	source clock period
t_{sp}	source pulse width
TTL	transistor-transistor logic

U

UI	update interval
UISOURCE	update interval counter clock signal
unipolar	a signal range that is always positive (for example, 0 to +10 V)
UPDATE	update signal

V

V	volts
VDC	volts direct current
VI	virtual instrument—(1) a combination of hardware and/or software elements, typically used with a PC, that has the functionality of a classic stand-alone instrument (2) a LabVIEW software module (VI), which consists of a front panel user interface and a block diagram program
V_{IH}	volts, input high
V_{IL}	volts, input low
V_{in}	volts in
V_m	measured voltage
V_{OH}	volts, output high
V_{OL}	volts, output low
V_{ref}	reference voltage
Vrms	volts, root mean square

W

waveform	multiple voltage readings taken at a specific sampling rate
WFTRIG	waveform generation trigger signal

Index

Numbers

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